12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

General Description

The MAX17843 is a programmable, highly integrated, high-voltage, 12-channel battery-monitoring smart dataacquisition interface with extensive features for safety. It is optimized for use with batteries used in automotive systems, hybrid electric battery packs, electric cars, and any system that stacks long series strings of secondary metal batteries. This highly integrated battery sensor incorporates a high-speed differential UART bus for robust daisychained serial communication.

The analog front-end combines a 12-channel voltagemeasurement data-acquisition system with a high-voltage switch-bank input. All measurements are done differentially across each cell. The full-scale measurement range is from 0 to 5.0V with a usable range of 0.2V to 4.8V. A high-speed successive approximation (SAR) A/D converter is used to digitize the cell voltages at 14-bit resolution with oversampling. All 12 cells can be measured in under 142 μ s. The MAX17843 uses a 2-scan approach for collecting cell measurements and correcting them for errors. This 2-phase approach yields excellent accuracy over temperature and in the face of extreme noise in the system.

The MAX17843 has two auxiliary analog inputs that can be used to measure external thermistor components. A negative temperature coefficient (NTC) thermistor can be configured with the AUXIN analog inputs to accurately monitor module or battery-cell temperature. A thermaloverload detector disables the MAX17843's linear regulator to protect the IC, and a die-temperature measurement is also available.

Applications

- 48V Vehicle Battery Modules or Systems
- High-Voltage Electric Vehicle (EVs)
- Hybrid Electric Vehicles (HEVs)
- Battery Packs
- Electric Bikes
- High-Power Battery-Backup Systems
- Super-Cap Backup Systems
- Power Tools

Ordering Information appears at end of data sheet.

Benefits and Features

- 12-Cell Battery-Voltage Measurement for Lithium-Ion, NiMH, or Super-Cap Cells
- Two Auxiliary Analog Inputs for NTC Thermistor or Absolute Voltage Measurement
- Die Temperature Measurement and alert
- High-Accuracy Differential Measurement I/Os
 - ±2mV Accuracy at +25°C and 3.6V
- Integrated 12-Channel Data-Acquisition System
 - Differential High-Voltage Mux to ADC
 - 14-Bit ADC Resolution with Oversampling
 - 12 Cell Voltages Measured within 142µs
 - Module Voltage Measurement
 - Redundant ADC
- Battery Fault Detection
 - Overvoltage and Undervoltage Digital Threshold Detection
 - Enhanced Diagnostic Features for Fault Detection to Support ASIL and FMEA
- 12 Internal Cell-Balancing Switches
 - Support Up to 150mA per Switch
 - Emergency Cell-Discharge Mode
- Integrated 9V to 65V Input Linear Regulator
- Integrated Temperature-Compensated, Voltage Reference
- Robust Differential Daisy-Chain UART Interface
 - Up to 32 Connected ICs in a Single Daisy-Chain
 - Compatible with Direct MCU Connection
 - Standard UART bytes at 2Mb/s (max) Rate
- Four General-Purpose Digital I/O Lines
- Built-In Diagnostics to Support ASIL D and FMEA Requirements
- Ultra-Low-Power Dissipation
 - 2.0mA (typ) Standby-Mode Supply Current
 - 3µA Shutdown Mode Leakage Current
- -40°C to +125°C Operating Temperature Range (AEC-Q100 Grade 1)
- 64-Pin, Lead-Free/RoHS-Compliant, 10mm x 10mm LQFP Package



12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

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Simplified Operating Circuit



Figure 1. Simplified Operating Circuit

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface



Simplified Operating Circuit (continued)

Figure 2. Cell and switch input Filter Operating Circuit

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Functional Block Diagram



Figure 3. MAX17843 Functional block diagram

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

Absolute Maximum Ratings

| HV to AGND | 0.3 to +80V |
|--|---------------------------------|
| DCIN, SWn, VBLK, and Cn to AGND | 0.3V to V _{HV} + 0.3V |
| | -0.3V to +72V |
| Cn to Cn-1 | 72V to +72V |
| SWn to SWn-1 | 0.3V to +16V |
| V _{AA} to AGND | 0.3v to +4V |
| V _{DDL1} to GNDL1 | 0.3V to +4V |
| V _{DDL2} to GNDL2 | 0.3V to +6V |
| V _{DDL3} to GNDL3 | 0.3V to +6V |
| V _{AA} to V _{DDL1} , V _{DDL2} , and V _{DDL3} | 0.3V to +0.3V |
| AGND to GNDL1, GNDL2, GNDL3 | 0.3V to +0.3V |
| AUXIN1, AUXIN2, THRM to AGND | 0.3V to V _{AA} + 0.3V |
| SHDNL to AGND | 0.3 to V _{DCIN} + 0.3V |
| CTG to AGND | 0.3V to +6V |
| RXLP, RXLN, RXUP, RXUN to GNDL1 | 30V to +30V |

| TXLP, TXLN to GNDL20.3V to +6V | , |
|---|---|
| | |
| TXUP, TXUN to GNDL30.3V to +6V | |
| CPP to AGND V _{DCIN} - 1V to V _{HV} + 1V | / |
| CPN to AGND0.3V to V _{DCIN} + 0.3V | / |
| GPIO0, GPIO1, GPIO2, GPIO3 to GNDL10.3V to V _{DDL1} + 0.3V | / |
| Max Continuous Current into Any Pin (Note 1)±20mA | ١ |
| Max Continuous Current into SWn Pin (Note 2)±400mA | ١ |
| Max Average Power for ESD Diodes (Note 3) 14.4/\dtW | Ι |
| Package Continuous Power (Note 4)2000mW | Ι |
| Package Junction-to-Ambient | |
| Thermal Resistance (θ _{JA})40°C/W | |
| Operating Temperature Range40°C to +125°C |) |
| Storage Temperature Range55°C to +150°C |) |
| Junction Temperature (continuous)150°C |) |
| Soldering Lead Temperature (10s max) |) |
| | |

Note 1: Balancing switches disabled.

Note 2: One balancing switch enabled, 60s (max).

Note 3: Average power for time period τ where τ is the time constant (in μs) of the transient diode current during a hot-plug event. For, example, if τ is 330μs, the maximum average power is 0.793W. Peak current must never exceed 2A. Actual average power during hot-plug must be calculated from the diode current waveform for the application circuit and compared to the maximum rating.

Note 4: Multilayer board. For $T_A > +70^{\circ}C$ derate 25mW/°C.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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Electrical Characteristics

 $(V_{DCIN} = +48V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted, where } T_{MIN} = -40^{\circ}\text{C} \text{ and } T_{MAX} = +125^{\circ}\text{C}.$ Typical values are at $T_A = +25^{\circ}\text{C}.$ Operation is with the recommended application circuit.) (Note 5)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---|----------------------|--|--------------|-----------------|-------------------|-------|
| POWER REQUIREMENTS | | | | | | |
| Supply Voltage | V _{DCIN} | | 9 | | 65 | V |
| | IDCSHDN | V _{SHDNL} = 0V | | 0.1 | 3 | μA |
| | IDCSTBY | V _{SHDNL} > 1.8V, baud rate = 0 (100% idle), SCAN = 0, BALSWEN, CTSTEN = 0000h | 1.5 | 2.0 | 2.7 | mA |
| Supply Current (Note 6) | IDCCOMM | Baud rate = 2Mb/s (0% idle time preambles mode), 200pF load on TXUP, 200pF on TXUN, TXL not active, SCAN = 0, BALSWEN, CTSTEN = 0000h | 2.0 | | 5 | mA |
| | IDCMEAS | MEASUREEN = 0FFFh, acquisition mode | 3.5 | 5.4 | 8 | mA |
| HV Measurement Current | I _{HVMEAS} | MEASUREEN = 0FFFh, acquisition mode, $V_{HV} = V_{DCIN} + 5.5V$ | 0.9 | 1.1 | 1.3 | mA |
| Incremental HV Current for n Balancing Switches Enabled | I _{HVBAL} | V _{HV} = V _{DCIN} + 5.5V, cell-balancing mode | (n+1) x 5 | (n+1) x 13.5 | (n+1) x 26 | μA |
| VOLTAGE INPUTS (Cn, for n | = 1 to 12 and | V _{BLKP}) | | | | · |
| Differential Input Range, | | Unipolar mode | 0.2 | | 4.8 | V |
| $V_{CELLn} = V_{Cn} - V_{Cn-1}$ (Note 7) | V _{CELLn} | Bipolar mode | -2.3 | | +2.3 | V |
| Common-Mode Input Range | V _{CnCM} | SWn inputs not connected | 0 | | 65 | V |
| Input Leakage Current | ILKGCn_L | V _{HV} = 71V, Cn = 0V | -200 | -10 | +200 | nA |
| Input Leakage Current | I _{LKGCn_H} | C0 = 5V, C1 to C5 = 28V, C6 to C12 = 65V; V _{HV} = 71V | -200 | ±10 | +200 | nA |
| V _{BLKP} Input Resistance (to AGND) | R _{VBLKP} | V _{BLKP} = V _{DCIN} = 57.6V | 4.5 | 10 | 20 | ΜΩ |
| HVMUX Switch Resistance | R _{MUX} | CTSTDAC[3:0] = Fh | 1.7 | 2.5 | 6 | kΩ |
| CELL-BALANCING INPUTS | (SWn for n = 1 | to 12) | | | | |
| Leakage Current | I _{LKG_SW} | V_{DCIN} = 60V, V_{SWn} = 5 x N, all SWn pins biased | -1 | | +1 | μA |
| Resistance, SWn to SWn-1 | R _{SWn} | BALSWENn = 1, I _{SWn} = 100mA | 0.5 | 2 | 5 | Ω |
| AUXILIARY INPUTS (AUXIN | I, AUXIN2) | | | | | |
| Input Voltage Range | V _{AUXINn} | | 0 | | V _{THRM} | V |
| Input Leakage Current | I _{LKG_AUX} | ADC off; V _{AUXINn} = 1.65V | -400 | 10 | +400 | nA |
| THRM OUTPUT | | | · | | | · |
| Switch Resistance, THRM to V_{AA} | R _{THRM} | | | 25 | 100 | Ω |
| THRM Leakage | ITHRM | V _{THRM} = 1.65V | -1 | | +1 | μA |

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

Electrical Characteristics (continued)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|--|-------------------------------|---|------|-------|------|-------|
| MEASUREMENT ACCURAC | Y | | | | | |
| Initial Total-Acquisition Error (HVMUX Inputs, ADC1 or ADC2) | V _{CELLn} ERRINIT | Unipolar mode, $V_{CELLn} = 3.6V$, DCIN = 43.2V, $T_A = +25^{\circ}C$, VSAMPL[2:0] = 011b, filter coefficient, FC [2:0] = 010b | -2 | | +2 | mV |
| | | Unipolar mode, $0.2V \le V_{CELLn} \le 4.8V$, 5C < T _A < 40°C OVSAMPL[2:0] = 011b, filter coefficient, FC [2:0] = 010b | -3.5 | | +3.5 | |
| Initial-Acquisition Error (HVMUX Inputs, ADC1 or ADC2) (Note 8) | V _{CELLnERR} | Unipolar mode, $0.2V \le V_{CELLn} \le 4.8V$, OVSAMPL[2:0] = 011b, filter coefficient, FC[2:0]= 010b | -6 | ±0.75 | +6 | mV |
| | | Bipolar mode, $-2.3V \le V_{CELLn} \le 2.3V$, OVSAMPL[2:0] = 011b, filter coefficient, FC[2:0] = 010b | -6 | | +6 | |
| Initial-Acquisition Error (HVMUX Inputs, ADC1 or ADC2) (Note 9) | | Unipolar mode, $0.2V \le V_{CELLn} \le 4.8V$, $0C < T_A < 40^{\circ}C$, $OVSAMPL[2:0] = 011b$, filter coefficient, FC[2:0]= 010b | -3.5 | | +3.5 | mV |
| Initial-Acquisition Error (ALTMUX Inputs, ADC1 or ADC2) (Note 8) | VSWnERR | Unipolar mode, $0.2V \le V_{CELLn} \le 4.8V$ 5C < T _A < 40°C OVSAMPL[2:0] = 011b, filter coefficient, FC [2:0] = 010b | -3.5 | | +3.5 | mV |
| | | Unipolar mode, $0.2V \le V_{CELLn} \le 4.8V$, OVSAMPL[2:0] = 011b, filter coefficient, FC[2:0] = 010b | -6 | | +6 | m)/ |
| | | Bipolar mode, $-2.3V \le V_{CELLn} \le 2.3V$, OVSAMPL[2:0] = 011b, filter coefficient, FC[2:0] = 010b | -6 | | +6 | - mV |
| Total-Acquisition Noise (Note 9) | V _{CELLNOISE} | No oversampling | | 1.1 | | mVRMS |
| Total-Acquisition Error (V _{BLKP} Input) | V _{BLKERR} | $9V \le V_{BLKP} \le 57.6V V_{DCIN} = 57.6V$, OVSAMPL[2:0]= 011b, filter coefficient, FC[2:0] = 010b | -110 | | +110 | mV |
| Offset Error for AUXIN Measurement | V _{OS_AUX} | | -3 | | +3 | mV |
| Gain Error for AUXIN Measurement | A _{V_AUX} | | -0.3 | | +0.3 | % |
| Total Error for Die- Temperature Measurement (Note 9) | T _{DIE_ERR} | T _J = -40°C to +105°C, no averaging | -5 | ±3 | +5 | °C |
| Differential Nonlinearity (Any Conversion) | DNL | | | ±1.0 | | LSbs |
| ADC Resolution | | | 12 | | | bits |

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

Electrical Characteristics (continued)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---|--------------------------------|--|------------------------|------|------|-------|
| Level-Shifting Amplifier Offset (Note 10) | V _{OS_LSAMP} | DIAGSEL[2:0] = 011b, OVSAMPL[2:0] = 011b | -200 | | +200 | mV |
| V _{AA} Diagnostic ADC1 Measurement Accuracy | V _{DIAG} _ VAAERR1 | DIAGSEL[2:0] = 010b, OVSAMPL[2:0] = 011b, ADCSELECT = 0 | -20 | | +20 | mV |
| V _{AA} Diagnostic ADC2 Measurement Accuracy | V _{DIAG} _ VAAERR2 | DIAGSEL[2:0] = 010b, OVSAMPL[2:0] = 011b, ADCSELECT = 1 | -30 | | +30 | mV |
| SHDNL INPUT AND CHARG | E PUMP | | | | | |
| Input Low Voltage | VIL_SHDNL | | | | 0.55 | V |
| Input High Voltage | VIH_SHDNL | | 1.8 | | | V |
| | | V _{DCIN} ≥ 12V | 8 | 9.5 | 12 | V |
| Regulated Voltage | VSHDNLIMIT | V _{DCIN} = 9V | | 6.7 | | V |
| Pulldown Resistance | R _{FORCEPOR} | FORCEPOR = 1 | 2.5 | 4.7 | 8 | kΩ |
| SHDNL Input Leakage Resistance | R _{SHDNL} | | 4.5 | | 20.5 | MΩ |
| Charge-Pump Current (Note 11) | ISHDNL | V _{SHDNL} < V _{SHDNLIMIT} , baud rate = 2Mbps | 15 | 117 | 350 | μA |
| GENERAL-PURPOSE I/O (G | PIO0–GPIO3) | | | | | |
| Input Low Voltage | V _{IL_GPIO} | | | | 0.8 | V |
| Input High Voltage | VIH_GPIO | | 2.4 | | | V |
| Pulldown Resistance | R _{GPIO} | GPIO[15:12] = 0h (input) | 0.5 | 2 | 7.5 | MΩ |
| Output Low Voltage | V _{OL_GPIO} | I _{SINK} = 3mA | | | 0.4 | V |
| Output High Voltage | V _{OH_GPIO} | I _{SOURCE} = 3mA | V _{DDL1} - 0. | 4 | | V |
| REGULATOR | - | | | | | |
| Output Voltage | V _{AA} | 0 ≤ I _{VAA} < 10mA | 3.2 | 3.3 | 3.4 | V |
| Short-Circuit Current | IAASC | V _{AA} shorted to AGND | 10 | 20 | 70 | mA |
| | V _{PORFALL} | V _{AA} falling | 2.85 | 2.95 | 3.02 | V |
| POR Threshold | V _{PORRISE} | V _{AA} rising | | 3.0 | 3.1 | V |
| POR Hysteresis | V _{PORHYS} | | | 40 | | mV |
| Thermal-Shutdown Temperature (Note 9) | T _{SHDN} | Temperature rising | | 165 | | °C |
| Thermal-Shutdown Hysteresis (Note 9) | T _{HYS} | | | 10 | | °C |
| HV CHARGE PUMP | | · | | | | |
| | Mana | $9V \le V_{DCIN} \le 12V$, $I_{LOAD} = 1.5mA$ | 5 | 5.5 | 6 | . V |
| Output Voltage (V _{HV} -V _{DCIN}) | V _{HV-DCIN} | $12V \le V_{DCIN} \le 65V$, $I_{LOAD} = 3mA$ | 5 | 5.5 | 6 | - V |
| Charge Pump Efficiency (Note 12) | | | | 38 | | % |

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

Electrical Characteristics (continued)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|--|-----------------------|--|-------|--------|-------|--------|
| HV Headroom | V _{HVHDRM} | ALRTHVHDRM = 0 | 4.7 | | | V |
| OSCILLATORS | | | | | | |
| 32kHz Oscillator Frequency | fosc_32K | | 32.11 | 32.768 | 33.42 | kHz |
| 16MHz Oscillator Frequency | fOSC_16M | | 15.68 | 16 | 16.32 | MHz |
| DIAGNOSTIC TEST SOURCE | ES | | | | | |
| | | CTSTDAC[3:0] = 9h, V _{Cn} < V _{AA} - 1.4V, V _{AA} = 3.3V | 50 | 62.5 | 75 | |
| Cell-Test Source Current | I | CTSTDAC[3:0] = 6h, V _{Cn} < V _{AA} - 1.4V, V _{AA} = 3.3V | 36 | 45 | 54 | |
| Cell-Test Source Current | I _{TSTCn} | $\begin{array}{l} CTSTDAC[3:0] = 6h, \\ V_{Cn} > V_{AGND} + 1.4V \end{array}$ | -54 | -45 | -36 | - μΑ |
| | | CTSTDAC[3:0] = 9h, V _{Cn} > V _{AGND} + 1.4V | -75 | -62.5 | -50 | |
| HVMUX Test-Source | | CTSTDAC[3:0] = 9h, V _{Cn} < V _{HV} - 1.4V, V _{HV} = 53.5V | 25 | 31.25 | 37.5 | |
| Current | ITSTMUX | CTSTDAC[3:0] = 6h, V _{Cn} < V _{HV} - 1.4V, V _{HV} = 53.5V | 18 | 22.5 | 27 | - μΑ |
| | | CTSTDAC[3:0] = 9h, V _{AUXINn} < V _{AA} - 1.4V, V _{AA} = 3.3V | 50 | 62.5 | 75 | μA |
| | ITSTAUXIN | CTSTDAC[3:0] = 6h, V _{AUXINn} < V _{AA} - 1.4V, V _{AA} = 3.3V | 36 | 45 | 54 | |
| AUXIN Test-Source Current | | CTSTDAC[3:0] = 6h, V _{AUXINn} > V _{AGND} + 1.4V | -54 | -45 | -36 | |
| | | CTSTDAC[3:0] = 9h, V _{AUXINn} > V _{AGND} + 1.4V | -75 | -62.5 | -50 | |
| DIAGNOSTIC REFERENCES | ; | | | | | |
| ALTREF Voltage (Note 10) | V _{ALTREF} | DIAGSEL[2:0] = 001b | 1.23 | 1.242 | 1.254 | V |
| ALTREF Temperature Coefficient ($\Delta V_{ALTREF}/\Delta T$) (Note 9) | A _{ALTREF} | | | ±25 | | ppm/°C |
| PTAT Output Voltage (Note 9) | V _{PTAT} | T _J = +120°C | | 1.2 | | V |
| PTAT Temperature Coefficient (ΔV _{PTAT} /ΔT) (Note 9) | A _{V_PTAT} | | | 3.07 | | mV/°C |
| PTAT Temperature Offset (Note 9) | T _{OS_PTAT} | | | 0 | | °C |
| ALERTS | | | I | | | |
| ALRTVDDLn Threshold | V _{VDDL_OC} | V _{AA} = 3.3V | 3 | 3.15 | 3.25 | V |
| ALRTGNDLn Threshold | V _{GNDL_} OC | AGND = 0V | 0.05 | 0.15 | 0.3 | V |

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Electrical Characteristics (continued)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---|------------------------------|---|--------------------------------|----------------------|--------------------------------|---------------------------|
| ALRTHVUV Threshold | V _{HVUV} | V _{HV} - V _{DCIN} falling | 3.8 | 4.1 | 4.25 | V |
| ALRTHVOV Threshold | V _{HVOV} | V _{HV} - V _{DCIN} rising | 7 | 8.5 | 10 | V |
| ALRTTEMP Threshold (Note 9) | T _{ALRTTEMP} | | 115 | 120 | 125 | °C |
| ALRTTEMP Hysteresis (Note 9) | T _{ALRTTEMP} HYS | | | 2 | | °C |
| UART OUTPUTS (TXLP, TXL | N, TXUP, TXU | ۷) | | | | |
| Output Low Voltage | V _{OL} | I _{SINK} = 20mA | | | 0.4 | V |
| Output High Voltage (TXLP, TXLN) | V _{OH} | I _{SOURCE} = 20mA | V _{DDL2} - | 0.4 | | V |
| Output High Voltage (TXUP, TXUN) | V _{OH} | I _{SOURCE} = 20mA | V _{DDL3} - | 0.4 | | V |
| Leakage Current | I _{LKG_TX} | V _{TX} = 1.5V | -1 | | +1 | μA |
| UART INPUTS (RXLP, RXLN | , RXUP, RXUN) | | | | | |
| Input Voltage Range | V _{RX} | | -25 | | +25 | V |
| Receiver High Comparator Threshold (Notes 13, 17) | V _{CH} | | V _{DDL} / 2 - 0.4 | V _{DDL} /2 | V _{DDL} / 2 + 0.4 | V |
| Receiver Zero-Crossing Comparator Threshold (Note 13) | V _{ZC} | | -0.4 | 0 | +0.4 | V |
| Receiver Low Comparator Threshold (Notes 13, 17) | V _{CL} | | -V _{DDL} / 2 - 0.4 | -V _{DDL} /2 | -V _{DDL} / 2 + 0.4 | V |
| Receiver Comparator Hysteresis (Note 13) | V _{HYS_RX} | | | 75 | | mV |
| Receiver Common-Mode Voltage Bias (Notes 13, 17) | V _{CM} | | | V _{DDL} /3 | | V |
| Leakage Current | I _{LKG_RX} | V _{RX} = 1.5V | | ±1.0 | | μA |
| Input Capacitance (RXLP, RXLN) | C _{RXL} | | | 4 | | pF |
| Input Capacitance (RXUP, RXUN) | C _{RXU} | | | 2 | | pF |
| UART TIMING | | | ł | | | |
| | | Baud rate = 2Mb/s | | 8 | | |
| Bit Period (Note 14) | t _{BIT} | Baud rate = 1Mb/s | | 16 | | 1/f _{OSC} |
| | | Baud rate = 0.5Mb/s | | 32 | | |
| Rx Idle to START Setup Time (Notes 9, 15) | t _{RXSTSU} | | 0 | | 1 | t _{BIT} |
| STOP Hold Time to Idle (Notes 9, 15) | ^t SPHD | | | | 4 | 1/f _{OSC} 16M |

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Electrical Characteristics (continued)

 $(V_{DCIN} = +48V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted, where } T_{MIN} = -40^{\circ}C \text{ and } T_{MAX} = +125^{\circ}C.$ Typical values are at $T_A = +25^{\circ}C.$ Operation is with the recommended application circuit.) (Note 5)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|--|-------------------------|------------|-----|-----|-----|------------------|
| RX Minimum Idle Time (STOP bit to START bit) (Notes 9, 15) | ^t RXIDLESPST | | 1 | | | ^t вıт |
| RX Fall Time (Notes 9, 16) | t _{FALL} | | | | 0.5 | t _{BIT} |
| RX Rise Time (Notes 9, 16) | t _{RISE} | | | | 0.5 | t _{BIT} |
| Propagation Delay (RX Port to TX port) (Note 9) | t _{PROP} | | | 2.5 | 3 | t _{ВIT} |
| Startup Time from SHNDL High and V _{AA} = 0V to RXUP/RXUN Valid | ^t STARTUP | | | 1 | | ms |

Note 5: Unless otherwise noted, limits are 100% production tested at T_A = +25°C. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization.

Note 6: Acquisition mode (ADC conversions) is entered when the SCAN bit is set and ends when SCANDONE is set. With the typical acquisition duty-cycle very low, the average current (IDCIN) is much less than IDCMEAS. Total supply current during communication: $I_{DCIN} = I_{DCCOMM} + I_{DCSTBY}$.

Range over which measurement settling time and accuracy is guaranteed. Note 7:

Note 8: $V_{CELLn} = V_{Cn} - V_{Cn-1}$, $V_{CELLn} = V_{CELLn-1}$, and $V_{DCIN} = 12 \text{ x} | V_{CELLn} |$ (9V min). **Note 9:** Guaranteed by design and not production tested.

Note 10: As measured during specified diagnostic mode; 5V full-scale for unipolar mode measurements and 2.5V full-scale for bipolar measurements

Note 11: I_{SHDNL} measured with V_{SHDNL} = 0.3V, STOP characters, zero idle time, V_{RX} _{PEAK} = 3.3V.

Note 12: Charge pump efficiency = $\Delta I_{LOAD} / \Delta I_{SUPPLY}$, where I_{LOAD} is applied from HV to AGND, ΔI_{LOAD} = 5mA, and ΔI_{SUPPLY} = I_{DCIN} (for $I_{LOAD} = 5mA$) - I_{DCIN} (for $I_{LOAD} = 0$).

Note 13: Differential signal (V_{RXP} - V_{RXN}) where V_{RXP} and V_{RXN} do not exceed a common-mode voltage range of ±25V.

Note 14: In daisy-chain applications, the bit time of the second STOP bit may be less than specified to account for clock-rate variation and sampling error between devices.

Note 15: Maximum limited by application circuit.

Note 16: Fall time measured 90% to 10%; rise time measured 10% to 90%.

Note 17: $V_{DDL} = V_{DDL2}$ for lower port; $V_{DDL} = V_{DDL3}$ for upper port.

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Figure 4. MAX17843 64-Pin LQFP Pin Configuration

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

Pin Description

| PIN | NAME | TYPE | FUNCTION | |
|--------------------------|-------------------|--------|---|--|
| 1, 18, 19, 26, 27, 60 | N.C. | — | Not Connected. Connect to ground or leave unconnected. | |
| 2, 4, 31 | AGND | Ground | Analog Ground. Connect to negative terminal of cell 1 and ground plane. | |
| 3 | SHDNL | Input | Active-Low Shutdown Input. Drive > 1.8V to enable operation and drive < 0.6V to reset device and place in shutdown mode. +72V tolerant. If not driven externally, this input can be controlled solely through UART communication and software control. Bypass with a 1nF capacitor to AGND. For single-ended UART, SHDNL must be driven externally. | |
| 5 | V _{AA} | Power | 3.3V Regulator Output Used to Supply $V_{DDL1}, V_{DDL2}, and V_{DDL3}.$ Bypass with a $1\mu F$ capacitor to ground. | |
| 6 | TXUN | Output | Negative Output for Upper-Port Transmitter. Driven between V _{DDL3} and GNDL3. | |
| 7 | TXUP | Output | Positive Output for Upper-Port Transmitter. Driven between V _{DDL3} and GNDL3. | |
| 8 | GNDL1 | Ground | Digital Ground. Connect to ground plane. | |
| 9 | V _{DDL1} | Power | 3.3V Digital Supply. Connect externally to $V_{\mbox{AA}}$ and bypass with 0.47 $\mu\mbox{F}$ capacitor to GNDL1. | |
| 10 | GNDL3 | Ground | Ground for Upper-Port Transmitter. Connect to ground plane. | |
| 11 | V _{DDL3} | Power | 3.3V Supply for Upper-Port Transmitter. Connect externally to VAA and bypass with 0.47 μF capacitor to GNDL3. | |
| 12 | RXUN | Input | Negative Input for Upper-Port Receiver. Tolerates ±30V. | |
| 13 | RXUP | Input | Positive Input for Upper-Port Receiver. Tolerates ±30V. Connect to ground for single- ended operation. | |
| 14 | GPIO3 | I/O | General-Purpose I/O 3. Driven between V _{DDL1} and GNDL1. 2MΩ internal pulldown. | |
| 15 | GPIO2 | I/O | General-Purpose I/O 2. Driven between V _{DDL1} and GNDL1. 2MΩ internal pulldown. | |
| 16 | GPIO1 | I/O | General-Purpose I/O 1. Driven between V _{DDL1} and GNDL1. 2MΩ internal pulldown. | |
| 17 | GPIO0 | I/O | General-Purpose I/O 0. Driven between V _{DDL1} and GNDL1. 2MΩ internal pulldown. | |
| 20 | TXLP | Output | Positive Output for Lower-Port Transmitter. Driven between V _{DDL2} and GNDL2. | |
| 21 | TXLN | Output | Negative Output for Lower-Port Transmitter. Driven between V _{DDL2} and GNDL2. | |
| 22 | V _{DDL2} | Power | 3.3V Supply for Lower-Port Transmitter. Connect externally to VAA and bypass with 0.47 μF capacitor to GNDL2. | |
| 23 | GNDL2 | Ground | Ground for Lower-Port Transmitter. Connect to ground plane. | |
| 24 | RXLP | Input | Positive Input for Lower-Port Receiver. Tolerates ±30V. Connect to ground for single- ended operation. | |
| 25 | RXLN | Input | Negative Input for Lower-Port Receiver. Tolerates ±30V. | |
| 28 | CTG | Input | Reserved for Factory use. Connect to ground. | |
| 29 | AUXIN2 | Input | Auxiliary Voltage Input 2 to Measure External Temperature. Connect to a voltage-divide consisting of a $10k\Omega$ pullup to THRM and $10k\Omega$ NTC thermistor to ground. If not used, connect to the pullup only. | |
| 30 | AUXIN1 | Input | Auxiliary Voltage Input 1 to Measure External Temperature. Connect to a voltage-divider consisting of a $10k\Omega$ pullup to THRM and a $10k\Omega$ NTC thermistor to ground. If not used, connect to the pullup only. | |
| 32 | THRM | Power | 3.3V Switched Output. Used to supply the voltage-dividers for the auxiliary inputs. The output is enabled only during measurements, or as configured by THRMMODE[1:0]. This output can source up to 2mA. | |

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Pin Description (continued)

| PIN | NAME | TYPE | FUNCTION | |
|-----|-------------------|-------|--|--|
| 33 | SW0 | Input | Balance Input for Cell 1 Negative. | |
| 34 | C0 | Input | Voltage Input for Cell 1 Negative. Connect to AGND. | |
| 35 | SW1 | Input | Balance Input for Cell 1 Positive (Cell 2 Negative) | |
| 36 | C1 | Input | Voltage Input for Cell 1 Positive (Cell 2 Negative) | |
| 37 | SW2 | Input | Balance Input for Cell 2 Positive (Cell 3 Negative) | |
| 38 | C2 | Input | Voltage Input for Cell 2 Positive (Cell 3 Negative) | |
| 39 | SW3 | Input | Balance Input for Cell 3 Positive (Cell 4 Negative) | |
| 40 | C3 | Input | Voltage Input for Cell 3 Positive (Cell 4 Negative) | |
| 41 | SW4 | Input | Balance Input for Cell 4 Positive (Cell 5 Negative) | |
| 42 | C4 | Input | Voltage Input for Cell 4 Positive (Cell 5 Negative) | |
| 43 | SW5 | Input | Balance Input for Cell 5 Positive (Cell 6 Negative) | |
| 44 | C5 | Input | Voltage Input for Cell 5 Positive (Cell 6 Negative) | |
| 45 | SW6 | Input | Balance Input for Cell 6 Positive (Cell 7 Negative) | |
| 46 | C6 | Input | Voltage Input for Cell 6 Positive (Cell 7 Negative) | |
| 47 | SW7 | Input | Balance Input for Cell 7 Positive (Cell 8 Negative) | |
| 48 | C7 | Input | Voltage Input for Cell 7 Positive (Cell 8 Negative) | |
| 49 | SW8 | Input | Balance Input for Cell 8 Positive (Cell 9 Negative) | |
| 50 | C8 | Input | Voltage Input for Cell 8 Positive (Cell 9 Negative) | |
| 51 | SW9 | Input | Balance Input for Cell 9 Positive (Cell 10 Negative) | |
| 52 | C9 | Input | Voltage Input for Cell 9 Positive (Cell 10 Negative) | |
| 53 | SW10 | Input | Balance Input for Cell 10 Positive (Cell 11 Negative) | |
| 54 | C10 | Input | Voltage Input for Cell 10 Positive (Cell 11 Negative) | |
| 55 | SW11 | Input | Balance Input for Cell 11 Positive (Cell 12 Negative) | |
| 56 | C11 | Input | Voltage Input for Cell 11 Positive (Cell 12 Negative) | |
| 57 | SW12 | Input | Balance Input for Cell 12 Positive | |
| 58 | C12 | Input | Voltage Input for Cell 12 Positive | |
| 59 | V _{BLKP} | Input | Block Voltage Positive Input. Internal $10M\Omega$ pulldown during measurement. | |
| 61 | HV | Power | Decoupling Capacitor Connection for the HV Charge Pump. $V_{HV} = V_{DCIN} + 5.5V$ (typical). Bypass with a 50V, 4.7µF capacitor to DCIN. | |
| 62 | DCIN | Power | DC Supply for the Low-Voltage Regulator, HV Charge Pump, and SHDNL Charge Pump. Connect to a voltage source between 9V and 65V through a 100Ω series resistor. Bypass with a $100V$, 2.2μ F capacitor to ground. | |
| 63 | CPP | Power | Positive Capacitor Connection for the HV Charge Pump. Connect a 100V, 0.1µF capacitor from CPP to CPN. | |
| 64 | CPN | Power | Negative Capacitor Connection for the HV Charge Pump | |

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

Detailed Description

The data-acquisition system consists of the major blocks as described in Table 1.

Table 1. System Blocks

| BLOCK | DESCRIPTION |
|-----------------------|---|
| ADC1 | Primary analog-to-digital converter. Uses a 12-bit successive-approximation register (SAR), with a reference voltage of 2.307V and is supplied by V_{AA} . V_{AA} diagnostic result yields V_{AA} . This is the default ADC selected by the ADCSELECT bit in the SCANCTRL register. |
| ADC2 | Secondary analog-to-digital converter. Uses a 12-bit successive-approximation register (SAR) with a reference voltage of 2.307V and is supplied by V_{AA} . This is the secondary ADC. V_{AA} diagnostic result yields $V_{AA}/2$. Writing the ADCSELECT bit to 1 selects this ADC for measurements. |
| HVMUX | 12-channel, high-voltage (65V) differential multiplexer for Cn inputs. |
| HV CHARGE PUMP | High-voltage charge-pump supply (V_{DCIN} + 5.5V) for the HVMUX, ALTMUX, BALSW, and LSAMP circuits that must switch high-voltage signals. Supplied by DCIN. |
| LSAMP | Level-shifting amplifier with a gain of 6/13. The result is that a 5V differential signal is attenuated to 2.307V, which is the reference voltage for the ADC. |
| LVMUX | Multiplexes various low-voltage signals including the level-shifted signals and temperature signals to the ADC for subsequent A-to-D conversion. |
| ALTMUX | 12-channel, high-voltage differential multiplexer for SWn inputs. |
| BALSW | Cell-balancing switches. |
| LINREG | 3.3V (V _{AA}) linear regulator used to power the ADC and digital logic. Supplied by DCIN (9V to 65V). |
| REF | 2.307V precision reference voltage for ADC and LINREG. Temperature-compensated. |
| ALTREF | 1.242V precision reference voltage used for diagnostics. |
| 16MHZ OSC | 16MHz oscillator with 2% accuracy for clocking state-machines and UART timing. |
| 32kHz OSC | 32,768Hz oscillator for driving charge pumps and timers. |
| LOWER PORT | Differential UART for communication with host or downstack devices. Autodetects baud rates of 0.5, 1, or 2Mbps. |
| UPPER PORT | Differential UART for communication with upstack devices. |
| CONTROL AND STATUS | ALUs, control logic, and data registers. |
| DIE TEMP | A proportional-to-absolute-temperature (PTAT) voltage source used to measure the die temperature. |

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Figure 6. Analog Front-End (AFE Inputs)

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

Data Conventions

Representation of data follows the conventions shown in Table 2. All registers are 16-bit words.

Data Acquisition

Data acquisition is composed of the distinct processes defined in <u>Table 3</u>, and is controlled by various configuration registers described in this section. Configuration changes should be made prior to the acquisition in which the changes are to be effected.

Precision Internal Voltage References

The measurement system uses two precision, temperature-compensated voltage references. The references are completely internal to the device and do not require any external components. The primary voltage reference (REF) is used to derive the linear regulator output voltage and to supply the ADC reference. An alternate, independent reference(ALTREF) can be used to verify the primary reference voltage, as described in the *Diagnostics* section.

Measurement Calibration

The acquisition system is calibrated at the factory and cannot be changed afterwards. The calibration parameters are stored in a ROM consisting of 12 read-only registers, CAL0–CAL10 and CAL15. ROMCRC[8:0] is an 8-bit CRC value based on the calibration ROM and is stored in ID2[15:8] at the factory. ROMCRC[8:0] can be used to check the integrity of the calibration, as described in the *Diagnostics* section.

Cell Inputs

Up to 12 voltage measurements can be sampled differentially from the 13 cell inputs. The differential signal (V_{CELLn}) is defined as $V_{Cn} - V_{Cn-1}$ for n = 1–12.

Cells to be measured are selected by MEASUREEN[11:0]. During the scan, each selected signal is multiplexed into the level-shifting amplifier (LSAMP) as shown in Figure 6. Since the common-mode range of the input signals is 0 to 65V, the signal must be level-shifted to the common-mode range of the amplifier. The amplifier has a gain of 6/13, so a 5V differential signal is attenuated to 2.307V, which is the ADC reference voltage.

| DESCRIPTION | CONVENTION | EXAMPLE |
|----------------------|--|-------------------------|
| Binary number | Binary number 0b prefix 0b01100001 = 61h | |
| Hexadecimal address | 0x prefix | 0x61 |
| Hexadecimal data | h suffix | 61h |
| Register bit | Register name [x] | STATUS[15] = 1 |
| Register field | Field name [x:y] | DA[4:0] = 0b01100 = 0Ch |
| Concatenated numbers | {xxxx, yyyy} | {DA[4:0], 0b001} = 61h |

Table 2. Numeric Conventions

Table 3. Data-Acquisition Processes

| PROCESS | DESCRIPTION |
|---------------------------------|---|
| Conversion | The ADC samples a single input channel, converts it to a 12-bit binary value, and stores it in an ALU register. |
| Scan | The ADC sequentially performs conversions on all enabled cell input channels. |
| Measurement cycle or Sample | The ADC performs two scans for the purpose of minimizing errors. The conversions (two for each input channel) are averaged together to form a single 14-bit binary value called a measurement. Note: The auxiliary inputs are only scanned once to create the auxiliary measurements. |
| Acquisition or Acquisition mode | If oversampling is enabled, the ADC takes sequential measurements and averages them together to form one 14-bit binary value for each input channel sampled. If there is no oversampling, the acquisition is essentially a single-measurement cycle. Note: The auxiliary inputs are never oversampled and are stored as 12-bit values. |

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Once the signal is properly conditioned, the ADC can start the conversion. The 12-bit conversion is stored in an ALU register where it can be averaged with subsequent conversions. The ALU output is a 14-bit value and is ultimately stored in a 16-bit register with the two least-significant bits zero. Disabled channels result in a measurement value of 0000h. Unless stated otherwise, measurement values are assumed to be 14-bit values. The 16-bit register values can be converted to 14-bit values by dividing by 4 (and vice versa). To convert the measurement value in register CELLn to a voltage, convert the 14-bit hexadecimal value to a decimal value and then convert to voltage as follows:

V_{CELLn} = CELLn[15:2] x 5V/16384 = CELLn[15:2] x 305.176µV.

Input Range

The input range in unipolar mode is nominally 0 to 5V; however, the ADC has reduced linearity at its range extents and so accuracy is specified for the input range 0.2V to 4.8V. Some applications may require specified accuracy below 0.2V, or even below 0V. To this end, the bipolar mode (POLARITY = 1) has a nominal input range of -2.5V to +2.5V, as shown in <u>Table 4</u>, with accuracy specified from -2.3V to +2.3V.

The input range can effectively be extended from -2.5V to +5V by taking one bipolar measurement and one unipolar measurement. Any bipolar measurements over 2.3V should be replaced with the unipolar measurement.

Note: Conversions for some diagnostic modes automatically use either bipolar or unipolar mode, regardless of the POLARITY bit value.

Block Voltage Input

The V_{BLKP} input (total module voltage) is selected for measurement by MEASUREEN14. The measurement is stored in the VBLOCK register with a full-scale value of 60V (3.662mV/bit). It can be compared to the sum of the cell voltages as a diagnostic. To precondition V_{BLKP} for conversion, it is voltage-divided by a factor of 26. The divider is disconnected by default to minimize power consumption. The divider is connected by setting MEASUREEN15 (BLKCONNECT = 1) with sufficient setting time prior to the acquisition. For high acquisition rates, BLKCONNECT can remain enabled to reduce cycle time.

Table 4. Input Range

| CELL INPU | JT VOLTAGE | CELLN[15:2] | (14 BITS) | CELLN[15:0] |
|------------------|-------------------|-------------|-----------|-------------|
| BIPOLAR MODE (V) | UNIPOLAR MODE (V) | HEXADECIMAL | DECIMAL | (16 BITS) |
| -2.5 | 0 | 0000h | 0d | 0000h |
| 0 | 2.5 | 2000h | 8192d | 8000h |
| +2.5 | 5 | 3FFFh | 16383d | FFFCh |



Figure 7. V_{BLKP} Measurement

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Auxiliary Inputs

The AUXIN1 and AUXIN2 inputs can be used to measure external temperatures by enabling MEASUREEN[13:12]. These inputs have a common-mode input range of 0 to V_{AA} . For these measurements, the ADC reference voltage is V_{THRM} , which is switched from V_{AA} , as shown in Figure 8. The auxiliary inputs are not oversampled even

if oversampling is enabled; they are measured only once and stored as 12-bit values in the AIN1 and AIN2 registers.

To measure external temperature, the auxiliary input is connected to a voltage-divider consisting of a $10k\Omega$ pullup to THRM and a $10k\Omega$ NTC thermistor to ground, as shown in Figure 9.



Figure 8. Auxiliary Measurement



Figure 9. Auxiliary Application Circuit

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

THRM Output

The THRM output has two modes of operation, automatic and manual, as shown in <u>Table 5</u>.

The automatic mode minimizes power consumption, but after the THRM output is enabled, the AUXIN voltages must be allowed to settle before the conversion. Since the auxiliary inputs are the last inputs measured, the duration of the measurement cycle itself can provide sufficient settling time, depending on what measurements are enabled and the time constants for the auxiliary input circuit. Up to 384µs of additional settling time, if required, can be configured by ACQCFG[5:0] (see Table 6), or by utilizing the manual mode. The ability to configure the settling time allows for a range of time constants to be considered in designing the auxiliary application circuit.

Computing Temperature

In <u>Figure 9</u>, $V_{AUXINn} = V_{THRM} \times R_{TH}/(10K\Omega + R_{TH})$ and this measurement is stored in the AINn register. The thermistor resistance can then be solved for as follows:

 $R_{TH} = (V_{AUX} \times 10 k\Omega) / (V_{THRM} - V_{AUXINn}),$ where $V_{THRM} = 3.3 V$ nominally.

The resistance of an NTC thermistor increases as the temperature decreases and is typically specified by its resistance R₀ at T₀ = 25°C = 298.15K and a material constant β (3400K typ). To the first order, the resistance R_{TH} is at a temperature T in Kelvin can be computed as follows:

$$R = R_0 e^{(\beta(1/T-1/T_0))}$$

The temperature T of the thermistor (in °C) can then be calculated as follows:

T (in °C) = $(\beta/ln((R_{TH}/10k\Omega) + (\beta/298.15K)) - 273.15K$

Temperature Alerts

Auxiliary voltage measurements can be directly compared to precalculated voltages in the AINUT and AINOT registers that correspond to specific over/undertemperature thresholds. When a measurement exceeds the AINUT or AINOT threshold level, the ALRTCOLD or ALRTHOT bits, respectively, are set in the STATUS register. An alert is cleared only by a new measurement that is within threshold.

| | · · · · · · · · · · · · · · · · · · · | |
|-----------|---------------------------------------|---|
| MODE | ACQCFG[9:8] | DESCRIPTION |
| Automatic | 00b | THRM output enabled at the beginning of the acquisition and disabled at the end |
| Automatic | 01b | of the acquisition. |
| Manual | 10b | THRM output is enabled |
| Manual | 11b | THRM output is disabled |

Table 6. AINTIME

| ACQCFG[5:0] (AINTIME) | ADDITIONAL SETTLING TIME PER ENABLED AUXILIARY CHANNEL = 6μs + (AINTIME x 6μs) |
|-----------------------|---|
| 00h | 6µs |
| 01h | 12µs |
| 02h | 18µs |
| | |
| 1Fh | 384 µs |

Table 5. THRM Output

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Die Temperature Measurement

The die temperature measurement allows the host to compute the device temperature (T_{DIE}) as it relates to the acquisition accuracy, and allows the device to automatically shut itself down when $T_{DIE} > 145$ °C. The measurement employs a source whose voltage (V_{PTAT}) is proportional to absolute temperature (PTAT), as shown in Figure 10. The V_{PTAT} measurement is enabled by setting DIAGSEL[2:0] to 0b110 and the 14-bit measurement is stored in DIAG[15:2]. The die temperature measurement requires a settling time of 50µs from the start of the measurement cycle until the diagnostic conversion. As long as two or more cell measurements are enabled, there will be sufficient settling time for this measurement. See Figure 17 and Table 10 for a detailed view of this timing.

The PTAT voltage is computed as follows:

V_{PTAT} = (DIAG[15:2]/16384d) x V_{REF}

where V_{REF} = 2.307V. The measured voltage can be converted into °C as follows:

 T_{DIE} (in °C) = ($V_{PTAT}/A_V PTAT$) + $T_{OS} PTAT$ - 273°C

See the <u>Electrical Characteristics</u> table for A_{V_PTAT} and $T_{OS\ PTAT}$ values.

Die Temperature Alert

The ALRTTEMP bit is updated at the end of each measurement cycle for which DIAGSEL[2:0] = 0b110. If ALRTTEMP is set, it signifies that $T_{DIE} > T_{ALRTTEMP}$, or that the diagnostic measurement did not have sufficient settling time (< 50µs) and therefore can not be accurate. If ALRTTEMP is set, the host should consider the possibility that the acquisition does not meet the expected accuracy specification, or that the die temperature measurement itself may be inaccurate due to insufficient settling time (< 2 cell measurements enabled).



Figure 10. Die Temperature Measurement

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

Acquisition Mode

The host enters the acquisition mode by writing a logic-one to the SCAN bit in the SCANCTRL register. This write is actually an automatic strobe of the bit since SCAN always reads logic-zero. In daisy-chained devices, acquisitions in upstack devices are delayed by the propagation delay (t_{PROP}) of the command packet through each device. The acquisition is complete when the device sets the SCANDONE bit. The basic acquisition process is outlined below with a detailed flowchart in Figure 8:

- 1) Disable HV charge pump.
- 2) V_{BLKP} conversion, if enabled.
- All enabled cell conversions (first):
 a. Ascending order (1:12) if pyramid mode, or
 b. Descending order (12:1) if top-down mode.
- 4) All enabled cell conversions (second):a. Descending order (12:1).
- 5) V_{BLKP} conversion (second), if enabled.
- 6) Diagnostic conversion (first), if enabled.
- 7) Diagnostic conversion (second), if enabled.
- 8) Enable HV charge pump for recovery period unless:
 a. OVSAMP[2:0] = 0 (no oversampling), or
 b. All oversample measurements are complete.
- 9) Repeat steps 1-8 until all oversamples are done.

- All enabled auxiliary conversions, in ascending order (AUXIN1, AUXIN2).
- 11) Set SCANDONE bit.

Oversampling

Oversampling mode performs multiple measurement cycles in a single acquisition, and averages the samples in the ALU to reduce the measurement noise and effectively increase the resolution of each measurement result. In oversampling mode, acquisition times are proportional to the number of oversamples, as shown in <u>Table 8</u>. The number of oversamples can be configured from 4 to 128 by OVSAMPL[2:0], as shown in <u>Table 7</u>. The AUXIN measurements are never oversampled, even in oversampling mode.

To add n bits of measurement resolution requires at least 2²ⁿ oversamples. Since the ADC resolution is 12 bits, 13-bit resolution requires at least 4 oversamples and to achieve the maximum 14-bit resolution requires at least 16 oversamples; therefore, with no oversampling, only the higher 12 bits of the measurement are statistically significant and with 4 or 8 oversamples, only the higher 13 bits are statistically significant. Taking more than 16 oversamples further reduces the measurement variation.

Of course with no oversampling, measurements can be averaged externally to achieve increased resolution, but at a higher computational cost for the host.

| OVSAMPL[2:0] | OVERSAMPLES | THEORETICAL RESOLUTION | ACQUISITION WATCHDOG TIMEOUT |
|----------------|-------------|------------------------|------------------------------|
| 000b (default) | 0 | 12 bits | 1.10ms |
| 001b | 4 | 13 bits | 2.08ms |
| 010b | 8 | 13 bits | 3.36ms |
| 011b | 16 | 14 bits | 5.92ms |
| 100b | 32 | 14 bits | 10.99ms |
| 101b | 64 | 14 bits | 21.18ms |
| 110b | 128 | 14 bits | 41.56ms |
| 111b | 128 | 14 bits | 41.56ms |

Table 7. Oversampling

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

Infinite Impulse Response Filtering (IIR Filter):

To augment the accuracy performance, an IIR filtering scheme is implemented where the results of the cell voltages are filtered after the oversampling. The IIR filter is implemented by the simple equation below:

$$Y(n) = FC \times X(n) + (1 - FC) \times Y(n-1)$$

where FC = filter coefficient, user-selectable 3 bits.

The default value is b'010, which has a weight of 3/8:

- X (n) = 3/8
- Y (n-1) = 5/8

The detailed filter coefficient settings are mentioned in the DEVCFG1 register. The filter can be turned off by setting the coefficient bits to b'111. The smaller that coefficient is, the more the history, represented by Y (n-1) outputs in

the equation, so it's a tradeoff between response times to change in input value versus the noise attenuation. Refer to the application note in detail for how the filter affects the accuracy performance of MAX17843.

Two new bits are added for the control of the data flow through the filter:

- 1) AMEND Filter (AMENDFILT) bit
- 2) Read Filter (RDFILT) bit

AMENDFILT is in SCANCTRL register 0x13.

This bit when set to '1' enables the automatic transfer of the new ADC conversion from the ALUn to CELLn registers through the IIR filter at the end of the scan. The default value is '0', which keeps the scan conversion data in the ALUn register as an unfiltered result.



Figure 11. IIR Filter Block Diagram

Table 8. AMENDFILT Bit

| AMENDFILT BIT | FUNCTIONALITY AND RECOMMENDED USAGE | |
|---------------|---|--|
| 0 | No transfer of the ADC conversion result from ALUn to CELLn registers. Unfiltered data is stored in ALUn registers at the end of the scan. This bit should be set to '0' during any diagnostic conversion such as open- sense wire, or using balancing switches. | |
| 1 | Automatic transfer of the ADC conversion result from ALUn to CELLn registers at the end of the scan through the IIR filter. Instantaneous unfiltered data is available in ALUn registers while the filtered data is stored in the CELLn registers. This bit should be set to '1' during normal cell-voltage measurements. | |

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RDFILT Bit in SCANCTRL Register (0x13)

This bit chooses where the ADC scan data is read from. Writing this bit to '1' enables the read to occur from filtered CELLn registers. The default value is '0', wherein the read of the scanned data occurs from unfiltered ALUn registers.



Figure 12. IIR Flowchart with Respect to the AMENDFILT Bit

Table 9. RDFILT Bit

| RDFILT BIT | FUNCTIONALITY AND RECOMMENDED USAGE | |
|------------|--|--|
| 0 | Reads UNFILTERED result from the ALUn registers. To read back the result of diagnostic conversion such as open sense wire stored in ALUn registers. | |
| 1 | Reads FILTERED result from the CELLn registers. To read back the cell-voltage measurement data. | |

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IIR filtering will be applicable for CELLn and $\mathsf{V}_{\mathsf{BLKP}}$ results of both the ADCs.

Figure 13. IIR Filter Diagram with Respect to RDFILT

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AUTOBALSWDIS Feature

This feature enables the automatic disabling of the balancing switches during measurements. The main purpose of this feature is to phase out the additional voltage drop due to cell balancing in accuracy measurements. This ultimately allows the system to get more precise cellvoltage readings, which helps to calculate higher accuracy of state-of-charge (SoC). The AUTOBALSWDIS bit is the D11 bit in the DEVCFG1 register. This bit when set to '1' turns off the balancing switches. A delay in the AUTOBALSWDIS delay register (0x0C) is selected based on the DELAYSEL bit in the SCANTCTRL register (0x13), and the set wait time is added after the scan is enabled before the start of actual measurements. The AUTOBALSWDIS delay register has a minimum delay setting of 96µs, with maximum being up to 24.57ms. It is divided into two 8-bit time-delay settings, with lowerbyte register-delay setting for cell-recovery time, while upper byte of the register used for the delay setting of certain diagnostics such as sense-wire open. This delay should be set as appropriate by the customer according to their cell characteristics and properties and to enhance the maximum SoC of the battery available. Once the measurement is executed and the Scan done bit is set, the AUTOBALSWDIS bit should be cleared by the host.

Enabling the AUTOBALSWDIS bit adds a delay before the start of measurements, but after the scan is enabled; therefore, this feature can be used during normal cell measurements as well as during diagnostic measurements with two separate delay timers that can be independently set.



Figure 14. Logic Diagram when Balancing Switches Are Disabled
12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

Acquisition Watchdog Timeout

If the acquisition does not finish within a predetermined time interval, the SCANTIMEOUT bit is set, the ADC logic is reset, the ALU registers are cleared, and the measurement data registers are also cleared. The acquisition watchdog-timeout interval depends on the oversampling configuration, as shown in Table 7.



Figure 15. Acquisition Mode Flowchart

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

Scan Modes

The cell, block, and diagnostic-measurement cycle consists of two conversion phases. In each phase, the ADC scans through the enabled input channels. There are two scan modes configured by the SCANMODE bit. If SCANMODE = 0, the mode is pyramid mode, as shown in <u>Figure 16</u>. If SCANMODE = 1, the mode is top-down mode. In pyramid mode, the ADC scans first ascending and then descending. In top-down mode, the ADC scans descending in both phases. In the second scan, the amplifier inputs are inverted to effectively chop out any offset and reference-induced errors. The two conversions are then offset corrected and averaged in the ALU.

After the cell and block scans are complete, the diagnostic conversions are made, if enabled, and finally, the auxiliary inputs, if enabled, are converted. The auxiliary inputs are measured using a single conversion and stored in the AIN1 and AIN2 registers. Any extra settling time, if configured by AINCFG[5:0], is implemented just before the conversion for each AUXIN channel, so if both inputs are enabled, the extra settling time occurs twice.



Figure 16. Acquisition, OVSAMP[2:0]=0h and SCANMODE=0



Figure 17. Acquisition, OVSAMP[2:0] > 0 and SCANMODE=0

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Acquisition Time

The total acquisition time can be calculated by summing all the required processes, as shown in <u>Table 10</u> and <u>Table 11</u>. There is one measurement cycle per oversample.

| PROCESS | TIME (μs) | CONDITION | FREQUENCY | |
|---------------------------------------|-------------------|---|---|--|
| Initialization | 13 | Always | Once per acquisition | |
| V _{BLKP} measurement | 27 | If V _{BLKP} is enabled | | |
| | 12.5 | If cell input(s) enabled and V _{BLKP} enabled | | |
| Cell scan setup | 20 | If cell input(s) enabled and V _{BLKP} disabled | | |
| Cell scans | 9 x n | For n = Number of enabled cell inputs | | |
| | 11.4 | If zero-scale ADC output diagnostic enabled | Every measurement cycle | |
| Diagnostic | 11.4 | If full-scale ADC output diagnostic enabled |] | |
| measurement | 86.2 | If V _{ALTREF} diagnostic enabled | | |
| (if enabled) | 86.2 | If die temperature diagnostic enabled | | |
| | 22.9 | If any other diagnostic mode enabled | | |
| | 10 | | | |
| AUXIN measurement | 6µs x AINCFG[5:0] | If AUXIN1 is enabled | Once per acquisition | |
| (if enabled) | 10 | Once per acquisitio | | |
| | 6µs x AINCFG[5:0] | If AUXIN2 is enabled | | |
| HV recovery (if oversampling enabled) | 100.3 x m | For m = Number of oversamples | After every measurement cycle except the last | |

Table 10. Acquisition Time

Table 11. Acquisition Time Examples (with AINCFG[5:0] = 00h)

| ENABLED MEASUREMENTS | NO OVERSAMPLING | FOUR OVERSAMPLES | EIGHT OVERSAMPLES |
|---|-----------------|------------------|-------------------|
| 12 cells | 141.0µs | 825.9µs | 1739.1µs |
| 12 cells, V _{BLKP} | 160.5µs | 903.9µs | 1895.1µs |
| 12 cells, AUXIN1 and AUXIN2 | 161.0µs | 845.9µs | 1759.1µs |
| 12 cells, V _{BLKP} , AUXIN1 and AUXIN2 | 180.5µs | 923.9µs | 1915.1µs |
| 12 cells, V _{BLKP} , die temperature, AUXIN1 and AUXIN2 | 266.7µs | 1268.7µs | 2604.7µs |

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Measurement Alerts

After the measurement cycle, the ALU compares the enabled measurements to the various configured thresholds, as shown in <u>Table 12</u>, and sets the alert bits before the ALU data is transferred to the data registers. In oversampling mode, the alert status is updated after the last oversample. The alerts are updated whether or not the data is moved from the ALU registers to the data registers and are only updated for those measurements enabled in the MEASUREEN register.

Voltage Alerts

Use the ALRTOVEN and ALRTUVEN registers to enable voltage alerts for the cell and auxiliary inputs. If a cell-voltage alert is enabled, the cell input voltage is compared against the programmable overvoltage and undervoltage thresholds after every acquisition as shown in Figure 14. Separate thresholds for both setting and clearing the alert provide hysteresis. Configure the set thresholds for cell undervoltage (V_{UVTHSET}) and overvoltage (V_{OVTHSET}) using the UVTHSET and OVTHSET registers. Configure the clear thresholds for cell undervoltage (V_{UVTHSET}) and cell overvoltage (V_{OVTHCLR}) using the UVTHCLR and OVTHCLR registers.

Alert flags in the ALRTOVCELL register are set, if enabled, when the acquired cell voltage is over $V_{OVTHSET}$. Alerts in the ALRTUVCELL register are set, if enabled, when the acquired cell voltage is under $V_{UVTHSET}$. The alerts are cleared when the cell voltage moves in the opposite direction and crosses the clear threshold. The voltage must cross the threshold; if it is equal to a threshold, the alert flag does not change. Therefore, setting the overvoltage

set threshold to full scale, or setting the undervoltage set threshold to zero scale, effectively disables voltage alerts.

The ALRTOV and ALRTUV bits in the STATUS register are set when any alert flag is set in the ALRTOVCELL or ALRTUVCELL registers, respectively. ALRTCELL[n] is the logical OR of ALROVCELL[n] and ALRTUVCELL[n].

Cell Mismatch

Enable the mismatch alert to signal when the minimum and maximum cell voltages differ by more than a specified voltage. The MSMTCH register sets the 14-bit threshold (V_{MSMTCH}) for the mismatch alert (ALRTMSMTCH). Whenever $V_{MAX} - V_{MIN} > V_{MSMTCH}$, then ALRTMSMTCH = 1. The alert bit is cleared when a new acquisition does not exceed the threshold condition. To disable the alert, write FFCH to the MSMTCH register (default value).

Cell Statistics

The cell numbers with the lowest and highest voltages are stored in the MINMAXCELL register. When multiple cells have the same minimum or same maximum voltage, only the highest cell position having that voltage is reported. The sum of all enabled cell voltages is stored in the TOTAL register as a 16-bit value. For acquisitions with no enabled cell inputs, the MINMAXCELL and TOTAL registers are not updated.

Temperature Alerts

Temperature alerts, if enabled, occur when the acquired AUXINx input voltages fall outside the thresholds configured by the AINOT and AINUT registers. Unlike the cell-voltage alerts, the temperature thresholds do not have the hysteresis afforded by separate set and clear thresholds.

| DESCRIPTION | CONDITION OR RESULT | ALERT BIT | LOCATION |
|--|---|-----------------------|--------------------|
| Cell overvoltage (OV) | V _{Cn} - V _{Cn-1} > V _{VOVTHSET} | ALRTOV, ALRTOVn | STATUS, ALRTOVCELL |
| Cell undervoltage (UV) | V _{Cn} - V _{Cn-1} < V _{UVTHSET} | ALRTUV, ALRTUVn | STATUS, ALRTUVCELL |
| Cell mismatch | V _{MAX} - V _{MIN} > V _{MSMTCH} | ALRTMSMTCH | STATUS |
| Cell with minimum voltage | n where V _{CELLn} = V _{MIN} | None | MINMAXCELL |
| Cell with maximum voltage | n where V _{CELLn} = V _{MAX} | None | MINMAXCELL |
| Total of all cell voltages | ΣV_{CELLn} where n = 1–12 | None | TOTAL |
| AUXINx overvoltage (undertemperature) | V _{AUXINx} > V _{AINUT} | ALTRTCOLD, ALRTOVAINx | STATUS, ALRTOVCELL |
| AUXINx undervoltage (overtemperature) | V _{AUXINx} < V _{AINOT} | ALRTHOT, ALRTUVAINx | STATUS, ALRTUVCELL |

Table 12. Measurement Alerts

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

Cell Balancing

Cell-Balancing Switches

Cell balancing can be performed using any of the 12 internal cell-balancing switches to discharge cells. The cellbalancing current is limited by the external balancing resistors and the internal balancing switch resistance (R_{SW}). Enabling adjacent balancing switches simultaneously may increase the balancing current significantly, so care must be taken to not exceed the device's maximum operating conditions. Fault detection is described in the *Diagnostics* section.



Figure 18. Cell Voltage-Alert Thresholds



Figure 19. Internal Cell Balancing

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Maximum Cell-Balancing Current

The maximum balancing current is limited by package power dissipation, average die temperature, average duty cycle of the switch, and the number of switches conducting current at any one time.

The power dissipation must not exceed the absolute maximum rating of the package, nor should the die temperature go outside the range specified for the desired level of measurement accuracy. Higher die temperatures and higher average duty cycles increase the probability of internal electromigration, so the maximum balancing current is lowered accordingly, as shown in <u>Table 13</u> for an assumed 10-year device lifetime.

Cell-Balancing Watchdog

Even if the host fails to disable the cell-balancing mode, the cell-balancing watchdog can automatically disable the cell-balancing switches regardless of the BALSWEN configuration. The cell-balancing watchdog does not modify the contents of the BALSWEN register. Use the WATCHDOG register to configure the timeout value from 1s to 3840s (64min), as shown in <u>Table 14</u>. The pre-divider configuration CBPDIV[2:0] effectively sets the rate at which the CBTIMER[3:0] counts down (see Figure 20).

Table 13. Maximum Allowed Balancing Current per Switch

| AVERAGE LIFETIME DUTY CYCLE (10 YEARS) | T _{DIE} = 85°C | T _{DIE} = 105°C | T _{DIE} = 125°C |
|---|-------------------------|--------------------------|--------------------------|
| 15% | > 320mA | > 320mA | 215mA |
| 20% | > 320mA | 320mA | 161mA |
| 25% | > 320mA | 256mA | 129mA |

Table 14. Cell-Balancing Watchdog Configuration

| | TIMER LSb PERIOD | RANGE OF C | BTIMER[3:0] | |
|-------------|------------------|----------------|-------------|--|
| CBPDIV[2:0] | | MINIMUM | MAXIMUM | |
| 000b | Timer Disabled | Timer Disabled | | |
| 001b | 1s | 1s | 15s | |
| 010b | 4s | 4s | 60s | |
| 011b | 16s | 16s | 240s | |
| 100b | 64s | 64s | 960s | |
| 101b | 128s | 128s | 1920s | |
| 110b | 256s | 256s | 3840s | |



Figure 20. Cell-Balancing Watchdog

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

The host should periodically update CBTIMER to ensure that it does not count down to zero. If the countdown timer is allowed to reach zero, the cell-balancing switches are disabled until the timer is either disabled or refreshed by writing a nonzero value.

To allow timed balancing with no host interaction, the GPIO3 pin is configured to output a logic-high level while the timer is counting using the GPIO3TMR configuration bit of the GPIO register. An external diode is connected from GPIO3 to SHDNL to prevent shutdown while the timer is counting. Once the timer expires, the device shuts down. The host may intervene prior to the timer expiring to keep the device active and to reconfigure the device.

Emergency-Discharge Mode

The emergency-discharge mode performs cell-balancing in a controlled manner so the cells can be discharged to a safe level in the event of an emergency. The BALSWDCHG and DEVCFG1 registers provide control for this mode. A timeout value for the mode is configured by DISCHGTIME[7:0], as shown in Table 15.

The emergency-discharge mode is activated by setting the EMGCYDCHG bit with DCHGTIME[7:0] \neq 00h. In emergency-discharge mode, the following occurs:

- 1) The CBTIMER[3:0] is cleared to prevent the cellbalancing watchdog from disabling the cell balancing.
- 2) Cell-balancing switches are controlled by BALSWDCHG, not BALSWEN.
- 3) The discharge timer starts to count down.

- Read-only counter DCHGCNTR[3:0] increments at a 2Hz rate with periodic rollover at Fh. The host can read this counter periodically to confirm the mode is active.
- 5) The GPIO3 pin is driven high while the countdown is active.

The emergency-discharge mode alternates between a 1-minute discharge cycle for odd cells and a 1-minute discharge cycle for even cells. There is a 62.5ms minimum off-time at the end of each discharge cycle to ensure no overlap between even and odd discharge cycles. The duty cycle of each discharge cycle can be configured by DCHGWIN[2:0], as shown in Table 15.

By clearing EMGCYDCHG, the emergency-discharge mode terminates and the following occurs:

- 1) The discharge timer is reset.
- 2) Control of the cell-balancing switches reverts to the BALSWEN register.
- 3) Control of GPIO3 reverts to the GPIO register.

The emergency-discharge mode also terminates if DCHGTIME[7:0] = 0h or the discharge time has reached the configured timeout.

To prevent the emergency-discharge mode from terminating prematurely due to a device shutdown (which could occur due to an extended lapse in host communications), connect an external diode from GPIO3 to SHDNL to keep SHDNL high while the timer is counting.

Table 15. Emergency Discharge Mode

| FUNCTION | REGISTER FIELD | CONFIGURATION | BEHAVIOR |
|------------|------------------------------|---------------|---|
| | | Oh | Switches on for 7.5s, off for 52.5s |
| Duty avala | DCHGWIN[2:0] | 1h | Switches on for 15s, off for 45s |
| Duty cycle | 7.5s/bit | | |
| | | 7h | Switches on for 59.94s, off for 62.5ms |
| | | | |
| | | 00h | Discharge mode disabled |
| | | 01h | Discharge mode disabled after 4 hours |
| Timeout | DCHGTIME[7:0] 2 hours/bit | 02h | Discharge mode disabled after 6 hours |
| | | | |
| | | FFh | Discharge mode disabled after 512 hours |

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

Low-Voltage Regulator

An internal linear regulator supplies low-voltage power (V_{AA}) for the ADC and digital logic. The regulator is disabled when SHDNL is active-low or when the die temperature (T_{DIE}) exceeds 145°C. Once V_{AA} decays below 2.95V (typ), an internal power-on reset (POR) is gener-

ated (see Figure 21). This event can be detected with the ALRTRST bit, as shown in Table 16. After a thermal shutdown, the regulator is not enabled until $T_{DIE} < 130^{\circ}C$ due to hysteresis.

The low-voltage regulator is continuously monitored for undervoltage, as described in Table 17.

Table 16. Low-Voltage Regulator

| INPUT: | DCIN |
|-----------------|---|
| INPUT VOLTAGE: | 9V to 65V |
| OUTPUT: | V _{AA} |
| OUTPUT VOLTAGE: | 3.3V |
| DISABLE: | V _{SHNDL} < 0.6V or T _{DIE} > 145°C |

Table 17. Low-Voltage Regulator Diagnostic

| FAULT | CONDITION | ALERT | LOCATION |
|------------------------------|-------------------------|---------|------------|
| V _{AA} undervoltage | V _{AA} < 2.95V | ALRTRST | STATUS[15] |



Figure 21. Low-Voltage Regulator

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

HV Charge Pump

The high-voltage multiplexers must be powered by a supply higher than any monitored voltage. To this end, an internal charge pump draws power from the DCIN input to provide a high-voltage supply (V_{HV}) that is regulated to V_{DCIN} + 5.5V (nominal). When the charge pump achieves regulation, charge pumping stops until the voltage drops by 20mV. The charge pump is automatically disabled during shutdown and during the measurement cycle to eliminate charge-pump noise. The charge pump can also be disabled manually by setting the HVCPDIS bit in the DEVCFG2 register.

If $V_{HV}\!-\!V_{DCIN}$ drops below $V_{HVUV},$ the HV undervoltage flag (ALRTHVUV) is set. If V_{HV} drops too low relative to

Table 18. HV Charge-Pump Diagnostics

the C12 input, there is insufficient headroom to guarantee that HVMUX switch resistance is sufficiently low for an accurate acquisition of the channel. To properly identify this fault condition, if $V_{HV}-V_{C12}$ is too low during the acquisition, the HV headroom-alert flag (ALRTHVHDRM) is set in the FMEA2 register. The HV undervoltage and HV headroom-alert functions can be verified by disabling the HV charge pump (HVCPDIS = 1) and allowing V_{HV} to decay while in acquisition mode. An overvoltage comparator disables the charge pump in the case where $V_{HV}-V_{DCIN}$ exceeds 8.5V. This condition is indicated by the ALRTHVOV bit in the FMEA2 register. The ALRTHVOV alert does not necessarily indicate a condition that affects measurement accuracy. HV charge-pump diagnostics are summarized in Table 18.

| FAULT | CONDITION | ALERT BIT | LOCATION |
|------------------------------|--|------------|----------|
| V _{HV} undervoltage | V _{HV} –V _{DCIN} < V _{HVUV} | ALRTHVUV | FMEA1[3] |
| V _{HV} overvoltage | V _{HV} –V _{DCIN} > V _{HVOV} | ALRTHVOV | FMEA2[0] |
| V _{HV} low headroom | V _{HV} –V _{C12} < V _{HVHDRM} (min.) | ALRTHVHDRM | FMEA2[2] |



Figure 22. HV Charge Pump

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

Oscillators

Two factory-trimmed oscillators provide all timing requirements: a 16MHz oscillator for the UART and control logic, and a 32.768kHz oscillator for HV charge pump and timers. A special diagnostic counter clocked by the 16MHz signal is employed to check the 32kHz oscillator. Every two periods of the 32kHz clock, the counter is sampled. If the count varies more than 5% from the expected value, the ALRTOSC1 bit is set, as shown in <u>Table 19</u>. A redundant alert bit (ALRTOSC2) increases the integrity level. If the 16MHz oscillator varies by more than 5%, communication errors are indicated.

Device ID Number

The ID1[15:0] register, together with ID2[7:0], contain a 24-bit manufacturing identification number (DEVID[23:0]). The ID, combined with the manufacturing date, provides a means of uniquely identifying each device. A device ID of zero is invalid.

Power-On And Shutdown

Applications that remain connected continuously to the power source rely on the SHDNL input to shut down and reset the device. When $V_{SHDNL} < 0.6V$, the regulator is disabled, the POR signal asserted, and the device goes into an ultra-low-power-shutdown mode. When $V_{SHDNL} > 1.8V$, POR is deasserted, the regulator is enabled, and the device becomes fully operational in the standby mode.

Power-On Method

The SHNDL input can be driven externally, or can be controlled using UART communication only. In differential mode, the signaling on the lower-port receiver drives an internal charge pump that charges up the external 1nF capacitor connected to the SHDNL input (see Figure 23). V_{SHDNL} reaches 1.8V in 200µs (typ). The charge pump then self-regulates to V_{SHDNLIMIT} and can maintain V_{SHDNL} at a logic-one even with the UART in idle 98% of the time.

| FAULT | CONDITION | ALERT BIT | LOCATION |
|----------------------|--|--------------------|---------------------|
| 32.768kHz oscillator | 31.129kHz > f _{osc_32k} > 34.406kHz | ALRTOSC1 | FMEA115 |
| 32.768kHz oscillator | 31.129kHz > f _{osc_32k} > 34.406kHz | ALRTOSC2 | FMEA114 |
| 16MHz oscillator | 15MHz > f _{osc_32k} > 17MHz | ALRTMAN or ALRTPAR | STATUS4, or STATUS2 |



Figure 23. SHDNL Charge Pump

Table 19. Oscillator Diagnostics

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Power-On Sequence

Once $V_{SHNDL} > 1.8V$, the regulator is enabled. After V_{AA} reaches 3V (typ), the POR signal is deasserted, the oscillators enabled, and the HV charge pump enabled. Once the HV charge pump is stable, the logic is enabled. The

device is fully operational (standby mode) within 1ms from the time communication is first received in the shutdown mode. The power-on sequence is shown in Figure 24.



Figure 24. Power-On Sequence

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Shutdown Mode

Shutdown is performed by bringing $V_{SHDNL} < 0.6V$. Table 20 summarizes the methods by which this can be achieved.

The quickest shutdown can be achieved by driving SHDNL externally with a driver pulldown impedance not exceeding 1k Ω . If SHDNL is not driven externally, the host can discharge C_{SHDNL} under software control by setting the FORCEPOR bit. This will enable a pulldown (4.7k Ω nominal) to discharge the capacitor with a 4.7 μ s time constant.

The slowest method is for the host to simply cease communication. With the UART idle, there is no charge pumping and the capacitor discharges through an internal 10M Ω resistor, with a 10ms time constant. If shutdown faster than 10ms is desired when power is disconnected from the device, a 200k Ω resistor can be connected externally from SHDNL to AGND to create a 200µs time constant.

If only a reset is required, the host can issue a soft-reset by setting the SPOR bit. This resets the device registers and disables high-voltage operation, but low-voltage operation remains enabled (the regulator is not disabled).

Note: For single-ended communication, SHDNL must be driven externally since the charge-pump operation requires a differential signal.

Shutdown Sequence

The shutdown sequence and timing is shown in Figure 25, Figure 26, and Figure 27. The ALRTSHDNL status bit is set and the low-voltage regulator disabled as soon as $V_{SHNDL} < 0.6V$. When the V_{AA} and V_{DDL} decoupling capacitors discharge below the POR threshold (2.95V typ), the device registers are reset and the HV charge pump disabled. The device is then in an ultra-low-power state until $V_{SHDNL} > 1.8V$.

Table 20. Shutdown Timing

| SHUTDOWN METHOD | R _{PULL} | DOWN | C _{SHDNL} | RC |
|----------------------------------|-------------------|----------|--------------------|----------|
| 1. Host drives SHDNL pin low | 1kΩ | External | | 1µs |
| 2. Host sets FORCEPOR bit | 5kΩ | Internal | 1 m F | 5µs |
| 3. Disconnect DCIN | 200kΩ | External | 1nF | 200µs |
| 4. Host places UART in idle mode | 10MΩ | Internal | | 10,000µs |



Figure 25. Shutdown Sequence

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface



Figure 26. Power-On and Shutdown Timing (UART Control)



Figure 27. Shutdown Timing (Software Control)

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

UART Interface

The battery-management UART protocol allows up to 32 devices to be connected in daisy-chain fashion (see Figure 28). The host initiates all communication with the daisy-chain devices through a UART interface such as the MAX17841B. The data flow is always unidirectional from the host, up the daisy-chain (upstack) and then loops back down the daisy-chain (downstack) to the host.

Each device first receives data at its lower RX port and immediately retransmits data from its upper TX port to the lower RX port of the next upstack device. The last device transmits data from its upper TX port directly into its upper RX port and then immediately retransmits the data from its lower TX port to the upper RX port of the next downstack device. The protocol supports fixed baud rates of 2Mb/s, 1Mb/s, or 0.5Mb/s. The baud rate is set by the host and is automatically detected by the device.



Figure 28. System Data Flow

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UART Ports

Two UART ports are utilized, a lower port (RXL/TXL) and an upper port (RXU/TXU). Each port consists of a differential line driver and differential line receiver. DC-blocking capacitors or transformers can be used to isolate daisychain devices that are operating at different commonmode voltages. During communication, the character encoding provides a balanced signal (50% duty cycle) that ensures charge neutrality on the isolation capacitors.

UART Transmitter

When no data is being transmitted by the UART, the differential outputs must be driven to a common level to maintain a neutral charge difference between the AC-coupling capacitors or to avoid saturation of the isolation transformers. In the default idle mode (low-Z), the transmitter drives both outputs to a logic-low level to balance the charge on the capacitors; this also works well with transformer coupling. The high-Z idle mode (TXLHIZIDLE, TXUHIZIDLE = 1) places the TX pins in a high-Z state in idle mode, which may be desirable to minimize the effects of charging and discharging the isolation capacitors. The idle mode for the upper and lower ports can be controlled independently through the TXLHIZIDLE and TXUHIZIDLE configuration bits.

UART Receiver

The UART receiver has a wide common-mode input range to tolerate harsh EMC conditions, which can be operated in differential mode or single-ended mode per <u>Table 21</u>. By default, the UART receivers are configured for differential mode. In single-ended mode, the RXP input is grounded and the RXN input receives inverse data, as described in the <u>Applications Information</u> section. In single-ended mode, the receiver input threshold is negative so that a zero differential voltage (V_{RXP}, V_{RXN} = 0V) is considered to be a logic-one and a negative differential voltage (V_{RXN} high) is a logic-zero.

UART RX Modes

During the first preamble received after a reset, the receiver automatically detects if the received signal is singleended and if so, places the receiver in single-ended mode; therefore, the device must be reset for any change in the RX-mode hardware configuration to be detected.

The receiver mode is indicated by the ALRTCOMMSEL bit (for lower port) and ALRTCOMMSEU bit (for upper port) of the FMEA1 register, as shown in <u>Table 21</u>. If the RXP input is open circuit, RX-mode detection places the UART in single-ended mode so the port can still operate, albeit with reduced noise immunity. The host can diagnose this condition by checking ALRTCOMMSEL and ALRTCOMMSEU after any POR event. Any other faults result in communication errors.



Figure 29. UART Transmitter

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Figure 30. UART Receiver

Table 21. UART RX Modes

| RXP | RXN | ALRTCOMMSEn | RX MODE |
|----------------------|---------------------------|-------------|--|
| Connected to data | Connected to inverse data | 0 | Differential mode (normal) |
| Grounded | Connected to inverse data | 1 | Single-ended mode (normal) |
| Open circuit (fault) | Connected to inverse data | 1 | Single-ended mode (low noise immunity) |
| Connected to data | Open circuit (fault) | 0 | Differential mode (communication errors) |

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UART Loopback

For the last device in the stack, the data must be looped back from the upper transmitter to the upper receiver. This is known as loopback and can be configured externally (default) or internally.

External Loopback Mode

External loopback mode (default) uses a two-wire cable to connect the upper transmitter (TXU) to the upper receiver (RXU). The external loopback has two advantages:

- It is quicker to determine device count for applications where the host does not assume what the device count is.
- 2) It helps to match the supply current of the last device to that of the other daisy-chain devices (because the hardware configuration is identical).

Internal Loopback Mode

Internal-loopback mode (LASTLOOP = 1) routes the upper-port transmit data internally to the upper-port receiver. Any signal present on the upper-port receiver input pins is ignored in the internal loopback mode; therefore, when LASTLOOP is set, the write command that was forwarded to any upstack devices is interrupted in the downstack direction. The host should expect this and read the LASTLOOP bit to verify that the write was successful. If the MAX17841B interface is used, its receive buffer should be cleared before changing LASTLOOP, and cleared again after changing the loopback configuration because the communication was interrupted.

Internal-loopback mode is useful to diagnose the location of a daisy-chain signal break by enabling the internal-loopback mode on the first device, checking communication, then moving the loopback mode to the next device, and continuing up the stack until communication is lost.

Baud Rate Detection

The UART can operate at a baud rate of 2Mb/s (default), 1Mb/s, or 0.5Mb/s. The baud rate is controlled by the host and is automatically detected by the device when the first preamble character is received after reset. If the host changes the baud rate after reset, it must issue another reset, which can be done by setting the SPOR bit, and resend a minimum of $2 \times n$ preambles (where n is the number of devices). The $2 \times n$ preambles are necessary since the transmitter for the upper port will not transmit data until the lower-port receiver has detected the baud rate; likewise, the transmitter on the lower port will not transmit data until the upper-port receiver has detected

the baud rate. A simple way to do this is for the host to start transmitting preambles and stop when a preamble has been received back at the host RX port.

TX Adaptive Mode for Single-Ended Mode

To overcome the error tolerance limitation when connecting a MAX17843 to a conventional UART port, an adaptive transmit-timing feature has been added. The feature works by monitoring the location of the incoming Manchester transitions at the RXL port, with respect to the local clock, to calculate a correction factor. This correction factor is then applied to the TXL port so the outgoing downstack signal has similar timing characteristics to the incoming upstack signal. With this adaptive transmit timing, the interface between a conventional UART node and a Maxim proprietary battery-monitoring system node has a tolerance for baud-rate mismatch that is much higher than that of the conventional receiver port alone giving a high level of timing margin for direct connection applications. TX adaptive mode should be enabled only on the bottom device (device connected to BMS micro or Maxim SPI-to-UART bridge IC).

Battery-Management UART Protocol

The battery-management UART protocol uses the following features to maximize the integrity of the communications:

- All transmitted data bytes are Manchester-encoded, where each data bit is transmitted twice with the 2nd bit inverted (G.E. Thomas convention).
- Every transmitted character contains 12 bits that include a start bit, a parity bit, and two stop bits.
- Read/write packets contain a CRC-8 packet error checking (PEC) byte
- Each packet is framed by a preamble character and STOP character.
- Read packets contain a data-check byte for verifying the integrity of the transmission.

The protocol is also designed to minimize power-"consumption by allowing slave devices to shut down if the UART is idle for a specified period of time. The host must periodically transmit data to prevent shutdown, unless the SHDNL input is driven externally.

12-Channel, High-Voltage Smart Sensor **Data-Acquisition Interface**

Command Packet

A command packet is defined as a sequence of UART characters originating at the host. Each packet starts with a preamble character, followed by data characters, and ending with a stop character (see Figure 31). After sending a packet, the host either goes into idle mode or sends another packet.

Preamble Character

The preamble is a framing character that signals the beginning of a command packet. It is transmitted as an unencoded 15h with a logic-one parity bit and a balanced duty cycle. If any bit(s) other than the stop bits deviate from the unique preamble sequence, the character is not interpreted as a valid preamble, but rather as a data character.



Figure 31. Command Packet



Figure 32. Preamble Character

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Data Characters

Each data character contains a single-nibble (4-bit) payload, so two characters must be transmitted for each byte of data. All data is transmitted least-significant bit, leastsignificant nibble, and least-significant byte first. The data itself is Manchester encoded, which means that each data bit is followed by its complement. If the UART detects a Manchester-encoding error in any received data character, it will set the ALRTMAN bit in the STATUS register. The parity is even, which means that the parity bit's value should always result in an even number of logic-one bits in the character. Given that the data is Manchester encoded and that there are two stop bits, the parity bit for data characters is always transmitted as a logic-zero. If the UART detects a parity error in any received data character it sets the ALRTPAR bit in the STATUS register.

See <u>Table 22</u> for a list of data characters and <u>Figure 33</u> for a graphical representation.

Table 22. Data Character

| BIT | NAME | SYMBOL | DESCRIPTION | |
|-----|--------|--------|---|--|
| 1 | Start | S | First bit in character, always logic-zero | |
| 2 | Data0 | | Least-significant bit of data nibble (true) | |
| 3 | Data0/ | — | Least-significant bit of data nibble (inverted) | |
| 4 | Data1 | | Data bit 1 (true) | |
| 5 | Data1/ | | Data bit 1 (inverted) | |
| 6 | Data2 | | Data bit 2 (true) | |
| 7 | Data2/ | | Data bit 2 (inverted) | |
| 8 | Data3 | — | Most-significant bit of data nibble (true) | |
| 9 | Data3/ | — | Most-significant bit of data nibble (inverted) | |
| 10 | Parity | E | Always logic-zero (even parity) | |
| 11 | Stop | Р | Always logic-one | |
| 12 | Stop | Р | Last bit in character, always logic-one | |



Figure 33. Data Characters

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

Stop Character

The stop character is a framing character that signals the end of a command packet. It is transmitted as an unencoded 54h with a logic-one parity bit and a balanced duty cycle (see Figure 34).

UART Idle Mode

In the low-Z (default) idle mode, the transmitter outputs are both driven to 0V (see <u>Figure 35</u>). In the high-Z idle mode, the transmitter outputs are not driven by the UART. The MAX17841B interface automatically places its transmitter in idle mode immediately after each command packet and remains in idle mode until either the next command packet is sent or it goes into keep-alive mode, sending periodic stop characters to prevent the daisy-chain device(s) from going into shutdown.

UART Communication Mode

When transitioning from idle mode to communication mode, the TXnP pin must be pulled high (logic-one) prior to signaling the start bit (logic-zero) (see Figure 35). The duration of the logic-one is minimized to maintain a balanced duty-cycle while still meeting the timing specification. When transitioning from the stop bit back to idle mode, the delay, if any, is also minimized.



Figure 34. Stop Character



Figure 35. Communication Mode

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Data Types

The battery-management UART protocol employs several different data types, as described in Table 23.

Command Bytes

The battery-management UART protocol supports six command types summarized in <u>Table 24</u>.

Command-Byte Encoding

Command bytes encoding is described in <u>Table 25</u>. For READDEVICE and WRITEDEVICE commands, the device address is encoded in the command byte. The device ignores commands containing a device address other than its own.

Register Addresses

All register addresses are single-byte quantities and are defined in the <u>Register Map</u>. In general, if the register or device address in a received command is not a valid address for the device, the device ignores the read or write and simply passes through the packet to the next device.

Register Data

All registers are 16-bit words (two data bytes) and are defined in the *Register Map*.

Table 23. Battery-Management UART Protocol (Data Types)

| DATA TYPE | DESCRIPTION |
|------------------|---|
| Command byte | A byte defining the command-packet type, generally either a read or a write. |
| Register address | A byte defining the register address to be read or written. |
| Register data | Register data bytes being read or written. |
| Data-check byte | An error and alert status byte sent and returned with all reads. |
| PEC byte | A packet-error-checking byte sent and returned with every packet except for HELLOALL. |
| Alive counter | A byte functioning as a device counter on all reads and writes, if ALIVECNTEN = 1. |
| Fill byte | Bytes transmitted in READALL command packets for clocking purposes only. |

Table 24. Battery-Management UART Protocol (Command Packet Types)

| COMMAND | DESCRIPTION | DATA CHECK | PEC | ALIVE- COUNTER | PACKET SIZE (CHARACTERS) |
|-------------|---|---------------|-----|-------------------|-----------------------------|
| HELLOALL | Writes a unique device address to each device in the daisy-chain. Required for system initialization. | No | No | No | 8 |
| WRITEALL | Writes a specific register in all devices. | No | Yes | Yes | 14 |
| WRITEDEVICE | Writes a specific register in a single device. | No | Yes | Yes | 14 |
| READALL | Reads a specific register from all devices. | Yes | Yes | Yes | 12 + (4z) |
| READDEVICE | Reads a specific register from a single device. | Yes | Yes | Yes | 16 |
| READBLOCK | Reads a set of registers from a single device. | Yes | Yes | Yes | 14 + (4 x BS) |

Notes: z = Total number of devices, ALIVECNTEN = 1, packet size includes framing characters. BS[4:0] = Block size[4:0] = 1–32, which is the number of registers read.

Table 25. Command-Byte Encoding

| COMMAND | BYTE* | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------|-----|-----|-----|-----|-----|---|---|---|
| HELLOALL | 57h | 0 | 1 | 0 | 1 | 0 | 1 | 1 | 1 |
| WRITEDEVICE | 04h | DA4 | DA3 | DA2 | DA1 | DA0 | 1 | 0 | 0 |
| WRITEALL | 02h | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 |
| READDEVICE | 05h | DA4 | DA3 | DA2 | DA1 | DA0 | 1 | 0 | 1 |
| READALL | 03h | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 |
| READBLOCK | 06h | BS4 | BS3 | BS2 | BS1 | BS0 | 1 | 1 | 0 |

***Notes:** Assumes DA[4:0] = 0x00 where DA[4:0] is the device address in the ADDRESS register. BS[4:0] = Block size (1–32).

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Data-Check Byte

The host uses the returned data-check byte to promptly determine if any communication errors occurred during the packet transmission and to check if alert flags are set in any devices, as shown in <u>Table 26</u>. The data-check byte is returned by the READALL and READDEVICE commands. For READDEVICE, the data-check byte is updated only by the addressed device.

The data-check byte sent by the host is a seed value normally set to 00hN although nonzero values can be used as a diagnostic. Each device logically ORs the received data-check byte with its own status and transmits it to the next device. A PEC error detected by any device will set the ALRTPEC bit in the STATUS register and, by extension, the ALRTPEC and ALRTSTATUS bits in the datacheck byte.

PEC Byte

The PEC byte is a CRC-8 packet-error check sent by the host with all read and write commands. If any device receives an invalid PEC byte, it sets the ALRTPEC bit in the STATUS register. During any write transaction, a device does not execute the write command internally unless the received PEC matches the expected calculated value. For read commands, the device must return its own calculated PEC byte based on the returned data. The host should verify that the received PEC byte matches the calculated value and if an error is indicated, the data should be discarded. See <u>Applications Information</u> section for details on the PEC calculation.

Alive-Counter Byte

The alive-counter byte is the last data byte of the command packets (except HELLOALL) if the ALIVECNTEN bit is set in the DEVCFG1 register. The host typically transmits the alive-counter seed value as 00h, but any value is permitted. For WRITEALL or READALL commands, each device retransmits the alive counter, incremented by one. For WRITEDEVICE or READDEVICE commands, only the addressed device will increment it. The alive counter is not used in the HELLOALL command. If the alive counter reaches FFh, the next device increments it to 00h.

Since the alive counter comes after the PEC byte, an incorrect PEC value does not affect the incrementing of the alive-counter byte. Also, the PEC calculation does not include the alive-counter byte. The host should verify that the alive counter equals the original seed value + the number of devices, considering that if the alive-counter reaches FFh, the next device increments it to 00h.

Fill Bytes

In the READALL command, the host sends two fill bytes for each device in the daisy-chain. The fill bytes are the locations within the packet and are used by the device to place the read data. The fill-byte values transmitted by the MAX17841B interface alternate between C2h and D3h. As the command packet propagates through the device, the device overwrites the appropriate fill bytes with the register data. The device uses the ADDRESS register to determine which specific fill bytes in the packet are to be overwritten.

For a READDEVICE command, only two fill bytes are required since only one device responds (returning two data bytes). Also, fill bytes are not required for write commands because the data received is exactly the same as the data retransmitted.

| BIT | NAME | DESCRIPTION |
|-----|------------|--|
| 7 | ALRTPEC | ALRTPEC is set. |
| 6 | ALRTFMEA | ALRTFMEA1 or ALRTFMEA2 is set. |
| 5 | ALRTSTATUS | STATUS bit other than ALRTFMEA1, ALRTFMEA2, ALRTOV, and ALRTUV is set. |
| 4 | CHECK | Check bit. Value received is forwarded. |
| 3 | CHECK | Check bit. Value received is forwarded. |
| 2 | ALRTOV | ALRTOV is set. |
| 1 | ALRTUV | ALRTUV is set. |
| 0 | CHECK | Check bit. Value received is forwarded. |

Table 26. Data-Check Byte

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Battery-Management UART Protocol Commands

HELLOALL Command

The purpose of the HELLOALL command is to initialize the device addresses of all daisy-chained devices. The device address is stored in the DA[4:0] bits of the ADDRESS register. The highest address possible is 0x1F, so a maximum of 32 devices can be addressed. The command must be issued after POR to reinitialize all device addresses.

When the HELLOALL command is first sent by the host, the address specified in the HELLOALL command is stored to the DA[4:0] bits of the ADDRESS register in the first daisy-chained device. The command is then forwarded to the next device in the chain, with the DA[4:0] bits of the address byte incremented by 1, as shown in Table 27. This continues in the upstack direction for each device. The downstack communication path does not increment the address. The advantage of the host choosing a first address FA[4:0] to all the devices since the default value of FA[4:0] is 0x00. Note: The host should set the first address so that no assigned device address increments from 0x1F to 0x00 during the HELLOALL command.

The DA[4:0] value returned to the host is one greater than the address assigned to the last device. Once this

last address is known, the host can determine how many devices are in the daisy-chain, which is required for subsequent READALL commands. A READALL command should be used to verify the ADDRESS registers.

Special considerations exist if the host desires to use internal loopback instead of external loopback. The first HELLOALL command is not returned to the host because the internal loopback bit for the top device has not yet been written. If the number of devices is known to the host, the host can use a WRITEDEVICE to set the internal loopback bit on the last device and then verify with a READALL command. If the number of devices is unknown, the internal loopback bit must be set on the first device, verified, and then cleared. It can then be set on the second device and verified, and so on incrementally until there is no response (end of stack). With the number of devices known, the loopback bit can be reset on the last device and all ADDRESS registers verified.

When a device receives a valid HELLOALL command, it clears the ADDRUNLOCK bit of the DEVCFG1 register. When this bit is 0, HELLOALL commands are ignored to prevent inadvertently changing any device address. To reconfigure the device address, the ADDRUNLOCK bit must first be set to 1, or a POR event must occur. After configuring the device addresses, they should be verified using the READALL or ROLLCALL commands.

| HOST TX | DEVICE (n) RXL | DEVICE (n) TXU | HOST RX |
|-------------------|-----------------------|---------------------|---------------------|
| Preamble | Preamble | Preamble | Preamble |
| 57h | 57h | 57h | 57h |
| 00h | 00h | 00h | 00h |
| {0b000,ADDR[4:0]} | {0b000,ADDR[4:0]+n-1} | {0b000,ADDR[4:0]+n} | {0b000,ADDR[4:0]+z} |
| Stop | Stop | Stop | Stop |

Table 27. HELLOALL Sequencing (z = Total Number of Devices)

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WRITEALL Command

The WRITEALL command writes a 16-bit value to a specified register in all daisy-chained devices. Since most configuration information is common to all the devices, this command allows faster setup than writing to each device individually. If the register address is not valid for the device, the command is ignored. The command sequence is shown in Table 28.

The register value is written immediately after the valid PEC byte is received, or if NOPEC is set, after the last byte is received. If the received PEC byte does not match the internal calculation, the command is not executed, but is still forwarded to the next device. The PEC is calculated from the first four bytes of the command starting after the preamble. A PEC error will generate a PEC alert in the device STATUS register.

WRITEDEVICE Command

[PEC]

[ALIVE]*

Stop

The WRITEDEVICE command writes a 16-bit value to the specified register in the addressed device only. If the register address is not valid for the device, the command is ignored. The command sequence is shown in Table 29.

The register value is written immediately after the valid PEC byte is received, or if NOPEC is set, after the last byte is received. If the received PEC byte does not match the internal calculation, the command is not executed, but is still forwarded to the next device. The PEC is calculated from the first four bytes of the command starting after the preamble. A PEC error sets the ALRTPEC bit in the STATUS register. A PEC error can only occur in the addressed device.

| Table 20. WRITEALE Sequencing (Onchanged by Daisy-Chain) | | | | | | |
|--|----------------|----------------|------------|--|--|--|
| HOST TX | DEVICE (n) RXL | DEVICE (n) TXU | HOST RX | | | |
| Preamble | Preamble | Preamble | Preamble | | | |
| 02h | 02h | 02h | 02h | | | |
| [REG ADDR] | [REG ADDR] | [REG ADDR] | [REG ADDR] | | | |
| [DATA LSB] | [DATA LSB] | [DATA LSB] | [DATA LSB] | | | |
| [DATA MSB] | [DATA MSB] | [DATA MSB] | [DATA MSB] | | | |

Table 28. WRITEALL Sequencing (Unchanged by Daisy-Chain)

Stop *If alive-counter mode is enabled.

[PEC]

[ALIVE]*

Table 29. WRITEDEVICE Sequencing (Unchanged by Daisy-Chain)

[PEC]

[ALIVE]*

Stop

| HOST TX | DEVICE (N) RXL | DEVICE (N) TXU | HOST RX |
|-------------------|-------------------|-------------------|-------------------|
| Preamble | Preamble | Preamble | Preamble |
| {(DA[4:0]),0b100} | {(DA[4:0]),0b100} | {(DA[4:0]),0b100} | {(DA[4:0]),0b100} |
| [REG ADDR] | [REG ADDR] | [REG ADDR] | [REG ADDR] |
| [DATA LSB] | [DATA LSB] | [DATA LSB] | [DATA LSB] |
| [DATA MSB] | [DATA MSB] | [DATA MSB] | [DATA MSB] |
| [PEC] | [PEC] | [PEC] | [PEC] |
| [ALIVE]* | [ALIVE]* | [ALIVE]* | [ALIVE]* |
| Stop | Stop | Stop | Stop |

*If alive-counter mode is enabled.

[PEC]

[ALIVE]*

Stop

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READALL Command

The READALL command returns register data from the specified register for all daisy-chain devices. The data for the first device (connected to host) is returned last. The command sequence is shown in <u>Table 30</u>. If the received PEC byte does not match the calculated value, the ALRTPEC bit of the data-check byte and ALRTPEC bit of the STATUS register are set, but the command proceeds. A Manchester error immediately switches the data propagation from read mode to write (pass-through) mode

ensuring that the Manchester error is propagated through the daisy-chain and back to the host.

The fill-byte values transmitted by the MAX17841B interface alternate between C2h and D3h as shown. As the packet propagates through the device, the device retransmits it in the order shown in the sequencing table (device TXU column). The device knows which bytes to overwrite since its ADDRESS register contains the first device address and its own device address and therefore knows where in the data stream it belongs.

Table 30. READALL Command Sequencing (z = Number of Devices)

| HOST TX | DEVICE (n) RXL | DEVICE (n) TXU | HOST RX |
|-----------------------|-----------------------|-----------------------|-----------------------|
| Preamble | Preamble | Preamble | Preamble |
| 03h | 03h | 03h | 03h |
| [REG ADDR] | [REG ADDR] | [DATA ADDR] | [REG ADDR] |
| [DC] = 0x00 | [DATA LSB(n-1)] | [DATA LSB(n)] | [DATA LSB(z)] |
| [PEC] | [DATA MSB(n-1)] | [DATA MSB(n)] | [DATA MSB(z)] |
| [ALIVE]* | | | [DATA LSB(z-1)] |
| [FD(1) C2h] | | | [DATA MSB(z-1)] |
| [FD(1) D3h] | [DATA LSB(1)] | [DATA LSB(1)] | |
| [FD(2) C2h] | [DATA MSB(1)] | [DATA MSB(1)] | |
| [FD(2) D3h] | [DC] | [DC] | |
| | [PEC] | [PEC] | |
| | [ALIVE]* | [ALIVE]* | |
| | [FD(1) C2h] | [FD(1) C2h] | |
| | [FD(1) D3h] | [FD(1) D3h] | [DATA LSB(1)] |
| | | | [DATA MSB(1)] |
| | | | [DC] |
| [FD(z) C2h] | [FD(z-n) C2h] | [FD(z-n-1) C2h] | [PEC] |
| [FD(z) D3h] | [FD(z-n) D3h] | [FD(z-n-1) D3h] | [ALIVE]* |
| Stop | Stop | Stop | Stop |
| 12+(4 x z) characters |

*If alive-counter mode is enabled.

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READDEVICE Command

The READDEVICE command returns a 16-bit word read from the specified register in the addressed device only. If the register address is not valid for the device, the command is ignored. The command sequence is shown in Table 31. The command packet is forwarded up the daisy-chain until it reaches the addressed device. The addressed device overwrites the received fill bytes with the two bytes of register data and forwards the packet to the next device. The alive-counter byte is only incremented by the addressed device. A Manchester error immediately switches the data propagation from read mode to write (pass-through) mode, ensuring that the Manchester error is propagated through the daisy-chain and back to the host.

| HOST TX | DEVICE RXL | DEVICE TXU | HOST RX |
|------------------|------------------|------------------|------------------|
| Preamble | Preamble | Preamble | Preamble |
| {DA[4:0], 0b101} | {DA[4:0], 0b101} | {DA[4:0], 0b101} | {DA[4:0], 0b101} |
| [REG ADDR] | [REG ADDR] | [REG ADDR] | [REG ADDR] |
| [DC] | [DC] | [DATA LSB] | [DATA LSB] |
| [PEC] | [PEC] | [DATA MSB] | [DATA MSB] |
| [ALIVE]* | [ALIVE]* | [DC] | [DC] |
| [FD(1) C2h] | [FD(1) C2h] | [PEC] | [PEC] |
| [FD(1) D3h] | [FD(1) D3h] | [ALIVE]* | [ALIVE]* |
| Stop | Stop | Stop | Stop |
| 16 characters | 16 characters | 16 characters | 16 characters |

Table 31. READDEVICE Sequencing

*If alive-counter mode is enabled.

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READBLOCK Command

The READBLOCK command returns an 18-byte read from the specified register for a block size of 1 in the addressed device only. If the register address is not valid for the device, it returns zero for any invalid addresses. If the device address is not valid, the command is ignored.

The command sequences for a block size of 1 and for a block size of 2 are shown in <u>Table 32</u> and <u>Table 33</u>, respectively.

The command packet is forwarded up the daisy-chain until it reaches the addressed device. The addressed device overwrites the received fill bytes with the two bytes of register data (from a single device) and forwards the packet to the next device. The alive-counter byte is only incremented by the addressed device. A Manchester error immediately switches the data propagation from read mode to write (pass-through) mode, ensuring that the Manchester error is propagated through the daisy-chain and back to the host.

Table 32. READBLOCK Sequencing for Block Size = 1

| HOST TX | DEVICE RXL | DEVICE TXU | HOST RX |
|------------------|------------------|------------------|------------------|
| Preamble | Preamble | Preamble | Preamble |
| {BS[4:0], 3b110} | {BS[4:0], 3b110} | {BS[4:0], 3b110} | {BS[4:0], 3b110} |
| [DEVICE ADDR] | [DEVICE ADDR] | [DEVICE ADDR] | [DEVICE ADDR] |
| [REG ADDR] | [REG ADDR] | [REG ADDR] | [REG ADDR] |
| [DC] | [DC] | [DATA LSB] | [DATA LSB] |
| [PEC] | [PEC] | [DATA MSB] | [DATA MSB] |
| [ALIVE]* | [ALIVE]* | [DC] | [DC] |
| [FD(1) C2h] | [FD(1) C2h] | [PEC] | [PEC] |
| [FD(1) D3h] | [FD(1) D3h] | [ALIVE]* | [ALIVE]* |
| Stop | Stop | Stop | Stop |
| 18 characters | 18 characters | 18 characters | 18 characters |

*If alive-counter mode is enabled.

Table 33. READBLOCK Sequencing for Block Size = 2

| HOST TX | DEVICE RXL | DEVICE TXU | HOST RX |
|------------------|------------------|------------------|------------------|
| Preamble | Preamble | Preamble | Preamble |
| {BS[4:0], 3b110} | {BS[4:0], 3b110} | {BS[4:0], 3b110} | {BS[4:0], 3b110} |
| [DEVICE ADDR] | [DEVICE ADDR] | [DEVICE ADDR] | [DEVICE ADDR] |
| [REG ADDR] | [REG ADDR] | [REG ADDR] | [REG ADDR] |
| [DC] | [DC] | [DATA0 LSB] | [DATA0 LSB] |
| [PEC] | [PEC] | [DATA0 MSB] | [DATA0 MSB] |
| [ALIVE]* | [ALIVE]* | [DATA1 LSB] | [DATA1 LSB] |
| [FD(1) C2h] | [FD(1) C2h] | [DATA1 MSB] | [DATA1 MSB] |
| [FD(1) D3h] | [FD(1) D3h] | [DC] | [DC] |
| [FD(1) C2h] | [FD(1) C2h] | [PEC] | [PEC] |
| [FD(1) D3h] | [FD(1) D3h] | [ALIVE]* | [ALIVE]* |
| Stop | Stop | Stop | Stop |
| 22 characters | 22 characters | 22 characters | 22 characters |

*If alive-counter mode is enabled.

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Diagnostics

Built-in diagnostics support ISO 26262 (ASIL) requirements by detecting specific fault conditions, as shown in <u>Table 34</u>. The device automatically performs some of the diagnostics while the host can perform others during initialization (e.g., at key-on), or periodically during operation, as required by the application. Diagnostics performed automatically by the device are previously described in the relevant functional sections. A description of the diagnostics requiring specific configurations are provided in this section.

Table 34. Summary of Built-In Diagnostics

| DIAGNOSTIC | S PERFORMED AUTOMATICA | LLY BY DEVICE, WITH | OUT HOST INTERVENTION |
|-------------------------------------|---|----------------------|--|
| FAULT | DIAGNOSTIC PROCEDURE | | OUTPUT |
| V _{AA} undervoltage | Continuous voltage comparison | | ALRTRST |
| V _{HV} undervoltage | Continuous voltage | comparison | ALRTHVUV |
| V _{HV} overvoltage | Continuous voltage | comparison | ALRTHVOV |
| V _{HV} low headroom | Voltage comparison – updated | I during measurement | ALRTHVHDRM |
| 32kHz oscillator fault | Continuous frequency | / comparison | ALRTOSC1, ALRTOSC2 |
| 16MHz oscillator fault | Communication error checking | | ALRTMAN, ALRTPAR |
| Communication fault | Communication error checking | | ALRTPEC, ALRTMAN, ALRTPAR |
| RX pin open/short | Verify RX mode after POR | | ALRTCOMMSEUn/ALRTCOMMSELn |
| VDDLx pin open/short | Continuous voltage comparison | | ALRTVDDLx |
| GNDLx pin open/short | Continuous voltage comparison | | ALRTGNDLx |
| Die over-temperature | temperature comparison – updated after measurement. | | ALRTTEMP |
| | | | |
| DIAGNOSTICS PER | FORMED DURING ACQUISITIC | ON MODE, AS SELECT | ED BY DIAGSEL OR BALSWDIAG |
| FAULT | DIAGNOSTIC PROCEDURE | DIAGSEL[2:0] | OUTPUT |
| Reference voltage fault | ALTREF diagnostic | DIAGSEL = 1h | DIAG[15:0] (ALTREF voltage) |
| V _{AA} voltage fault | V _{AA} diagnostic ADC1 | DIAGSEL = 2h | DIAG[15:0] (V _{AA} voltage) |
| V _{AA} voltage fault | V _{AA} diagnostic ADC2 | DIAGSEL = 2h | DIAG[15:0] (V _{AA} /2 voltage) |
| LSAMP Offset too high | LSAMP offset diagnostic | DIAGSEL = 3h | DIAG[15:0] (LSAMP offset voltage) |
| ADC bit stuck high | Zero-Scale ADC diagnostic | DIAGSEL = 4h | DIAG[15:0] (Zero-scale) |
| ADC bit stuck low | Full-Scale ADC diagnostic | DIAGSEL = 5h | DIAG[15:0] (Full-scale) |
| V _{PTAT} or ALRTTEMP fault | Die Temperature diagnostic | DIAGSEL = 6h | DIAG[15:0] (V _{PTAT} voltage), ALRTTEMP |
| Balancing switch short | BALSW diagnostic mode | BALSWDIAG = 1h | ALRTBALSW |
| Balancing switch open | BALSW diagnostic mode | BALSWDIAG = 2h | ALRTBALSW |
| Odd sense-wire open | BALSW diagnostic mode | BALSWDIAG = 5h | ALRTBALSW |
| | | | • |

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Table 34. Summary of Built-In Diagnostics (continued)

| PROCEDURAL DIAGNOSTICS | | | | |
|--------------------------|--|--------------------------------|--|--|
| FAULT | DIAGNOSTIC PROCEDURE | OUTPUT | | |
| SHDNL stuck high | Idle mode | ALRTSHDNL | | |
| HVMUX switch open | Acquisition with HVMUX test sources | ALRTOV, ALRTUV | | |
| HVMUX switch short | ALTREF diagnostic | DIAG[15:0] | | |
| HVMUX test sources | Acquisition with HVMUX test sources | CELLn | | |
| Cn pin open | Acquisition with cell-test sources | ALRTOV, ALRTUV | | |
| Cn short to SWn | Acquisition with balancing switches | CELLn | | |
| Cn pin leakage | ALTMUX vs. HVMUX acquisition | CELLn | | |
| Voltage comparator fault | ALTMUX acquisition with balancing switches | CELLn | | |
| Voltage comparator fault | ALTMUX acquisition with balancing switches | CELLn | | |
| ALRTHVUV comparator | Acquisition with HV charge pump disabled | ALRTHVUV | | |
| HVMUX sequencer | Acquisition with cell-test sources | CELLn | | |
| ALU Data Path | Acquisition with ADCTEST = 1 | CELLn, VBLKP, DIAG, and AUXINn | | |
| AUXINn Pin Open | Acquisition with AUXIN test sources | AUXINn | | |
| Calibration corruption | Read CALx, IDx, perform CRC | ID2 | | |

Note: Pin faults such as an open pin or adjacent pins shorted to each other must be detectable. Pin faults do not result in device damage, but have a specific device response such as a communication error, or are detectable through a built-in diagnostic. Analyzing the effect of pin faults is referred to as a pin FMEA. Contact Maxim Applications to obtain pin FMEA results.

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ALTREF Diagnostic Measurement

The ALTREF diagnostic measurement (DIAGSEL[2:0] = 0b001) checks the primary voltage reference of the ADC by measuring the alternate reference voltage (V_{ALTREF}). The result is available in the DIAG register after a normal acquisition.

The ALTREF voltage is computed from the result in the DIAG register as follows:



V_{ALTREF} = (DIAG[15:2]/16384d) x 5V

Since $1.23V < V_{ALTREF} < 1.254V$ and $V_{ALTREF} = 1.242V$ nominally, the expected range for DIAG[15:2] is:

 $(1.23V/5V) \times 16384d = 4030d$ to $(1.254V/5V) \times 16384 = 4109d$. Therefore, 0FBEh \leq DIAG[15:2] \leq 100Dh. To use the 16-bit register value, the 14-bit values must be shifted or multiplied by four, so that 3EF8h \leq DIAG[15:0] \leq 4034h.

Figure 36. ALTREF Diagnostic

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V_{AA} Diagnostic Measurement

The V_{AA} diagnostic measurement (DIAGSEL[2:0] = 0b010) verifies that V_{AA} is within specification This diagnostic measures V_{REF} using REF as the ADC reference.

V_{AA} diagnostic for ADC1 is given by:

DIAG[15:2] = (3.3/5) x (16384d) = 10813d V_{AA} = (DIAG[15:2]/16384d) x 5V V_{AA} (for ADC1) =3.29V The result for V_{AA} should fall within the range provided in the <u>Electrical Characteristics</u> table for V_{AA} .

 V_{AA} diagnostic for ADC2 is given by:

$$\begin{split} \mathsf{DIAG}[15:2] &= (3.3 \text{ x} (5/8)/2.307) \text{ x} (16384d) = 14648d \\ \mathsf{V}_{\mathsf{A}\mathsf{A}} &= (\mathsf{DIAG}[15:2]/16384d) \text{ x} \text{ 5V} \\ \mathsf{V}_{\mathsf{A}\mathsf{A}} (\text{for ADC2}) &= 4.47\mathsf{V} \end{split}$$



Figure 37. VAA Diagnostic ADC1



Figure 38. V_{AA} Diagnostic ADC2

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LSAMP Offset Diagnostic Measurement

The LSAMP diagnostic measurement (DIAGSEL[2:0] = 0b011) measures the level-shift amplifier offset by shorting the LSAMP inputs during the diagnostic portion of the acquisition. The result is available in the DIAG register after a normal acquisition. For this measurement, the ADC polarity is automatically set to bipolar mode to allow accurate measurement of voltages near zero. This measurement eliminates the chopping phase to preserve the offset error. If the diagnostic measurement exceeds the valid range for V_{OS_LSAMP}, as specified in the <u>Electrical</u> <u>Characteristics</u> table, the chopping function may not be able to cancel out all the offset error, and the acquisition accuracy could be degraded accordingly. See Figure 39 for LSAMP Offset Diagnostics

The LSAMP offset is computed from the result in the DIAG register, as follows:

LSAMP Offset = (| DIAG[15:2] - 2000h |/16384d) x 5V

The validity of measurements through LSAMP is further confirmed by the ALTREF and V_{AA} diagnostics, and comparison of the V_{BLKP} measurement to the sum of the cell measurements.

Zero-Scale ADC Diagnostic Measurement

Stuck ADC output bits can be verified with a combination of the zero-scale and full-scale diagnostics. The zero-scale ADC diagnostic measurement (DIAGSEL[2:0] = 0b100) verifies that the ADC conversion results in 000h when its input is at -V_{AA} in bipolar mode (since for an input \leq -2.5V, DIAG[15:0] = 0000h). For this measurement, the ADC is automatically set to bipolar mode (see Figure 40).



Figure 39. LSAMP Offset Diagnostic



Figure 40. ADC Zero-Scale Diagnostic

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Full-Scale ADC Diagnostic Measurement

Stuck ADC output bits can be verified with a combination of the zero-scale and full-scale diagnostics. The zero-scale ADC diagnostic measurement (DIAGSEL[2:0] = 0b101) verifies that the ADC conversion results in FFFh when its input is at V_{AA} in bipolar mode (since for an input \geq 2.5V, DIAG[15:0] = FFF0h). For this measurement, the ADC is automatically set to bipolar mode.

BALSW Diagnostics

Four balancing switch diagnostic modes are available to facilitate the following diagnostics:

- Balancing switch shorted (BALSWDIAG[2:0] = 0b001)
- Balancing switch open (BALSWDIAG[2:0] = 0b010)
- Odd sense wire open (BALSWDIAG[2:0] = 0b101)
- Even sense wire open (BALSWDIAG[2:0] = 0b110)

Enabling any of these modes automatically preconfigures the acquisition (e.g. enables the ALTMUX measurement path). The host must initiate the acquisition but the diagnostic mode automatically compares the measurements to the specific thresholds, and sets any corresponding alerts. The host presets the thresholds as determined by the minimum and maximum resistance of the switch (R_{SW}) specified in the <u>Electrical Characteristics</u> table and the intended cell-balancing current.

During any balancing switch diagnostic mode, ALRTOV, ALRTUV and ALRTMSMTCH comparisons are dis-

abled. After BALSWDIAG[2:0] is cleared, the modified configurations automatically return to their prior setting. The same configurations and comparisons could be implemented manually but at the expense of more host operations.

BALSW Short Diagnostic

A short-circuit fault in the balancing path could be a short between SWn and SWn-1 (see <u>Figure 42</u>), or that the balancing FET is stuck in the conducting state. In the short circuit state, the voltage between SWn and SWn-1 (switch voltage) is less than the voltage between Cn and Cn-1 (cell voltage).

When enabled, the balancing switch short diagnostic mode (BALSWDIAG[2:0] = 0b001) functions as follows:

- · Disables the balancing switches automatically
- Configures the acquisition using ALTMUX path automatically
- Host initiates the acquisition
- Compares the measurement to the threshold value BALSHRTTHR automatically
- If outside the threshold, sets the corresponding flag in ALRTBALSW automatically

For the best sensitivity to leakage current, set the threshold value based on the minimum cell voltage minus a small noise margin (100mV), then update the threshold value periodically or every time a measurement is taken, depending on how fast the cell voltages are expected to change.



Figure 41. ADC Full-Scale Diagnostic

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Figure 42. Balancing Switch Short



Figure 43. BALSW Short Diagnostic

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BALSW Open Diagnostics

The BALSW open diagnostic (BALSWDIAG[2:0] = 0b010) verifies that each enabled balancing switch is conducting (not open) as follows:

- Configures acquisition for bipolar mode (for measuring voltages near zero) automatically
- Configures acquisition for ALTMUX path automatically
- Configures acquisition to measure switch voltages for those switches enabled by BALSWEN automatically
- Host initiates acquisition
- Compares measurement to the threshold value BALLOWTHR and BALHIGHTHR (Table 36) automatically
- If outside the threshold, set the corresponding flag in ALRTBALSW automatically

Set the thresholds by taking into account the minimum and maximum R_{SW} of the switch itself as specified in the <u>Electrical Characteristics</u> table and the balancing current for the application.

See <u>Table 35</u> for BALSW Short-Diagnostic Autoconfiguration, <u>Table 36</u> for BALSW Diagnostics. See <u>Table 37</u> for BALSW Open-Diagnostic Autoconfiguration and Figure 44 for BALSW Open Diagnostics.

Even/Odd Sense Wire Open Diagnostics

If enabled, the sense-wire open diagnostic modes detect if a cell-sense wire is disconnected as follows:

- Closes nonadjacent switches (even or odd automatically)
- Configures acquisition to use ALTMUX path automatically
- Host waits 100µs for settling and then initiates the acquisition
- Compares the result to the BALHIGHTHR and BALLOWTHR registers automatically
- If outside thresholds, sets flags in ALRTBALSW automatically

See Figure 45 for Cell Sense-Wire Open Diagnostics.

Table 35. BALSW Short Diagnostic Autoconfiguration

| CONFIGURATION BITS | AUTOMATIC SETTING | PURPOSE |
|--------------------|-------------------|--|
| MEASUREEN[14:12] | 0b000 | Disable AUXIN and V _{BLKP} measurements |
| BALSWEN[11:0] | 000h | Disable all balancing switches |
| DIAGCFG.ALTMUXSEL | 1 | Enable ALTMUX measurement path |

Table 36. BALSW Diagnostics

| BALSW | V _{SWn} | FAULT INDICATED? | POSSIBLE FAULT CONDITION |
|-------|------------------|------------------|-------------------------------------|
| | > V(BALHIGHTHR) |) Yes | Switch open circuit, or overcurrent |
| On | > V(BALLOWTHR) | No | None |
| | < V(BALHIGHTHR) | | |
| | < V(BALLOWTHR) | Yes | Path open circuit, or short circuit |
| Off | > V(BALSHRTTHR) | No | None |
| | < V(BALSHRTTHR) | Yes | Short circuit, or leakage current |

Table 37. BALSW Open-Diagnostic Autoconfiguration

| CONFIGURATION BITS | AUTOMATIC SETTING | PURPOSE |
|--------------------|-------------------|---|
| MEASUREEN[14:12] | 0b000 | Disable AUXINn and V _{BLKP} measurements |
| MEASUREEN[11:0] | BALSWEN[11:0] | Measure only active switch positions |
| DIAGCFG.ALTMUXSEL | 1 | Enable ALTMUX measurement path |
| SCANCTRL.POLARITY | 1 | Enable bipolar mode |

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Figure 44. BALSW Open Diagnostics
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Figure 45. Cell Sense-Wire Open Diagnostics

Table 38. Odd Sense-Wire Open Measurement Result

| | | | | | | SEN | SE WIRE | OPEN F | AULT LO | CATION | | | | |
|-------------|--------|----|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|------------------|-------------------|-------------------|-----|
| | | C0 | C1 | C2 | C3 | C4 | C5 | C6 | C7 | C8 | C9 | C10 | C11 | C12 |
| | Cell1 | 0V | 0V | NC | NC | NC | NC |
| | Cell2 | NC | cell1+ cell2 | cell2+ cell3 | NC | NC | NC | NC |
| | Cell3 | NC | NC | 0V | 0V | NC | NC | NC | NC | NC | NC | NC | NC | NC |
| CHANGE | Cell4 | NC | NC | NC | cell3+ cell4 | cell4+ cell5 | NC | NC | NC | NC | NC | NC | NC | NC |
| | Cell5 | NC | NC | NC | NC | 0V | 0V | NC | NC | NC | NC | NC | NC | NC |
| MENT | Cell6 | NC | NC | NC | NC | NC | cell5+ cell6 | cell6+ cell7 | NC | NC | NC | NC | NC | NC |
| L R | Cell7 | NC | NC | NC | NC | NC | NC | 0V | 0V | NC | NC | NC | NC | NC |
| MEASUREMENT | Cell8 | NC | NC | NC | NC | NC | NC | NC | cell7+ cell8 | cell8+ cell9 | NC | NC | NC | NC |
| CELL | Cell9 | NC | NC | NC | NC | NC | NC | NC | NC | 0V | 0V | NC | NC | NC |
| CE | Cell10 | NC | NC | NC | NC | NC | NC | NC | NC | NC | cell9+ cell10 | cell10+ cell11 | NC | NC |
| | Cell11 | NC | NC | NC | NC | NC | NC | NC | NC | NC | NC | 0V | 0V | NC |
| | Cell12 | NC | NC | NC | NC | NC | NC | NC | NC | NC | NC | NC | cell11+ cell12 | UD |

Note: NC = No Change; UD = Undefined; Maximum result is 5V.

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Figure 46. Sense-Wire Open Diagnostic

Table 39. Sense-Wire Open-Diagnostic Configurations

| CONFIGURATION BIT(S) | CONFIGURATION STATE | TASK |
|----------------------|---|---|
| BALSWEN[11:0] | 555h (BALSWDIAG = 0b101) or AAAh (BALSWDIAG = 0b110) | Enable odd switches Enable even switches |
| MEASUREEN[14:12] | 0b000 | Disable AUXINn and V _{BLKP} measurements |
| MEASUREEN[11:0] | BALSWEN[11:0] | Measure only active switch positions |
| DIAGCFG.ALTMUXSEL | 1 | Enable ALTMUX measurement path |
| SCANCTRL.POLARITY | 1 | Enable bipolar mode |

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Diagnostic Test Sources

Diagnostic test current sources (see Figure 47) can be enabled prior to the acquisition mode for detecting both internal and external hardware faults in the measurement path. One set of test sources are connected to the HVMUX input side and another set are connected to the HVMUX output side. See <u>Table 40</u> for HVMUX output assignments. The basic premise in these diagnostics is that for a symmetrical measurement channel with no faults, the test currents can be applied symmetrically to the differential channel and there should be almost no change in the channel measurement. On the other hand, if an asymmetric fault exists on the channel, the resulting change will indicate the nature of the fault (e.g., an open or shorted pin).

For the 15 test current sources on the input channels (13 Cn and two AUXINn):

- The test currents individually enabled per CTSTEN[12:0] and AUXINTSTEN[2:1].
- The test current ranges from 6.25µA up to 100µA per

CTSTDAC[3:0] (applies to all enabled sources).

 Test current sources from V_{AA} or sinks to AGND per the CTSTSRC bit, except for C0 (applies to all enabled sources). The test current sources from V_{AA} only for CTST0.

For the two test current sources on the HVMUX output side:

- The test currents are enabled by the MUXDIAGEN bit.
- The test current always sources from the HV supply.
- The test current ranges from 3.125µA up to 50µA per CTSTDAC[3:0] (applies to all enabled sources).
- The test current, by default, is applied to both HVMUX outputs (even and odd outputs). However, if MUXDIAGPAIR is set, the test current is applied to only one of the output lines per MUXDIAGBUS. This mode is used to test the test sources themselves.

See Figure 47 for test current sources diagram.

| INPUT SIGNAL | HVMUX OUTPUT |
|--------------|--------------|
| C12 | Even bus |
| C11 | Odd bus |
| C10 | Even bus |
| C9 | Odd bus |
| C8 | Even bus |
| C7 | Odd bus |
| C6 | Even bus |
| C5 | Odd bus |
| C4 | Even bus |
| C3 | Odd bus |
| C2 | Even bus |
| C1 | Odd bus |
| C0 | Even bus |
| REF | Odd bus |
| ALTREF | Odd bus |
| AGND | Even bus |

Table 40. HVMUX Output Assignment

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Figure 47. Test Current Sources

Shutdown Diagnostic

The shutdown diagnostic verifies that no hardware fault is preventing the device from shutting down, such as the SHDNL input being stuck at logic-one. To perform the diagnostic, the host attempts a shutdown. The timing shown in Figure 48 is for a UART idle mode shutdown. Once V_{SHNDL} < 0.6V, the ALRTSHDNL bit is set in the STATUS register and the regulator is disabled (see Table 41); however, the STATUS register can still be read as long as VAA has not decayed below 2.95V (typ), which takes about 1ms. The host should verify that ALRTSHDNL is set. By reading the bit, the charge pump will drive V_{SHDNL} > 1.8V in about 200µs and enable the regulator. The host must clear the ALRTSHDNL bit to complete the diagnostic. The ALRTSHDNLRT bit is a real-time version of ALRTSHDNL that automatically clears when V_{SHDNL} > 1.8V.

HVMUX Switch Open Diagnostic

Since an open HVMUX switch causes the measured voltage to go to either zero or full-scale, it is possible to execute the test by looking for an overvoltage or undervoltage alert following the diagnostic measurement without analyzing the measurement data. It is possible to read all voltage measurements and let the host compare the results by splitting the test into several segments.

The procedure in Figure 49 is quick and efficient. For higher sensitivity to faults, each cell voltage measurement in the diagnostic mode can be compared to a threshold of 100mV by the host to determine if the HVMUX path is working correctly. The threshold is derived from the worst case HVMUX resistance mismatch and the worst-case diagnostic current source value variation.

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Table 41. Shutdown Diagnostic

| FAULT | COMPARISON | ALERT BIT | LOCATION |
|-------------------|----------------------------|------------|------------|
| SHDNL input stuck | V _{SHDNL} < 0.6V? | ALRTSHDNL | STATUS[12] |
| SHDNL input stuck | V _{SHDNL} < 0.6V? | ALRTSHNDRT | STATUS[11] |







Figure 49. HVMUX Switch Open Diagnostic

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HVMUX Switch Shorted Diagnostic

A shorted mux switch is detectable in two ways based on corrupted measurement values. First, the ALTREF diagnostic reports a large error. Also, during normal cell measurements, a shorted HVMUX switch causes the LSAMP to saturate, which is also easily detectable

HVMUX Test Source Diagnostic

The two current sources attached to the HVMUX even bus and the HVMUX odd bus can be enabled indepen-

Table 42. HVMUX Switch Open Diagnostic

dently instead of as a pair setting the MUXDIAGPAIR bit. MUXDIAGBUS controls which source is enabled (MUXDIAGBUS = 1 for odd bus source). This causes every measurement to have a definable change as the sources are enabled and disabled. By taking measurements while alternating which current source is enabled, it is possible to verify that each current source is working.

See <u>Table 42</u> for HVMUX switch open diagnstics and <u>Table</u> 43 for HVMUX test-source diagnostic.

| | | | HVMUX SWITCH OPEN FAULT LOCATION | | | | | | | | | | | |
|-------------|--------|----|----------------------------------|----|----|----|----|----|----|----|----|-----|-----|-----|
| | | C0 | C1 | C2 | C3 | C4 | C5 | C6 | C7 | C8 | C9 | C10 | C11 | C12 |
| | Cell1 | 0V | 5V | NC | NC | NC |
| | Cell2 | NC | 0V | 5V | NC | NC | NC |
| | Cell3 | NC | NC | 0V | 5V | NC | NC | NC |
| MEASUREMENT | Cell4 | NC | NC | NC | 0V | 5V | NC | NC | NC | NC | NC | NC | NC | NC |
| EM | Cell5 | NC | NC | NC | NC | 0V | 5V | NC | NC | NC | NC | NC | NC | NC |
| SUR | Cell6 | NC | NC | NC | NC | NC | 0V | 5V | NC | NC | NC | NC | NC | NC |
| EAS | Cell7 | NC | NC | NC | NC | NC | NC | 0V | 5V | NC | NC | NC | NC | NC |
| | Cell8 | NC | NC | NC | NC | NC | NC | NC | 0V | 5V | NC | NC | NC | NC |
| CELL | Cell9 | NC | NC | NC | NC | NC | NC | NC | NC | 0V | 5V | NC | NC | NC |
| | Cell10 | NC | NC | NC | NC | NC | NC | NC | NC | NC | 0V | 5V | NC | NC |
| | Cell11 | NC | NC | NC | NC | NC | NC | NC | NC | NC | NC | 0V | 5V | NC |
| | Cell12 | NC | NC | NC | NC | NC | NC | NC | NC | NC | NC | NC | 0V | 5V |

Note: NC = No change.

Table 43. HVMUX Test-Source Diagnostic

| | /MUX TEST- URCE FAULT | EVEN TEST SOURCE SHORTED TO HV | EVEN TEST SOURCE OPEN CIRCUIT | ODD TEST SOURCE SHORTED TO HV | ODD TEST SOURCE OPEN CIRCUIT |
|------------------|--------------------------|-----------------------------------|----------------------------------|----------------------------------|---------------------------------|
| | Cell1: | 0V | -l x R | 5V | I x R |
| щ | Cell2: | 5V | I x R | 0V | -l x R |
| CHANGE | Cell3: | 0V | -l x R | 5V | I x R |
| CH | Cell4: | 5V | I x R | 0V | -l x R |
| L | Cell5: | 0V | -l x R | 5V | I x R |
| NE NE | Cell6: | 5V | I x R | 0V | -l x R |
| URE | Cell7: | 0V | -l x R | 5V | I x R |
| ASI | Cell8: | 5V | I x R | 0V | -l x R |
| CELL-MEASUREMENT | Cell9: | 0V | -l x R | 5V | I x R |
| | Cell10: | 5V | I x R | 0V | -l x R |
| 5 | Cell11: | 0V | -I x R | 5V | I x R |
| | Cell12: | 5V | l x R | 0V | -I x R |

Note: I = Test source current, R = HVMUX resistance.

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Cn Open Diagnostic

If the cell is disconnected from the input, the corresponding cell-test source (sinking to AGND) pulls the cell input voltage toward 0V (except for C0, where source to V_{AA} current source will pull the cell input voltage to V_{AA}). A new measurement is taken with the current sources enabled, and a change in measurement value is detected. If no open circuit exists, then the measurement value changes by only the value of the test current across the application circuit series resistor to the Cn pin (see Table 44).

Cn Shorted to SWn Diagnostic

Short circuits between the SWn pins and the cell input pins are detectable. A shorted SWn pin can be detected by an acquisition with the relevant cell-balancing switch off and then again with it on. If the SWn pin is not shorted to an adjacent cell input pin, no change in the measured value should be observed for the two cases. If the SWn pin is shorted to the Cn pin, then the measured value will change by approximately 40% to 50% when the balancing switch is turned on based on the values of R_{BALANCE}, and the balancing switch resistance. A short circuit from SWn to Cn-1 produces the same effect. By comparing both the V_{CELLn+1} measurement value along with the V_{CELLn+1} and V_{CELLn-1} values, it is possible to determine exactly where the short circuit is located.

| | | | | | | Cn | PIN OPE | N FAULT | LOCATI | ON | | | | |
|------------------|--------|----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|------------------|-------------------|-------------------|-----|
| | | C0 | C1 | C2 | C3 | C4 | C5 | C6 | C7 | C8 | C9 | C10 | C11 | C12 |
| | Cell1 | Cell1- 3.3V | 0V | NC | NC | NC | NC |
| | Cell2 | NC | Cell2+ Cell1 | 0V | NC | NC | NC | NC |
| | Cell3 | NC | NC | Cell3+ Cell2 | 0V | NC | NC | NC | NC | NC | NC | NC | NC | NC |
| | Cell4 | NC | NC | NC | Cell4+ Cell3 | 0V | NC | NC | NC | NC | NC | NC | NC | NC |
| NENT | Cell5 | NC | NC | NC | NC | Cell5+ Cell4 | 0V | NC | NC | NC | NC | NC | NC | NC |
| SUREN | Cell6 | NC | NC | NC | NC | NC | Cell6+ Cell5 | 0V | NC | NC | NC | NC | NC | NC |
| CELL MEASUREMENT | Cell7 | NC | NC | NC | NC | NC | NC | Cell7+ Cell6 | 0V | NC | NC | NC | NC | NC |
| CELL | Cell8 | NC | NC | NC | NC | NC | NC | NC | Cell8+ Cell7 | 0V | NC | NC | NC | NC |
| | Cell9 | NC | NC | NC | NC | NC | NC | NC | NC | Cell9+ Cell8 | 0V | NC | NC | NC |
| | Cell10 | NC | NC | NC | NC | NC | NC | NC | NC | NC | Cell10+ Cell9 | 0V | NC | NC |
| | Cell11 | NC | NC | NC | NC | NC | NC | NC | NC | NC | NC | Cell11+ Cell10 | 0V | NC |
| | Cell12 | NC | NC | NC | NC | NC | NC | NC | NC | NC | NC | NC | Cell12+ Cell11 | 0V |

Table 44. Cn Pin Open Diagnostic

Note: I = Test source current, R = HVMUX resistance.

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Figure 50. SWn to Cn Short



Figure 51. SWn-1 to Cn Short

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Cn Leakage Diagnostic

Leakage at the Cn inputs can cause the voltage seen by the ADC to be different than that at the voltage source due to the resistance of the external filter circuit. By utilizing an alternate measurement path, any voltage errors as a result of Cn pin leakage can be detected. The SWn pins are connected to the cell sources through an alternate path. Implementing an HVMUX connection from the SWn pins to the LSAMP completes the redundant measurement path. This alternate measurement path for the cell measurements can be enabled by setting the ALTMUXSEL bit of the DIAGCFG register. When this bit is set and a measurement cycle started, all cell measurements are taken using the alternate path instead of the Cn pin HVMUX connections. Measurements taken with the normal and alternate paths can be compared and should be nearly identical for a system with no faults. Since the SWn pins typically have a smaller external filter time constant than the Cn pins, increasing the oversampling setting for this diagnostic measurement may be beneficial for reducing measurement noise when the measurement is taken while the cells are exposed to transient loads.

Cell Overvoltage Diagnostic

Enabling balancing switches can be used to generate a voltage up to 2 x V_{CELL} at the ALTMUX inputs to test the input-range capability, assuming the cell is sufficiently charged.

A cell-position input voltage is elevated by approximately 1.5 x V_{CELLn} turning on either BALSWn+1 or BALSWn-1. When the adjacent switch is turned on, the SWn pin shared with the switch is moved by 0.5 x V_{CELL}, which causes V_{CELLn} to increase by that amount when measured with the ALTMUX path. For the topmost cell position, BALSWn-1 must be used, and for the bottom cell position, BALSWn+1 must be used. By turning on two adjacent switches instead of one, such as BALSWn+1 and BALSWn+2, the measured voltage is approximately 2 x V_{CELL}, assuming all cells are at approximately the same voltage. This technique can create an input voltage that exceeds the overvoltage threshold to verify the higher end of the input range and the overvoltage alert function.

Input range can also be verified by using the cell-test sources to induce a higher cell-channel voltage. If the change is as expected, it shows that the system can measure voltages above the present nominal input voltage.



Figure 52. Redundant HVMUX Paths

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Cell Undervoltage Diagnostic

Turning on the balancing switch can be used to generate a near-zero voltage at any input channel to the ALTMUX path. By successfully measuring this near-zero voltage, the diagnostic verifies the lower-end of the input range and the undervoltage alert function.

Input range can also be verified by using the cell-test sources to induce a lower cell-channel voltage. If the change is as expected, it shows that the system can measure voltages below the present nominal input voltage.

ALRTHVUV Comparator Diagnostic

The ALRTHVUV comparator functionality can be verified by setting the CPEN bit (to disable the HV charge pump) and then discharging the external HV capacitor by performing an acquisition for 5ms (such as 12 cells, 32 oversamples), or by enabling using one or more of the cell-test current sources for an appropriate amount of time. The ALRTHVUV bit should be set after the voltage has decayed.

HVMUX Sequencer Diagnostic

The HVMUX control sequence can be checked using the sources attached to the Cn pins. The sources are controlled by the CTSTEN bits of the CTSTCFG register. The basic test method is as follows:

- 1) Perform an acquisition
- 2) Turn on a cell-test source
- 3) Wait for sufficient settling time
- 4) Perform an acquisition
- 5) Check that the cell(s) sharing the pin whose current source was turned on had the expected measurement change and other cells had no changes.
- 6) Repeat steps 1–5 for other pins to confirm there are no logic errors in the HVMUX control sequencer.

The cell-test sources can be turned on for individual pins to create a detectable measurement variation that is determined by the current-source value and the series resistance of the cell input-filter circuit. The settling time needed for a certain change in measurement value depends on the size of the external filter capacitors and the amplitude of the test-current source. A longer settling time gives the full voltage change, while a shorter settling time saves test time and should still produce an easily detectable voltage difference. By detecting the expected measurement variation for a given cell input pair and running a sequence of tests to cover all cases, the HVMUX sequencer operation is verified.



Figure 53. HVMUX Sequencer Diagnostic

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Figure 54. HVMUX Sequencer Diagnostic

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ALU Diagnostic

The ALU diagnostic utilizes the ADC test mode (ADCTSTEN = 1) to feed data from specific test registers directly into the ALU instead of from the ADC conversion. The host can write different data combinations to the test registers in this mode to provide test coverage for all ALU and data registers (CELLn, VBLKP, DIAG, and AUXINn), as well as all alerts that are based on the measurement data and the corresponding thresholds (e.g., overvoltage alerts). The ADCTEST1n registers are used for all odd-numbered samples in oversampling mode, as well as in single-sample acquisitions. The ADCTEST2n registers are used for all even-numbered samples (in oversampling mode). The A registers are used in lieu of the first conversion of each measurement and the B registers are used in lieu of the second conversion. After the acquisition, the host can read the measurement data registers and the alert registers and compare the data to expected values to verify the ALU functionality.



Figure 55. ALU Diagnostic

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For MAX17843, Maxim design team added a digital offset trim to improve ADC accuracy. Because it is calculated after the ADCTST data insertion, it will show up as an offset to any ADCTST diagnostic. The offset value will be constant for a given part, but varies from part to part. Table 45 gives the mapping of expected read from the diagnostic and block register.

AUXINn Open Diagnostic

The AUXINn open diagnostic can be used to detect if the AUXINn pin is open circuit. The diagnostic procedure is shown in Figure 56 and Figure 57.

Table 45. Expected ALU Diagnostic and Block Register Results

| ALU DIAGNOSTIC RESULT WHEN ADCTSTST = 1, DIAGSEL = 6 | | | | | | | |
|--|---|--------------|--|--|--|--|--|
| OS SETTING OVERSAMPLING DIAGNOSTIC DATA ALU | | | | | | | |
| 000 | 1 | ADCTST1A x 4 | | | | | |
| 001–111 | 001–111 4–128 [ADCTST1A + ADCTST2A] x 2 | | | | | | |

| ALU DIAGNOSTIC RESUL | ALU DIAGNOSTIC RESULT WHEN ADCTSTST = 1, DIAGSEL = 4, 5 | | | | | | |
|---|---|---------------------------|--|--|--|--|--|
| OS SETTING OVERSAMPLING DIAGNOSTIC DATA ALU | | | | | | | |
| 000 | 1 | ADCTST1B x 4 | | | | | |
| 001–111 | 4–128 | [ADCTST1B + ADCTST2B] x 2 | | | | | |

| ALU DIAGNOSTIC RESULT WHEN ADCTSTST = 1, DIAGSEL = 1, 2, 3 | | | | | | | |
|--|-------|---|--|--|--|--|--|
| OS SETTING OVERSAMPLING DIAGNOSTIC DATA ALU | | | | | | | |
| 000 | 1 | [ADCTST1A + ADCTST1B] x 2 | | | | | |
| 001–111 | 4–128 | [ADCTST1A + ADCTST1B ADCTST2A + ADCTST2B] | | | | | |

| ALU BLOCK RESULT WHEN ADCTSTST = 1 | | | | | | |
|------------------------------------|--------------|---|--|--|--|--|
| OS SETTING | OVERSAMPLING | DIAGNOSTIC DATA ALU | | | | |
| 000 | 1 | [ADCTST1A + ADCTST1B] x 2 | | | | |
| 001–111 | 4–128 | [ADCTST1A + ADCTST1B ADCTST2A + ADCTST2B] | | | | |



Figure 56. AUXINn Open Diagnostic

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Figure 57. AUXINn Open Diagnostic

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Calibration ROM Diagnostic

The CRC for the calibration ROM can be independently computed by the host. Any mismatch between the calculated CRC and the factory CRC indicates that the measurement accuracy may be compromised. The factory CRC, ROMCRC[7:0], is stored in the ID2 register.

The CRC for the calibration ROM uses the same polynomial as the CRC-8 PEC byte and is performed on addresses C0h to CAh, CFh, and D0 to D4h. ID2 is processed in the order shown in <u>Table 46</u>, least-significant bit first. Registers CAL11, CAL12, CAL13, and CAL14 are excluded from the calculation. Also, certain ROM bits must be zeroed prior to performing the calculation using the bit-wise AND masks in Table 46.

Table 46. CRC Bit Mask

| ORDER | ADDRESS | NAME | BIT-WISE AND MASK | |
|-------|---------|-------|-------------------|--|
| 1 | 0xC0 | CAL0 | 0x003F | |
| 2 | 0xC1 | CAL1 | 0x007F | |
| 3 | 0xC2 | CAL2 | 0x001F | |
| 4 | 0xC3 | CAL3 | 0x0FFF | |
| 5 | 0xC4 | CAL4 | 0xFFFF | |
| 6 | 0xC5 | CAL5 | 0x3F00 | |
| 7 | 0xC7 | CAL7 | 0x3F3F | |
| 8 | 0xC8 | CAL8 | 0x003F | |
| 9 | 0xC9 | CAL9 | 0x3FFF | |
| 10 | 0xCA | CAL10 | 0x000F | |
| 11 | 0xCF | CAL15 | 0x007F | |
| 12 | 0xD0 | CAL16 | 0x3FFF | |
| 13 | 0xD1 | CAL17 | 0x00FF | |
| 14 | 0xD2 | CAL18 | 0x3F00 | |
| 15 | 0xD3 | CAL19 | 0x3F3F | |
| 16 | 0xD4 | CAL20 | 0x003F | |
| 17 | 0x0E | ID2 | 0x0001 | |

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

Applications Information

Vehicle Applications

Battery cells can use various chemistries such as NiMH, Li-ion, SuperCap, or Lead-Acid. SuperCap cells are used in fast-charge applications such as energy storage for regenerative braking. An electric vehicle system may require a high-voltage battery pack containing up to 200 Li-ion cells, or up to 500 NiMH cells. A battery module is a number of cells connected in series that can be connected with other modules to build a high-voltage battery pack (see Figure 58). The modularity allows for economy, configurability, quick assembly, and serviceability. The minimum number of cells connected to any one device is limited by the device's minimum operating voltage. The 9V minimum for V_{DCIN} usually requires at least two Li-ion, six NiMH or six SuperCap cells per module.



Figure 58. Electric Vehicle System

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Battery-Management Systems

Daisy-Chain System

A daisy-chain system (Figure 59) employs a single data link between the host and all the battery modules. The daisy-chain method reduces cost and requires only a single isolator between the lowest module and the host.



Figure 59. Daisy-Chain System

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Distributed-Module Communication

A distributed-module system employs a separate data link and isolator between each battery module and the host, with an associated increase in cost. Maxim battery-management ICs support the daisy-chain system (see Figure 60).



Figure 60. Distributed System

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External Cell Balancing Using BJT Switches

An application circuit for cell balancing that employs BJT switches is shown in <u>Figure 61</u>. Q_{BALANCE} is selected for power dissipation based on the I_B drive current available and the cell-balancing current. D_{BASE} protects Q_{BALANCE} from negative V_{GS} during hot-plug events. R_{BASE} protects the device by limiting the hot-pluginrush current. The cell-balancing current is limited by R_{BALANCE}. See <u>Table 47</u> for BJT balancing components.

External Cell-Balancing Short-Circuit Detection

A short-circuit fault in the external balancing path results in continuous current flow through $R_{BALANCE}$ and $Q_{BALANCE}$. To detect this fault, the voltage drop across the sense-wire parasitic resistance must be measurable. A very small series resistor can added for this purpose.



Figure 61. External Cell Balancing (BJT)

Table 47. BJT Balancing Components

| COMPONENT NAME | TYPICAL VALUE OR PART | FUNCTION |
|----------------------|------------------------------------|---|
| R _{BIAS} | 22Ω | Voltage-divider for transistor bias |
| R _{BASE} | 15Ω | Hot-plug current-limiting resistor |
| D _{BASE} | S1B | Reverse emitter-base voltage protection |
| C _{BASE} | 1nF | Transient V _{BE} suppression |
| R _{BALANCE} | Per balancing-current requirements | Balancing current-limiting resistor |
| Q _{BALANCE} | NST489AMT1 | External switch |

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UART Interface

The UART pins also employ both internal and external circuits to protect against noise. The recommended external filters are shown in Figure 62. ESD protection is shown in Figure 64 and Figure 65.

High-Z Idle Mode

The high-Z idle mode lowers radiated emissions from wire harnesses by minimizing the charging and discharging of the AC-coupling capacitors when entering and exiting the idle mode. The application circuit shown in Figure 63 uses a weak resistor-divider to bias the TX lines to V_{DDL} during the high-Z idle period and pnp transistor clamps to limit the maximum voltage at the TX pins during high noise injection. The resistor-divider and pnp clamps are not needed for applications utilizing only the low-Z mode. The low-Z and high-Z idle modes both exhibit a similar immunity to noise injection. Low-Z mode may be preferred for ports driving inductive loads to minimize ringing.



Figure 62. UART Connection

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UART Supplemental ESD Protection

The UART ports may require supplemental protection to meet IEC 61000-4-2 requirements for contact discharge.

The recommended circuits to meet \pm 8kV protection levels are shown in <u>Figure 64</u> and <u>Figure 65</u>. The protection components should be placed as near as possible to the signal's entry point on the PCB.



Figure 63. High-Z Idle Mode Application Circuit



Figure 64. External ESD Protection for UART TX Ports

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UART Supplemental ESD Protection

The UART ports may require supplemental protection to meet IEC 61000-4-2 requirements for contact discharge. The recommended circuits to meet ±8kV protection levels are shown in Figures 64 and 65. The protection components should be placed as near as possible to the signal's entry point on the PCB.

Single-Ended RX Mode

To configure the lower port for single-ended RX mode, the RXLP input is connected to digital ground and the RXLN input receives the inverted signal, just as it does for differential mode. If the host cannot transmit inverted data then the signal must be inverted as shown in Figure 66.

Transmitter operation is not affected. If the upstack device is single-ended, so only the TXUN signal is required. **Note:** in single-ended mode, SHDNL must be driven externally; leave TXLP unconnected.

UART Isolation

The UART is expected to communicate reliably in noisy high-power battery environments, where both high dV/dt supply noise and common-mode current injection induced by electromagnetic fields are prevalent. Common-mode currents can also be induced by parasitic coupling of the system to a reference node such as a battery or vehicle chassis. The daisy-chain physical layer is designed for maximum noise immunity.



Figure 65. External ESD Protection for UART RX Ports



Figure 66. Application Circuit for Single-Ended Mode

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The AC-coupled differential communication architecture has a ±30V common-mode range and +6V differential swing. This range is in addition to the static commonmode voltage across the AC-coupling capacitors between modules. Transmitter drivers have low internal impedance and are source-terminated by the application circuit so that impedances are well-matched in the high- and lowdriver states. This architecture minimizes differential noise induced by common-mode current injection. The receiver inputs are filtered above the fundamental communication frequency to prevent high-frequency noise from entering the device. The system is designed for use with isolation transformers or optocouplers to provide an even higher degree of common-mode noise rejection in circuit locations where extremely large common-mode noise is present, such as between vehicle chassis and high-voltage batterypack terminals.

Since a mid-pack service-disconnect safety switch is present in many battery packs, the device is designed to communicate with the entire daisy-chain, regardless of whether the service-disconnect switch is engaged or open. This is possible with daisy-chains that employ capacitor isolation.

UART Transformer Isolation

The UART ports can be transformer-coupled because of their DC-balanced differential design (see Figure 67). Transformer coupling between the MAX17841B interface and the MAX17843 provides excellent isolation and common-mode noise rejection. The center tap of a signal transformer can be used to enhance commonmode rejection by AC-coupling the node to local ground. Common-mode currents that are able to pass through the parasitic coupling of the primary and secondary are shunted to ground to make a very effective commonmode noise filter.



Figure 67. UART Transformer Isolation

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UART Optical Isolation

The daisy-chain may use optical isolation instead of transformer or capacitor isolation (see Figure 68).

Device Initialization Sequence

Immediately after reset, all device addresses are set to 0x00 and the UART baud rate and receive modes have not been autodetected; therefore, the following initialization sequence is recommended after every reset or after any change to the hardware configuration for differential mode:

After the daisy-chain is initialized, each device should be configured for operation as follows:

 Perform a READALL of the status registers: The ALRTRST bit should be set in all devices to signify a reset occurred.

Check for other unexpected alerts.

- 2) Clear the ALRTRST bit on each device so that future unintended resets can be detected.
- Change configuration registers as necessary with WRITEALL commands: Configure the alert enables and alert thresholds

required by the application.

Configure the acquisition mode.

- 4) Perform all necessary key-on diagnostics.
- 5) Start the acquisition cycle.
- 6) Continuously monitor diagnostic and alert status bits.
- 7) Periodically perform additional diagnostics, as required by the application.

Error Checking

Data integrity is provided by Manchester encoding, parity, character framing, and packet-error checking (PEC). The combination of these features verify stage-to-stage communication both in the write and read directions, with a hamming distance (HD) value of 6 for commands with a length up to 247 bits (counted prior to Manchesterencoding and character framing. This is equivalent to the longest possible command packet for a daisy-chain of up to 13 devices. The data-check byte is present in the READALL and READDEVICE commands to verify that the entire command propagated without errors. Using the data-check and PEC bytes, complete transaction integrity for READALL and READDEVICE command packets can be verified.

PEC Errors

If the device receiver receives an invalid PEC byte, the ALRTPEC bit is set in the STATUS register. A device does not execute any write command unless the received PEC matches the calculated PEC so to verify the write command execution, the host should perform a READALL to verify the contents of the written register.

For returned read packets, the host should store the received data, perform the PEC calculation, and compare the results to the received PEC byte before considering the data to be valid. To support PEC, the host must implement an 8-bit cyclic redundancy check (CRC-8) encoding and decoding algorithm based on the following polynomial:

$$\mathsf{P}(\mathsf{x}) = \mathsf{x}^8 + \mathsf{x}^6 + \mathsf{x}^3 + \mathsf{x}^2 + 1$$



Figure 68. UART Optical Isolation

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Figure 69. Device Initialization Sequence in Differential Mode



Figure 70. CRC Calculation

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The host uses the algorithm to process all bytes received in the command packet prior to the PEC byte itself. Neither the PEC nor the alive-counter bytes are part of the calculation. The bits are processed in the order they are received, LSB first. A byte-wise pseudo-code algorithm is shown in <u>Figure 71</u>, but lookup table solutions are also possible to reduce host calculation time. For commonly issued command packets, the host can pre-calculate (hard-code) the PEC byte. For commonly used partial packets, the CRC value of a partial calculation can be used as the initial value for a subsequent run-time calculation.

| F | Function PEC_Calculation(ByteList(), NumberOfBytes, CRCByte) |
|---|---|
| { | // CRCByte is initialized to 0 for each ByteList in this implementation, where // ByteList contains all bytes of a single command. It is passed into the // function in case a partial ByteList calculation is needed. |
| | // Data is transmitted and calculated in LSb first format // Polynomial = x^8+x^6+x^3+x^2+1 POLY = &HB2 // 10110010b for LSb first |
| | //Loop once for each byte in the ByteList For ByteCounter = 0 to (NumberOfBytes – 1) |
| | <pre>//Bitwise XOR the current CRC value with the ByteList byte CRCByte = CRCByte XOR ByteList(Counter1)</pre> |
| | //Process each of the 8 CRCByte remainder bits For BitCounter = 1 To 8 |
| | (// The LSb should be shifted toward the highest order polynomial // coefficient. This is a right shift for data stored LSb to the right // and POLY having high order coefficients stored to the right. |
| | <pre>// Determine if LSb = 1 prior to right shift If (CRCByte AND &H01) = 1 Then // When LSb = 1, right shift and XOR CRCByte value with 8 LSbs // of the polynomial coefficient constant. "/ 2" must be a true right // shift in the target CPU to avoid rounding problems. CRCByte = ((CRCByte / 2) XOR POLY)</pre> |
| | Else //When LSb = 0, right shift by 1 bit. "/ 2" must be a true right // shift in the target CPU to avoid rounding problems. CRCByte = (CRCByte / 2) End If |
| | //Truncate the CRC value to 8 bits if necessary CRCByte = CRCByte AND &HFF |
| | //Proceed to the next bit Next BitCounter) |
| | //Operate on the next data byte in the ByteList Next ByteCounter) |
| } | // All calculations done; CRCByte value is the CRC byte for ByteList() and // the initial CRCByte value Return CRCByte |
| | |

Figure 71. PEC Calculation Pseudocode

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

Register Map

| 0x00 xxxh VERSION Device model and version 0x01 0000h ADRESS Device addresses 0x02 8000h STATUS Status flags 0x04 0000h ARTOELL Voltage-fault alert flags 0x05 0000h ALRTOVCELL Undervoltage alert flags 0x07 0000h ALRTUVCELL Undervoltage alert flags 0x08 0000h ALRTUSCELL Undervoltage alert flags 0x08 0000h ALRTUSCELL Cell number for the highest and lowest voltages measured 0x08 0000h ADR AUTOBALSWDIS Delay Register 0x00 ADR AUTOBALSWDIS Delay Register 0x00 XXXh ID1 Device ID 1 0x10 1002h DEVCFG1 Device onfiguration 1 0x11 0000h GPIO GPIO status and configuration 0x11 0000h ALRTUVEN Measurement enables 0x13 0000h ALRTUVEN Undervoltage alert enables 0x14 0000h ALRTUVEN Undervolta | ADDRESS | POR | NAME | DESCRIPTION |
|--|---------|-------|------------|--|
| 0x02 8000h STATUS Status flags 0x03 0000h ALRTOKELL Voltage-fault alert flags 0x04 0000h ALRTOKELL Voltage-fault alert flags 0x07 0000h ALRTOVCELL Undervoltage alert flags 0x08 0000h ALRTOVCELL Cell number for the highest and lowest voltages measured 0x08 0000h FMEA2 Failure mode flags 2 0x00 0000h ALRTBALSW Balancing switch alert flags 0x00 0000h FMEA2 Failure mode flags 2 0x00 0000h ADR AUTOBALSWDIS Delay Register 0x00 XXXh ID1 Device ID 1 0x01 XXXh ID2 Device configuration 1 0x11 0000h GPIO GPIO status and configuration 0x12 0000h MEASUREEN Measurement enables 0x13 0000h ALRTOVEN Overvoltage alert enables 0x14 0000h ALRTOVEN Undervoltage alert enables 0x14 0000h ALSWEN <td>0x00</td> <td>xxxxh</td> <td>VERSION</td> <td>Device model and version</td> | 0x00 | xxxxh | VERSION | Device model and version |
| 0x03 0000h FMEA1 Failure mode flags 1 0x04 0000h ALRTCELL Voltage-fault alert flags 0x05 0000h ALRTOVCELL Overvoltage alert flags 0x07 0000h ALRTUVCELL Undervoltage alert flags 0x08 0000h ALRTBALSW Balancing switch alert flags 0x08 0000h ALRTBALSW Balancing switch alert flags 0x00 0000h ALRTBALSW Balancing switch alert flags 0x00 0000h FMEA2 Failure mode flags 2 0x00 0000h ADR AUTOBALSWDE Delya Register 0x00 XXXh ID1 Device ID 1 0x00 XXXh ID2 Device ID 2 0x11 1002h DEVCFG1 Device configuration 1 0x11 0000h GPIO GPIO Status and configuration 0x13 0000h ALRTOVEN Overvoltage alert enables 0x14 0000h ALRTOVEN Undervoltage alert enables 0x14 0000h ALRCQEG Acquisit | 0x01 | 0000h | ADDRESS | Device addresses |
| 0x04 0000h ALRTCELL Voltage-fault alert flags 0x05 0000h ALRTOVCELL Overvoltage alert flags 0x08 0000h ALRTUVCELL Undervoltage alert flags 0x08 0000h ALRTALSUW Balancing switch alert flags 0x08 0000h ALRTALSUW Balancing switch alert flags 0x08 0000h ADR AUTOBALSWDIS Delay Register 0x00 0x00h ADR AUTOBALSWDIS Delay Register 0x00 XXXXh ID1 Device ID 1 0x01 1002h DEVCFG1 Device configuration 1 0x11 0000h GPIO GPIO status and configuration 0x12 0000h ALRTUVEN Measurement enables 0x13 0000h ALRTUVEN Overvoltage alert enables 0x14 0000h ALRTUVEN Undervoltage alert enables 0x14 0000h ALQCFG Acquisition configuration 0x14 0000h BALSWEN Balancing switch discharge configuration 0x14 0000h | 0x02 | 8000h | STATUS | Status flags |
| 0x05 0000h ALRTOVCELL Overvoltage alert flags 0x07 0000h ALRTUVCELL Undervoltage alert flags 0x08 0000h ALRTBALSW Balancing switch alert flags 0x08 0000h FMEA2 Cell number for the highest and lowest voltages measured 0x0C 0000h FMEA2 Failure mode flags 2 0x0C 0000h ADR AUTOBALSWDIS Delay Register 0x0D XXXXh ID1 Device ID 1 0x0E XXXXh ID2 Device ID 2 0x10 1002h DEVCFG1 Device configuration 1 0x11 0000h GPIO GPIO status and configuration 0x12 0000h MEASUREEN Measurement enables 0x13 0000h ALRTOVEN Overvoltage alert enables 0x18 0000h ALRTUVEN Undervoltage alert enables 0x18 0000h ALCCFG Acquisition configuration 0x14 0000h BALSWEN Balancing switch enables 0x16 0000h BALCGFG <td>0x03</td> <td>0000h</td> <td>FMEA1</td> <td>Failure mode flags 1</td> | 0x03 | 0000h | FMEA1 | Failure mode flags 1 |
| 0x07 0000h ALRTUVCELL Undervoltage alert flags 0x08 0000h ALRTBALSW Balancing switch alert flags 0x0A 0F0Fh MINMAXCELL Cell number for the highest and lowest voltages measured 0x0B 0000h ADR AUTOBALSWDIS Delay Register 0x0C 0000h ADR AUTOBALSWDIS Delay Register 0x0D XXXXh ID1 Device ID 2 0x10 1002h DEVCFG1 Device configuration 1 0x11 0000h GPIO GPIO Status and configuration 0x12 0000h MEASUREEN Measurement enables 0x13 0000h ALRTOVEN Overvoltage alert enables 0x14 0000h ALRTUVEN Undervoltage alert enables 0x18 0000h ALRTUVEN Undervoltage alert enables 0x14 0000h BALSWEN Balancing switch enables 0x14 0000h BALSWEN Balancing switch discharge configuration 0x14 0000h BALSWEN Balancing switch discharge configuration | 0x04 | 0000h | ALRTCELL | Voltage-fault alert flags |
| 0x08 0000h ALRTBALSW Balancing switch alert flags 0x0A 0F0Fh MINMAXCELL Cell number for the highest and lowest voltages measured 0x0B 0000h FMEA2 Failure mode flags 2 0x0C 0000h ADR AUTOBALSWDIS Delay Register 0x0D XXXkh ID1 Device ID 1 0x0E XXXkh ID2 Device ID 2 0x10 1002h DEVCFG1 Device configuration 1 0x11 0000h SCANCTRL Acquisition control and status 0x11 0000h SCANCTRL Acquisition control and status 0x14 0000h ALRTOVEN Overvoltage alert enables 0x15 0000h ALRTOVEN Undervoltage alert enables 0x18 0000h ALCGFG Acquisition configuration 0x18 0000h BALSWEN Balancing switch enables 0x14 0000h BALSWEG Balancing switch discharge configuration 0x16 0000h BALSWEG Balancing switch discharge configuration 0x16 | 0x05 | 0000h | ALRTOVCELL | Overvoltage alert flags |
| 0x0A 0F0Fh MINMAXCELL Cell number for the highest and lowest voltages measured 0x0B 0000h FMEA2 Failure mode flags 2 0x0C 0000h ADR AUTOBALSWDIS Delay Register 0x0D XXXXh ID1 Device ID 1 0x0E XXXXh ID2 Device ID 1 0x0I 1002h DEVCFG1 Device configuration 1 0x11 0000h GPIO GPIO status and configuration 0x12 0000h MEASUREEN Measurement enables 0x13 0000h ALRTOVEN Overvoitage alert enables 0x14 0000h ALRTUVEN Undervoitage alert enables 0x14 0000h ALRTUVEN Undervoitage alert enables 0x14 0000h ACCFG Acquisition configuration 0x14 0000h ALRTUVEN Undervoitage alert enables 0x14 0000h ACCFG Acquisition configuration 0x14 0000h BALSWEN Balancing switch enables 0x16 0000h DEVCFG2 | 0x07 | 0000h | ALRTUVCELL | Undervoltage alert flags |
| 0x0B 0000h FMEA2 Failure mode flags 2 0x0C 0000h ADR AUTOBALSWDIS Delay Register 0x0D XXXXh ID1 Device ID 1 0x0E XXXXh ID2 Device ID 2 0x10 1002h DEVCFG1 Device onfiguration 1 0x11 0000h GPIO GPIO status and configuration 0x12 0000h MEASUREEN Measurement enables 0x13 0000h SCANCTRL Acquisition control and status 0x14 0000h ALRTUVEN Overroltage alert enables 0x15 0000h ALRTUVEN Undervoltage alert enables 0x14 0000h ALRTUVEN Undervoltage alert enables 0x14 0000h ALRTUVEN Undervoltage alert enables 0x14 0000h ALRTUVEN Balancing switch enables 0x14 0000h BALSWEN Balancing switch enables 0x14 0000h BALSWECHG Balancing switch discharge configuration 0x16 0000h CELL1 <t< td=""><td>0x08</td><td>0000h</td><td>ALRTBALSW</td><td>Balancing switch alert flags</td></t<> | 0x08 | 0000h | ALRTBALSW | Balancing switch alert flags |
| 0x0C 000h ADR AUTOBALSWDIS Delay Register 0x0D XXXxh ID1 Device ID 1 0x0E XXXxh ID2 Device ID 2 0x10 1002h DEVCFG1 Device configuration 1 0x11 0000h GPIO GPIO status and configuration 0x12 0000h MEASUREEN Measurement enables 0x14 0000h ALRTOVEN Overvoltage alert enables 0x15 0000h ALRTOVEN Overvoltage alert enables 0x18 0000h ALRTOVEN Undervoltage alert enables 0x18 0000h ACQCFG Acquisition configuration 0x18 0000h BALSWEN Balancing switch enables 0x110 0000h BALSWEN Balancing switch discharge configuration 0x110 0000h BALSWDCHG Balancing switch discharge configuration 0x110 0000h BALSWDCHG Balancing switch discharge configuration 0x120 0000h CELL1 Coll a measurement result 0x221 0000h | 0x0A | 0F0Fh | MINMAXCELL | Cell number for the highest and lowest voltages measured |
| 0x0DXXXXhID1Device ID 10x0EXXXXhID2Device ID 20x101002hDEVCFG1Device configuration 10x110000hGPIOGPIO status and configuration0x120000hMEASUREENMeasurement enables0x130000hSCANCTRLAcquisition control and status0x140000hALRTOVENOvervoltage alert enables0x150000hALRTOVENUndervoltage alert enables0x180000hTIMERCFGTimer configuration0x190000hBALSWENBalancing switch enables0x1A0000hBALSWENBalancing switch discharge configuration0x1D0000hBALDIAGCFGBalancing switch discharge configuration0x1D0000hBALSWDCHGBalancing switch discharge configuration0x120000hCELL1Cell 1 measurement result0x200000hCELL2Cell 3 measurement result0x220000hCELL3Cell 4 measurement result0x240000hCELL4Cell 4 measurement result0x250000hCELL6Cell 6 measurement result0x270000hCELL1Cell 1 measurement result0x280000hCELL10Cell 10 measurement result0x240000hCELL10Cell 10 measurement result0x280000hCELL10Cell 11 measurement result0x280000hCELL12Cell 21 measurement result0x280000hCELL12Cell 11 mea | 0x0B | 0000h | FMEA2 | Failure mode flags 2 |
| 0x0E XXXXh ID2 Device ID 2 0x10 1002h DEVCFG1 Device configuration 1 0x11 0000h GPIO GPIO status and configuration 0x12 0000h MEASUREEN Measurement enables 0x13 0000h SCANCTRL Acquisition control and status 0x14 0000h ALRTOVEN Overvoltage alert enables 0x15 0000h ALRTOVEN Undervoltage alert enables 0x18 0000h TIMERCFG Timer configuration 0x14 0000h BALSWEN Balancing switch enables 0x18 0000h DEVCFG2 Device configuration 2 0x1C 0000h BALDIAGCFG Balancing switch discharge configuration 0x1D 0000h BALDIAGCFG Balancing switch discharge configuration 0x12 0000h CELL1 Cell 1 measurement result 0x20 0000h CELL1 Cell 2 measurement result 0x21 0000h CELL4 Cell 4 measurement result 0x22 0000h | 0x0C | 0000h | ADR | AUTOBALSWDIS Delay Register |
| 0x101002hDEVCFG1Device configuration 10x110000hGPIOGPIO status and configuration0x120000hMEASUREENMeasurement enables0x130000hSCANCTRLAcquisition control and status0x140000hALRTOVENOvervoltage alert enables0x150000hALRTUVENUndervoltage alert enables0x180000hALRTUVENUndervoltage alert enables0x180000hALQCFGAcquisition configuration0x190000hBALSWENBalancing switch enables0x1100000hBALSWENBalancing switch discharge configuration0x1110000hBALDIAGCFGBalancing switch discharge configuration0x1110000hBALSWENGBalancing switch discharge configuration0x1110000hBALSWENGBalancing switch discharge configuration0x1110000hBALSWENGBalancing switch discharge configuration0x1110000hCELL1Cell 1 measurement result0x200000hCELL2Cell 2 measurement result0x220000hCELL3Cell 3 measurement result0x230000hCELL4Cell 4 measurement result0x240000hCELL6Cell 6 measurement result0x250000hCELL7Cell 7 measurement result0x280000hCELL10Cell 9 measurement result0x280000hCELL11Cell 10 measurement result0x280000hCELL12Cell 11 measurement | 0x0D | XXXXh | ID1 | Device ID 1 |
| 0x110000hGPIOGPIO status and configuration0x120000hMEASUREENMeasurement enables0x130000hSCANCTRLAcquisition control and status0x140000hALRTOVENOvervoltage alert enables0x150000hALRTUVENUndervoltage alert enables0x180000hALRTUVENUndervoltage alert enables0x190000hACQCFGAcquisition configuration0x140000hBALSWENBalancing switch enables0x180000hDEVCFG2Device configuration 20x100000hBALDIAGCFGBalancing diagnostic configuration0x100000hBALDIAGCFGBalancing diagnostic configuration0x110000hBALDIAGCFGBalancing diagnostic configuration0x120000hCELL1Cell 1 measurement result0x200000hCELL2Cell 2 measurement result0x220000hCELL3Cell 3 measurement result0x230000hCELL4Cell 4 measurement result0x240000hCELL6Cell 6 measurement result0x250000hCELL7Cell 7 measurement result0x280000hCELL10Cell 9 measurement result0x280000hCELL11Cell 9 measurement result0x280000hCELL12Cell 10 measurement result0x280000hCELL12Cell 10 measurement result0x280000hCELL12Cell 11 measurement result0x280000h | 0x0E | XXXXh | ID2 | Device ID 2 |
| 0x120000hMEASUREENMeasurement enables0x130000hSCANCTRLAcquisition control and status0x140000hALRTOVENOvervoltage alert enables0x150000hALRTUVENUndervoltage alert enables0x180000hTIMERCFGTimer configuration0x190000hACQCFGAcquisition configuration0x1A0000hBALSWENBalancing switch enables0x1C0000hDEVCFG2Device configuration 20x1C0000hBALISWENBalancing diagnostic configuration0x1D0000hBALSWDCHGBalancing switch discharge configuration0x1E0000hCELL1Top cell configuration0x200000hCELL1Cell 2 measurement result0x210000hCELL3Cell 3 measurement result0x220000hCELL4Cell 4 measurement result0x230000hCELL5Cell 5 measurement result0x240000hCELL6Cell 6 measurement result0x270000hCELL9Cell 9 measurement result0x280000hCELL10Cell 10 measurement result0x280000hCELL10Cell 11 measurement result0x280000hCELL10Cell 11 measurement result0x280000hCELL10Cell 11 measurement result0x280000hCELL12Cell 11 measurement result0x280000hCELL12Cell 11 measurement result0x280000hCELL12Cell | 0x10 | 1002h | DEVCFG1 | Device configuration 1 |
| 0x130000hSCANCTRLAcquisition control and status0x140000hALRTOVENOvervoltage alert enables0x150000hALRTUVENUndervoltage alert enables0x180000hTIMERCFGTimer configuration0x190000hACQCFGAcquisition configuration0x1A0000hBALSWENBalancing switch enables0x1B0000hDEVCFG2Device configuration 20x1C0000hBALDIAGCFGBalancing diagnostic configuration0x1D0000hBALSWDCHGBalancing switch discharge configuration0x1E0000hCELL1Coll 1 measurement result0x200000hCELL2Cell 2 measurement result0x210000hCELL3Cell 3 measurement result0x230000hCELL4Cell 6 measurement result0x240000hCELL5Cell 6 measurement result0x270000hCELL6Cell 6 measurement result0x280000hCELL1Cell 9 measurement result0x280000hCELL4Cell 1 measurement result0x280000hCELL4Cell 9 measurement result0x280000hCELL10Cell 9 measurement result0x280000hCELL10Cell 10 measurement result0x280000hCELL11Cell 10 measurement result0x280000hCELL12Cell 11 measurement result0x280000hCELL12Cell 11 measurement result | 0x11 | 0000h | GPIO | GPIO status and configuration |
| 0x140000hALRTOVENOvervoltage alert enables0x150000hALRTUVENUndervoltage alert enables0x180000hTIMERCFGTimer configuration0x190000hACQCFGAcquisition configuration0x1A0000hBALSWENBalancing switch enables0x1B0000hDEVCFG2Device configuration 20x1C0000hBALDIAGCFGBalancing diagnostic configuration0x1D0000hBALSWDCHGBalancing switch discharge configuration0x1E0000hCELL1Cell 1 measurement result0x200000hCELL2Cell 2 measurement result0x210000hCELL3Cell 3 measurement result0x230000hCELL4Cell 4 measurement result0x240000hCELL5Cell 6 measurement result0x270000hCELL6Cell 6 measurement result0x280000hCELL1Cell 9 measurement result0x280000hCELL10Cell 9 measurement result0x280000hCELL10Cell 10 measurement result0x280000hCELL11Cell 10 measurement result0x280000hCELL12Cell 11 measurement result0x280000hCELL11Cell 11 measurement result0x280000hCELL12Cell 11 measurement result0x280000hCELL12Cell 11 measurement result0x280000hCELL11Cell 11 measurement result0x280000hCELL12Cel | 0x12 | 0000h | MEASUREEN | Measurement enables |
| 0x150000hALRTUVENUndervoltage alert enables0x180000hTIMERCFGTimer configuration0x190000hACQCFGAcquisition configuration0x1A0000hBALSWENBalancing switch enables0x1B0000hDEVCFG2Device configuration 20x1C0000hBALDIAGCFGBalancing diagnostic configuration0x1D0000hBALSWDCHGBalancing switch discharge configuration0x1E0000hCELL1Cell 1 measurement result0x200000hCELL2Cell 2 measurement result0x210000hCELL3Cell 3 measurement result0x230000hCELL4Cell 4 measurement result0x240000hCELL5Cell 5 measurement result0x250000hCELL7Cell 7 measurement result0x270000hCELL8Cell 9 measurement result0x280000hCELL10Cell 1 measurement result0x280000hCELL11Cell 10 measurement result0x280000hCELL12Cell 12 measurement result0x280000hCELL12Cell 12 measurement result | 0x13 | 0000h | SCANCTRL | Acquisition control and status |
| 0x18000hTIMERCFGTimer configuration0x19000hACQCFGAcquisition configuration0x1A000hBALSWENBalancing switch enables0x1B000hDEVCFG2Device configuration 20x1C000hBALDIAGCFGBalancing diagnostic configuration0x1D000hBALSWDCHGBalancing switch discharge configuration0x1E000chTOPCELLTop cell configuration0x20000hCELL1Cell 1 measurement result0x21000hCELL2Cell 2 measurement result0x22000hCELL3Cell 3 measurement result0x23000hCELL4Cell 6 measurement result0x24000hCELL5Cell 6 measurement result0x25000hCELL7Cell 7 measurement result0x26000hCELL4Cell 8 measurement result0x27000hCELL4Cell 9 measurement result0x28000hCELL4Cell 9 measurement result0x28000hCELL4Cell 10 measurement result0x28000hCELL4Cell 11 measurement result0x28000hCELL10Cell 11 measurement result0x28000hCELL12Cell 11 measurement result0x28000hCELL12Cell 11 measurement result0x28000hCELL12Cell 12 measurement result | 0x14 | 0000h | ALRTOVEN | Overvoltage alert enables |
| 0x190000hACQCFGAcquisition configuration0x1A0000hBALSWENBalancing switch enables0x1B0000hDEVCFG2Device configuration 20x1C0000hBALDIAGCFGBalancing diagnostic configuration0x1D0000hBALSWDCHGBalancing switch discharge configuration0x1E0000hTOPCELLTop cell configuration0x200000hCELL1Cell 1 measurement result0x210000hCELL2Cell 2 measurement result0x220000hCELL3Cell 3 measurement result0x230000hCELL4Cell 4 measurement result0x240000hCELL6Cell 6 measurement result0x250000hCELL7Cell 7 measurement result0x260000hCELL10Cell 9 measurement result0x280000hCELL10Cell 9 measurement result0x280000hCELL10Cell 10 measurement result0x280000hCELL11Cell 11 measurement result0x280000hCELL11Cell 11 measurement result0x280000hCELL11Cell 11 measurement result0x280000hCELL11Cell 11 measurement result0x280000hCELL11Cell 12 measurement result0x280000hCELL12Cell 12 measurement result | 0x15 | 0000h | ALRTUVEN | Undervoltage alert enables |
| 0x1A0000hBALSWENBalancing switch enables0x1B0000hDEVCFG2Device configuration 20x1C0000hBALDIAGCFGBalancing diagnostic configuration0x1D0000hBALSWDCHGBalancing switch discharge configuration0x1E000ChTOPCELLTop cell configuration0x200000hCELL1Cell 1 measurement result0x210000hCELL2Cell 2 measurement result0x220000hCELL3Cell 3 measurement result0x230000hCELL4Cell 4 measurement result0x240000hCELL5Cell 5 measurement result0x250000hCELL6Cell 6 measurement result0x260000hCELL6Cell 9 measurement result0x270000hCELL17Cell 7 measurement result0x280000hCELL9Cell 9 measurement result0x290000hCELL10Cell 10 measurement result0x240000hCELL12Cell 10 measurement result0x280000hCELL12Cell 11 measurement result0x280000hCELL11Cell 11 measurement result0x280000hCELL11Cell 11 measurement result0x280000hCELL12Cell 11 measurement result0x280000hCELL12Cell 11 measurement result0x280000hCELL12Cell 11 measurement result0x280000hCELL12Cell 12 measurement result | 0x18 | 0000h | TIMERCFG | Timer configuration |
| 0x1B0000hDEVCFG2Device configuration 20x1C0000hBALDIAGCFGBalancing diagnostic configuration0x1D0000hBALSWDCHGBalancing switch discharge configuration0x1E0000hTOPCELLTop cell configuration0x200000hCELL1Cell 1 measurement result0x210000hCELL2Cell 2 measurement result0x220000hCELL3Cell 3 measurement result0x230000hCELL4Cell 4 measurement result0x240000hCELL5Cell 5 measurement result0x250000hCELL6Cell 6 measurement result0x260000hCELL7Cell 7 measurement result0x270000hCELL9Cell 9 measurement result0x280000hCELL9Cell 9 measurement result0x290000hCELL10Cell 10 measurement result0x2A0000hCELL11Cell 11 measurement result0x280000hCELL11Cell 10 measurement result0x280000hCELL11Cell 11 measurement result0x280000hCELL11Cell 11 measurement result0x280000hCELL12Cell 12 measurement result0x280000hCELL11Cell 11 measurement result0x280000hCELL12Cell 12 measurement result | 0x19 | 0000h | ACQCFG | Acquisition configuration |
| 0x1C0000hBALDIAGCFGBalancing diagnostic configuration0x1D0000hBALSWDCHGBalancing switch discharge configuration0x1E000ChTOPCELLTop cell configuration0x200000hCELL1Cell 1 measurement result0x210000hCELL2Cell 2 measurement result0x220000hCELL3Cell 3 measurement result0x230000hCELL4Cell 4 measurement result0x240000hCELL5Cell 5 measurement result0x250000hCELL6Cell 6 measurement result0x260000hCELL7Cell 7 measurement result0x270000hCELL8Cell 9 measurement result0x280000hCELL9Cell 9 measurement result0x290000hCELL10Cell 10 measurement result0x240000hCELL10Cell 11 measurement result0x280000hCELL2Cell 12 measurement result | 0x1A | 0000h | BALSWEN | Balancing switch enables |
| 0x1D0000hBALSWDCHGBalancing switch discharge configuration0x1E0000hTOPCELLTop cell configuration0x200000hCELL1Cell 1 measurement result0x210000hCELL2Cell 2 measurement result0x220000hCELL3Cell 3 measurement result0x230000hCELL4Cell 4 measurement result0x240000hCELL5Cell 5 measurement result0x250000hCELL6Cell 6 measurement result0x260000hCELL7Cell 7 measurement result0x270000hCELL8Cell 9 measurement result0x280000hCELL9Cell 9 measurement result0x290000hCELL10Cell 10 measurement result0x2A0000hCELL11Cell 11 measurement result0x280000hCELL11Cell 11 measurement result0x280000hCELL11Cell 11 measurement result0x280000hCELL12Cell 12 measurement result | 0x1B | 0000h | DEVCFG2 | Device configuration 2 |
| 0x1E000ChTOPCELLTop cell configuration0x20000hCELL1Cell 1 measurement result0x21000hCELL2Cell 2 measurement result0x22000hCELL3Cell 3 measurement result0x23000hCELL4Cell 4 measurement result0x24000hCELL5Cell 5 measurement result0x25000hCELL6Cell 6 measurement result0x26000hCELL7Cell 7 measurement result0x27000hCELL8Cell 9 measurement result0x28000hCELL9Cell 10 measurement result0x29000hCELL10Cell 11 measurement result0x2A000hCELL11Cell 11 measurement result0x28000hCELL11Cell 11 measurement result0x29000hCELL11Cell 11 measurement result0x28000hCELL11Cell 11 measurement result0x28000hCELL12Cell 12 measurement result | 0x1C | 0000h | BALDIAGCFG | Balancing diagnostic configuration |
| 0x200000hCELL1Cell 1 measurement result0x210000hCELL2Cell 2 measurement result0x220000hCELL3Cell 3 measurement result0x230000hCELL4Cell 4 measurement result0x240000hCELL5Cell 5 measurement result0x250000hCELL6Cell 6 measurement result0x260000hCELL7Cell 7 measurement result0x270000hCELL8Cell 8 measurement result0x280000hCELL10Cell 9 measurement result0x290000hCELL10Cell 10 measurement result0x2A0000hCELL11Cell 11 measurement result0x2B0000hCELL12Cell 12 measurement result | 0x1D | 0000h | BALSWDCHG | Balancing switch discharge configuration |
| 0x210000hCELL2Cell 2 measurement result0x220000hCELL3Cell 3 measurement result0x230000hCELL4Cell 4 measurement result0x240000hCELL5Cell 5 measurement result0x250000hCELL6Cell 6 measurement result0x260000hCELL7Cell 7 measurement result0x270000hCELL8Cell 8 measurement result0x280000hCELL9Cell 9 measurement result0x290000hCELL10Cell 10 measurement result0x2A0000hCELL11Cell 11 measurement result0x2B0000hCELL12Cell 12 measurement result | 0x1E | 000Ch | TOPCELL | Top cell configuration |
| 0x220000hCELL3Cell 3 measurement result0x230000hCELL4Cell 4 measurement result0x240000hCELL5Cell 5 measurement result0x250000hCELL6Cell 6 measurement result0x260000hCELL7Cell 7 measurement result0x270000hCELL8Cell 8 measurement result0x280000hCELL9Cell 9 measurement result0x290000hCELL10Cell 10 measurement result0x2A0000hCELL11Cell 11 measurement result0x2B0000hCELL12Cell 12 measurement result | 0x20 | 0000h | CELL1 | Cell 1 measurement result |
| 0x230000hCELL4Cell 4 measurement result0x240000hCELL5Cell 5 measurement result0x250000hCELL6Cell 6 measurement result0x260000hCELL7Cell 7 measurement result0x270000hCELL8Cell 8 measurement result0x280000hCELL9Cell 9 measurement result0x290000hCELL10Cell 10 measurement result0x2A0000hCELL11Cell 11 measurement result0x2B0000hCELL12Cell 12 measurement result | 0x21 | 0000h | CELL2 | Cell 2 measurement result |
| 0x240000hCELL5Cell 5 measurement result0x250000hCELL6Cell 6 measurement result0x260000hCELL7Cell 7 measurement result0x270000hCELL8Cell 8 measurement result0x280000hCELL9Cell 9 measurement result0x290000hCELL10Cell 10 measurement result0x2A0000hCELL11Cell 11 measurement result0x2B0000hCELL12Cell 12 measurement result | 0x22 | 0000h | CELL3 | Cell 3 measurement result |
| 0x250000hCELL6Cell 6 measurement result0x260000hCELL7Cell 7 measurement result0x270000hCELL8Cell 8 measurement result0x280000hCELL9Cell 9 measurement result0x290000hCELL10Cell 10 measurement result0x2A0000hCELL11Cell 11 measurement result0x2B0000hCELL12Cell 12 measurement result | 0x23 | 0000h | CELL4 | Cell 4 measurement result |
| 0x260000hCELL7Cell 7 measurement result0x270000hCELL8Cell 8 measurement result0x280000hCELL9Cell 9 measurement result0x290000hCELL10Cell 10 measurement result0x2A0000hCELL11Cell 11 measurement result0x2B0000hCELL12Cell 12 measurement result | 0x24 | 0000h | CELL5 | Cell 5 measurement result |
| 0x270000hCELL8Cell 8 measurement result0x280000hCELL9Cell 9 measurement result0x290000hCELL10Cell 10 measurement result0x2A0000hCELL11Cell 11 measurement result0x2B0000hCELL12Cell 12 measurement result | 0x25 | 0000h | CELL6 | Cell 6 measurement result |
| 0x280000hCELL9Cell 9 measurement result0x290000hCELL10Cell 10 measurement result0x2A0000hCELL11Cell 11 measurement result0x2B0000hCELL12Cell 12 measurement result | 0x26 | 0000h | CELL7 | Cell 7 measurement result |
| 0x290000hCELL10Cell 10 measurement result0x2A0000hCELL11Cell 11 measurement result0x2B0000hCELL12Cell 12 measurement result | 0x27 | 0000h | CELL8 | Cell 8 measurement result |
| 0x2A 0000h CELL11 Cell 11 measurement result 0x2B 0000h CELL12 Cell 12 measurement result | 0x28 | 0000h | CELL9 | Cell 9 measurement result |
| 0x2B 0000h CELL12 Cell 12 measurement result | 0x29 | 0000h | CELL10 | Cell 10 measurement result |
| | 0x2A | 0000h | CELL11 | Cell 11 measurement result |
| 0x2C 0000h BLOCK Block measurement result | 0x2B | 0000h | CELL12 | Cell 12 measurement result |
| | 0x2C | 0000h | BLOCK | Block measurement result |

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

Register Map (continued)

| ADDRESS | POR | NAME | DESCRIPTION |
|---------|-------|------------|--|
| 0x2D | 0000h | | AUXIN1 measurement result |
| 0x2E | 0000h | AIN2 | AUXIN2 measurement result |
| 0x2F | 0000h | TOTAL | Sum of all cell measurements |
| 0x40 | FFFCh | OVTHCLR | Cell overvoltage clear threshold |
| 0x42 | FFFCh | OVTHSET | Cell overvoltage set threshold |
| 0x44 | 0000h | UVTHCLR | Cell undervoltage clear threshold |
| 0x46 | 0000h | UVTHSET | Cell undervoltage set threshold |
| 0x48 | FFFCh | MSMTCH | Cell mismatch threshold |
| 0x49 | 0000h | AINOT | AUXIN overtemperature threshold |
| 0x4A | FFF0h | AINUT | AUXIN undertemperature threshold |
| 0x4B | 0000h | BALSHRTTHR | Balancing switch diagnostic, short-circuit threshold |
| 0x4C | 0000h | BALLOWTHR | Balancing switch diagnostic, on-state low threshold |
| 0x4D | 0000h | BALHIGHTHR | Balancing switch diagnostic, on-state high threshold |
| 0x50 | 0000h | DIAG | Diagnostic measurement result |
| 0x51 | 0000h | DIAGCFG | Diagnostic configuration |
| 0x52 | 0000h | CTSTCFG | Test source configuration |
| 0x57 | 0000h | ADCTEST1A | User-specified data for ALU diagnostic |
| 0x58 | 0000h | ADCTEST1B | User-specified data for ALU diagnostic |
| 0x59 | 0000h | ADCTEST2A | User-specified data for ALU diagnostic |
| 0x5A | 0000h | ADCTEST2B | User-specified data for ALU diagnostic |

VERSION Register (address 0x00)

| BIT | POR | NAME | DESCRIPTION |
|-----|-------|-------------|----------------------------------|
| D15 | | | |
| D14 | | | |
| D13 | | | |
| D12 | | | |
| D11 | | | |
| D10 | 843h | MOD[11:0] | Model number. Always reads 843h. |
| D9 | 04311 | | Model humber. Always reads 645h. |
| D8 | | | |
| D7 | | | |
| D6 | | | |
| D5 | | | |
| D4 | | | |
| D3 | | | |
| D2 | 1h | VER[3:0] | Die version as below: |
| D1 | | v Li ([3.0] | MAX17843 = 1h |
| D0 | | | |

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ADDRESS Register (address 0x01)

| BIT | POR | NAME | DESCRIPTION |
|-----|-----|----------|--|
| D15 | | | |
| D14 | 0 | Reserved | Always reads logic-zero. |
| D13 | | | |
| D12 | | | |
| D11 | | | Address of the device connected to the host (first address). If the host uses a first address other than 0x00 in the HELLOALL command, then the host must write that first address |
| D10 | 0 | FA[4:0] | to all devices in the daisy-chain with a WRITEALL command. READALL commands |
| D9 | | | require that FA[4:0] and DA[4:0] be correct in order for the data-check and PEC features to function as intended. |
| D8 | | | |
| D7 | | | |
| D6 | 0 | Reserved | Always reads logic-zero. |
| D5 | | | |
| D4 | | | |
| D3 | | | Device address written by the HELLOALL command as it propagates up the daisy-chain and is automatically incremented for each device. The host must choose a first address |
| D2 | 0 | DA[4:0] | so that the last device address does not exceed the maximum address of 0x1F during the |
| D1 | | | HELLOALL command. Writing has no effect except with a HELLOALL command while ADDRUNLOCK = 1. |
| D0 | | | |

STATUS Register (address 0x02)

| BIT | POR | NAME | DESCRIPTION |
|----------|-----|-------------|--|
| D15 | 1 | ALRTRST | Indicates a power-on reset (POR) event occurred. Clear after power-on and after a successful HELLOALL to detect future resets. Writing to a logic-one has no effect. |
| D14 | 0 | ALRTOV | Bit-wise logical OR of ALRTOVCELL[15:0]. Read-only. |
| D13 | 0 | ALRTUV | Bit-wise logical OR of ALRTUVCELL[15:0]. Read-only. |
| D12 | 0 | ALRTSHDNL | Indicates $V_{SHDNL} < V_{IL}$. Read during shutdown diagnostic when $V_{AA} > V_{PORFALL}$. Cleared by writing to logic-zero or POR. Writing to a logic-one has no effect. |
| D11 | 0 | ALRTSHDNLRT | Indicates $V_{SHDNL} < V_{IL}$. Read during shutdown diagnostic when $V_{AA} > V_{PORFALL}$. Read-only. |
| D10 | 0 | ALRTMSMTCH | Indicates V _{MAX} - V _{MIN} > V _{MSMTCH} . Cleared at next acquisition if the condition is false. Read-only. |
| D9 | 0 | ALRTTCOLD | Logical OR of ALRTOVAIN0 and ALRTOVAIN1. Read-only. |
| D8 | 0 | ALRTTHOT | Logical OR of ALRTUVAIN0 and ALRTUVAIN1. Read-only. |
| D7 | 0 | ALRTPEC | Indicates a received character contained a PEC error. Cleared only by writing to logic-zero. Writing to a logic-one has no effect. |
| D6 D5 | 0 | Reserved | Always reads logic-zero. |
| D4 | 0 | ALRTMAN | Indicates that a character received by the lower UART contained a Manchester error. Cleared only by writing to logic-zero. Writing to a logic-one has no effect. |
| D3 | 0 | 0 | Write ignored, Read back '0'. |
| D2 | 0 | ALRTPAR | Indicates that a character received by the lower UART contained a parity error. Cleared only by writing to logic-zero. Writing to logic-one has no effect. |
| D1 | 0 | ALRTFMEA2 | Bit-wise logical OR of FMEA2 [15:0]. Read-only. |
| D0 | 0 | ALRTFMEA1 | Bit-wise logical OR of FMEA1 [15:0]. Read-only. |

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FMEA1 Register (address 0x03)

| BIT | POR | NAME | DESCRIPTION |
|-----|-----|--------------|---|
| D15 | 0 | ALRTOSC1 | Indicates that the 32kHz oscillator frequency is not within $\pm 5\%$ of its expected value. The status is updated every two cycles (32kHz). Cleared only by writing to logic-zero. Writing to a logic-one has no effect. |
| D14 | 0 | ALRTOSC2 | Same as ALRTOSC1 (redundant alert). Cleared only by writing to logic-zero. Writing to a logic-one has no effect. |
| D13 | 0 | 0 | Always reads logic-zero. |
| D12 | 0 | ALRTCOMMSEU1 | Indicates that the UART has placed the upper-port receiver in single-ended mode based on the first preamble received after POR. This bit is not set until the ALRTRST bit is cleared. Read-only. |
| D11 | 0 | ALRTCOMMSEL1 | Indicates that the UART has placed the lower-port receiver in single-ended mode based on the first preamble received after POR. This bit is not set until the ALRTRST bit is cleared. Read-only. |
| D10 | 0 | ALRTCOMMSEU2 | Same as ALRTCOMMSEU1 (redundant alert) except that it sets before ALRTRST is cleared. Read-only. |
| D9 | 0 | ALRTCOMMSEL2 | Same as ALRTCOMMSEL2 (redundant alert) except that it sets before ALRTRST is cleared. Read-only. |
| D8 | 0 | ALRTVDDL3 | Indicates V _{DDL3} < V _{VDDL_OC} . This bit is not set until the ALRTRST bit is cleared, and cleared only by writing to logic-zero. Writing to a logic-one has no effect. |
| D7 | 0 | ALRTVDDL2 | Indicates V _{DDL2} < V _{VDDL_OC} . This bit is not set until the ALRTRST bit is cleared, and cleared only by writing to logic-zero. Writing to a logic-one has no effect. |
| D6 | 0 | ALRTGNDL2 | Indicates an open circuit on the GNDL2 pin. This bit is not set until the ALRTRST bit is cleared, and cleared only by writing to logic-zero. Writing to a logic-one has no effect. |
| D5 | 0 | ALRTBALSW | Bit-wise logical OR of ALRTBALSW[15:0]. Cleared automatically if the fault is cleared, or by writing it to logic-zero. |
| D4 | 0 | ALRTTEMP | Indicates that $T_{DIE} > 115^{\circ}C$ (120°C typ) or that the diagnostic measurement did not have sufficient settling time (< 50µs) and therefore may not be accurate. Cleared only by writing to logic-zero. Writing to a logic-one has no effect. |
| D3 | 0 | ALRTHVUV | Indicates V _{HV} < V _{HVUV} . This bit is not set until the ALRTRST bit is cleared, and cleared only by writing to logic-zero. Writing to logic-one has no effect. |
| D2 | 0 | ALRTGNDL3 | Indicates an open circuit on the GNDL3 pin. This bit is not set until the ALRTRST bit is cleared, and cleared only by writing to logic-zero. Writing to a logic-one has no effect. |
| D1 | 0 | ALRTVDDL1 | Indicates V _{DDL1} < V _{VDDL_OC} . This bit is not set until the ALRTRST bit is cleared and cleared only by writing to logic-zero. Writing to a logic-one has no effect. |
| D0 | 0 | ALRTGNDL1 | Indicates an open circuit on the GNDL1 pin. This bit is not set until the ALRTRST bit is cleared, and cleared only by writing to logic-zero. Writing to a logic-one has no effect. |

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ALRTCELL Register (address 0x04)

| BIT | POR | NAME | DESCRIPTION |
|-----|-----|----------------|--|
| D15 | _ | Deserved | |
| D14 | 0 | Reserved | Always reads logic-zero. |
| D13 | 0 | ALRTAIN1 | Logical OR of ALRTOVAIN1 and ALRTUVAIN1. Read-only. |
| D12 | 0 | ALRTAIN0 | Logical OR of ALRTOVAIN0 and ALRTUVAIN0. Read-only. |
| D11 | | | |
| D10 | | | |
| D9 | | | |
| D8 | | | |
| D7 | | | |
| D6 | 0 | | AL PTCELL [n] is the legisle OP of AL POVCELL [n] and AL PTUVCELL [n]. Read Only |
| D5 | 0 | ALRTCELL[12:1] | ALRTCELL[n] is the logical OR of ALROVCELL[n] and ALRTUVCELL[n]. Read-Only. |
| D4 | | | |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

ALRTOVCELL Register (address 0x05)

| BIT | POR | NAME | DESCRIPTION | |
|-----|-----|--------------|--|--|
| D15 | 0 | | | |
| D14 | 0 | Reserved | Always reads logic-zero. | |
| D13 | 0 | ALRTOVAIN1 | Indicates V _{AIN1} > AINUT (cold). Cleared at next acquisition if the condition is false. Read-only. | |
| D12 | 0 | ALRTOVAIN0 | Indicates V _{AIN0} > AINUT (cold). Cleared at next acquisition if the condition is false. Read-only. | |
| D11 | | | | |
| D10 | | | | |
| D9 | | | | |
| D8 | | | | |
| D7 | | | | |
| D6 | 0 | ALRTOV[12:1] | ALRTOV[n] indicates V _{CELLn} > V _{OV} (OVTHRSET threshold) if ALRTOVEN[n] = 1 . Cleared | |
| D5 | 0 | ALITOV[12.1] | at next acquisition if the condition is false. Read-only. | |
| D4 | | | | |
| D3 | | | | |
| D2 | | | | |
| D1 | | | | |
| D0 | | | | |

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| BIT | POR | NAME | DESCRIPTION |
|-----|-----|--------------|---|
| D15 | 0 | Reserved | Always reads logic-zero. |
| D14 | 0 | Reserved | Always leads logic-zelo. |
| D13 | 0 | ALRTUVAIN1 | Indicates V _{AIN1} < AINOT (hot). Cleared at next acquisition if the condition is false. Read-only. |
| D12 | 0 | ALRTUVAIN0 | Indicates V _{AIN0} < AINOT (hot). Cleared at next acquisition if the condition is false. Read-only. |
| D11 | | | |
| D10 | | | |
| D9 | | | |
| D8 | | | |
| D7 | | | |
| D6 | 0 | ALRTUV[12:1] | ALRTUV[n] indicates V _{CELLn} < V _{UV} (UVTHRSET threshold) if ALRTUVEN[n] = 1 . Cleared |
| D5 | 0 | ALITOV[12.1] | at next acquisition if the condition is false. Read-only. |
| D4 | | | |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

ALRTUVCELL Register (address 0x07)

ALRTBALSW Register (address 0x08)

| BIT | POR | NAME | DESCRIPTION |
|-----|-----|-----------------|--|
| D15 | | | |
| D14 | 0 | Reserved | Always reads logic-zero. |
| D13 | 0 | Reserved | Always leads logic-zelo. |
| D12 | | | |
| D11 | | | |
| D10 | | | |
| D9 | | | |
| D8 | | | |
| D7 | | | |
| D6 | 0 | ALRTBALSW[11:0] | ALRTBALSW[n] indicates the corresponding measurement result exceeds the threshold specified by BALSWDIAG[2:0]. Cleared at next acquisition if the condition is false. |
| D5 | 0 | ALKIBALSW[11.0] | Read-only. |
| D4 | | | |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

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BIT POR NAME DESCRIPTION D15 D14 0 Reserved Always reads logic-zero. D13 D12 D11 Cell number of the maximum cell voltage currently in the measurement registers. If D10 Fh MAXCELL[3:0] multiple cells have the same maximum value, this field contains the highest cell number D9 with that measurement. Read-only. D8 D7 D6 0 Reserved Always reads logic-zero. D5 D4 D3 Cell number of the minimum cell voltage currently in the measurement registers. If multiple D2 Fh MINCELL[3:0] cells have the same minimum value, this field contains the highest cell number with that D1 measurement. Read-only. D0

MINMAXCELL Register (address 0x0A)

FMEA2 Register (address 0x0B)

| BIT | POR | NAME | DESCRIPTION |
|-----|-----|------------|--|
| D15 | | | |
| D14 | | | |
| D13 | | | |
| D12 | | | |
| D11 | | | |
| D10 | | | |
| D9 | 0 | Reserved | Always reads logic-zero. |
| D8 | | | |
| D7 | | | |
| D6 | | | |
| D5 | | | |
| D4 | | | |
| D3 | | | |
| D2 | 0 | ALRTHVHDRM | Indicates that V_{HV} - V_{C12} was too low during the acquisition for an accurate measurement. Cleared only by writing to logic-zero. Writing to a logic-one has no effect. |
| D1 | 0 | Reserved | Always reads logic-zero. |
| D0 | 0 | ALRTHVOV | Indicates that $V_{HV} > V_{HVOV}$. This bit is not set until the ALRTRST bit is cleared and cleared only by writing to logic-zero. Writing to a logic-one has no effect. |

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AUTOBALSWDIS Delay Register (address 0x0C)

| BIT | POR | NAME | DESCRIPTION | |
|-----|-----|----------------------------------|---|---|
| D15 | | Diagnostic Recovery Time[7:0] | Time delay for cell recovery after diagnostic configuration. Default time is 96µs, with maximum time of 24.576ms. | |
| D14 | | | DIAGNOSTIC RECOVERY TIME[7:0] | DELAY TIME IN μs |
| D13 | | | 0000000 | 96 |
| D12 | | | 0000001 | 192 |
| D11 | 0 | | 0000010 | 288 |
| D10 | | | 00000011 | 384 |
| | | | 00000100 | 480 |
| D9 | | | | |
| | | | 1111110 | 24480 |
| D8 | | | 1111111 | 24576 |
| D7 | | Cell Recovery Time[7:0] | Time delay for cell recovery from cell-balanci maximum time of 24.576ms. | ing voltage drop. Default time is 100µs, with |
| D6 | | | CELL RECOVERY TIME[7:0] | DELAY TIME IN μs |
| D5 | | | 0000000 | 96 |
| D4 | | | 0000001 | 192 |
| D3 | 0 | | 0000010 | 288 |
| D2 | | | 00000011 | 384 |
| D1 | | | 00000100 | 480 |
| | | | | |
| D0 | | | 1111110 | 24480 |
| | | | 1111111 | 24576 |

ID1 Register (address 0x0D)

| BIT | POR | NAME | DESCRIPTION |
|-----|-------|-------------|--|
| D15 | | | |
| D14 | | | |
| D13 | | | |
| D12 | | | |
| D11 | | | |
| D10 | | | |
| D9 | | | The two least-significant bytes of the 24-bit factory-programmed device ID. A valid device |
| D8 | xxxxh | | |
| D7 | **** | DEVID[15:0] | ID has two or more bits set to logic-one. Read-only. |
| D6 | | | |
| D5 | | | |
| D4 | | | |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

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ID2 Register (address 0x0E)

| BIT | POR | NAME | DESCRIPTION |
|-----|------|--------------|--|
| D15 | | | |
| D14 | | | |
| D13 | | | |
| D12 | xxh | ROMCRC[7:0] | 8-bit CRC value computed from the on-board read-only memory. Read-only. |
| D11 | 7711 | | |
| D10 | | | |
| D9 | | | |
| D8 | | | |
| D7 | | | |
| D6 | | | |
| D5 | | DEVID[23:16] | Most-significant byte of the 24-bit factory-programmed device ID. ID1[0] always reads logic-one. A valid device ID has two or more bits set to logic-one. Read-only. |
| D4 | xxh | | |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

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DEVCFG1 Register (address 0x10)

| POR | NAME | DESCRIPTION | |
|-----|---|---|---|
| 0 | POLARITY | Enables bipolar mode for ADC (input range is -2.5V to 2.5V). Default is unipolar mode (input range is 0V to 5V). The ADC logic latches the value of this bit at the start of the measurement cycle. The DIAG measurement timeslot is controlled by the internal logic. Changing the value of this bit takes effect at the next measurement cycle start. | |
| 0 | ADCSELECT | Configures which ADC is selected for measurements. Default is the ADC1 which is the primary ADC. The ADC logic latches the value of this bit at the start of the measurement cycle. Changing the value of this bit takes effect at the next measurement cycle start. | |
| | | ADCSELECT | SELECTED ADC |
| | | 0 | 1 (Primary) |
| | | 1 | 2 (Secondary) |
| | | IIR filter coefficient bits. User-selectable filter of a weight of 3/8. Setting these bits to 111 would transferred from ALU to CELLn registers as is | d turn the filter off. The ADC scan data is then |
| | | FILTER COEFFICIENT[2:0] | WEIGHT OF THE COEFFICIENT |
| | | 000 | 1/8 |
| | FC[2:0] | 001 | 2/8 |
| 010 | | 010 | 3/8, Default value |
| | | 011 | 1/2 |
| | | 100 | 5/8 |
| | | 101 | .6/8 |
| | | 110 | 7/8 |
| | | 111 | 1, Filter Off |
| 0 | EMGCYDCHG | Set to enable emergency cell-discharge mode | e (configured by BALSWDCHG). |
| 0 | HVCPDIS | Disables the HV charge pump. Used for ALRTHVUV diagnostic. If the HV charge pump is disabled in normal operation, measurement errors will result due to V _{HV} undervoltage. | |
| 0 | Reserved | Reserved for future use. | |
| 0 | FORCEPOR | Enables hard POR by pulling down SHDNL internally. If cleared before the POR occurs, it disables the active pulldown on SHDNL. | |
| 0 | ALIVECNTEN | Enables inclusion of alive-counter byte at end of all write and read packets. | |
| 0 | ADCTSTEN | Enables the ALU test mode. This mode feeds 12-bit data from the ADCTEST registers directly into the ALU, instead of from the ADC conversion. | |
| 0 | SCANTODIS | Disables the acquisition watchdog but does not clear the SCANTIMEOUT flag in the SCANCTRL register if it is set. | |
| 0 | BALSWDISABLE | Disables all the balancing switches conducting between SWn and Swn-1. This allows disabling all the balancing switches without actually clearing the BALSWEN register. | |
| 0 | NOPEC | Disables packet-error checking (PEC). | |
| 1 | ADDRUNLOCK | Disables write-protection of device address DA[4:0]. Cleared only by HELLOALL command (write protected). | |
| 0 | SPOR | Enables soft POR. Writing to a logic-zero has no effect. Always reads logic-zero. | |
| | 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 | 0POLARITY0ADCSELECT0ADCSELECT010FC[2:0]010FC[2:0]0EMGCYDCHG0HVCPDIS0Reserved0FORCEPOR0ADCTSTEN0SCANTODIS0BALSWDISABLE0NOPEC1ADDRUNLOCK | 0 POLARITY Enables bipolar mode for ADC (input range is input range is 0V to 5V). The ADC logic latche measurement cycle. The DIAG measurement tim Changing the value of this bit takes effect at the Configures which ADC is selected for measure primary ADC. The ADC logic latches the value of this bit takes effect at the ADC SELECT 0 ADCSELECT Configures which ADC is selected for measure primary ADC. The ADC logic latches the value of this bit takes effect at the ADC SELECT 0 1 IIR filter coefficient bits. User-selectable filter of a weight of 3/8. Setting these bits to 111 would transferred from ALU to CELL nregisters as is FILTER COEFFICIENT[2:0] 000 001 100 0010 FC[2:0] 000 010 FC[2:0] 010 0111 000 001 010 FC[2:0] 010 011 011 010 010 111 0 011 110 111 0 EMGCYDCHG Set to enable emergency cell-discharge mode 0 HVCPDIS Disables the HV charge pump. Used for ALR disabled in normal operation, measurement et disabled in normal operation, measurement et disables the active pulldown on SHDNL. 0 Reserved Finables hard POR by pulling down SHDNL in disables the active pulldo |
12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

GPIO Register (address 0x11)

| BIT | POR | NAME | DESCRIPTION |
|-----|-----|----------|--|
| D15 | | | |
| D14 | 0 | וטיגזסוט | Setting DIRn enables GPIOn as an output. Default state is high-impedance input. |
| D13 | 0 | DIR[3:0] | |
| D12 | | | |
| D11 | | | |
| D10 | 0 | DD(2-0) | Indicates the current logic state of each GPIOn pin input buffer. The logic state is sampled |
| D9 | U | RD[3:0] | at the end of the parity bit of the register address byte during a read of this register. Read- only. |
| D8 | | | |
| D7 | 0 | GPI03TMR | Enables the GPIO3 timer mode. This mode overrides DIR3 and DRV3 and drives GPIO3 to logic-one when the timer is counting, and drives to logic-zero when the timer times out. Emergency cell-discharge mode (EMGCYDCHG = 1) automatically enables the GPIO3 timer mode. |
| D6 | | | |
| D5 | 0 | Reserved | Always reads logic-zero. |
| D4 | | | |
| D3 | | | |
| D2 | 0 | | Setting DRVn sets GPIOn to logic-one if DIRn is set. |
| D1 | 0 | DRV[3:0] | |
| D0 | | | |

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MEASUREEN Register (address 0x12)

| BIT | POR | NAME | DESCRIPTION |
|-----|-----|--------------|---|
| D15 | 0 | BLKCONNECT | Connects the voltage-divider to the V _{BLKP} pin. Must be enabled prior to the VBLOCK measurement. The ADC logic latches the value of this bit at the start of the measurement cycle. Changing the value of this bit takes effect at the next measurement cycle start. |
| D14 | 0 | BLOCKEN | Enables measurement of the V_{BLKP} input in the acquisition mode. The ADC logic latches the value of this bit at the start of the measurement cycle. Changing the value of this bit takes effect at the next measurement cycle start. |
| D13 | 0 | AIN2EN | Enables measurement of the AUXIN2 input in the acquisition mode. The ADC logic latches the value of this bit at the start of the measurement cycle. Changing the value of this bit takes effect at the next measurement cycle start. |
| D12 | 0 | AIN1EN | Enables measurement of the AUXIN1 input in the acquisition mode. The ADC logic latches the value of this bit at the start of the measurement cycle. Changing the value of this bit takes effect at the next measurement cycle start. |
| D11 | | | |
| D10 | | | |
| D9 | | | |
| D8 | | | |
| D7 | | | Enables measurement of the respective cell in the acquisition mode. Disabled channels |
| D6 | 0 | CELLEN[12:1] | result in a measurement value of 0000h. The ADC logic latches the value of this bit at |
| D5 | 0 | GELLEN[12.1] | the start of the measurement cycle. Changing the value of this bit takes effect at the next measurement cycle start. |
| D4 | | | nousurement eyele start. |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

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SCANCTRL Register (address 0x13)

| BIT | POR | NAME | DESCR | IPTION | | |
|------------|-----|----------------|--|--|--|--|
| D15 | 0 | SCANDONE | Indicates the acquisition has completed. Cleared only by writing it to logic-zero to detect completion of the next acquisition. Writing to logic 1 has no effect. A new acquisition will not commence if this bit is set. | | | |
| D14 | 0 | SCANTIMEOUT | Indicates the acquisition did not complete in the expected period of time. The timeout depends on the oversampling configuration. Cleared only by writing it to logic-zero to allow detection of future timeout events. The watchdog can be disabled by setting SCANTODIS in the DEVCFG register. | | | |
| D13 | 0 | DATARDY | the data registers and can now be read. Data TOTAL is transferred at the same time. Cleare | Indicates the measurement data from the acquisition has been transferred from the ALU to the data registers and can now be read. Data for all measurement registers and MIN/MAX/TOTAL is transferred at the same time. Cleared by writing it to logic-zero to allow detection of the next data transfer. Writing to logic-one has no effect. | | |
| D12 | 0 | DELAYSEL | The delay after the start of the scan before the measurement is enabled only if the AUTOBALSWDIS bit is set to 1. Sets the delay based on the setting in the AUTOBALSWDIS Delay register (0x0C). The default bit setting is 0 which selects the delay associated with cell recovery time in register 0x0C. Setting this bit to 1 selects the delay setting of "Diagnostic Recovery time." See <u>AUTOBALSWDIS Delay Register (address</u> 0x0C) table for details on delay timings. | | | |
| D11 | 0 | AUTOBALSWDIS | Automatic disable of balancing switches during measurements. The delay for cell recovery settling time and for the diagnostic recovery is set based on the AUTOBALSWDIS Delay register (0x0C). Set this bit to zero for normal balancing switch operation. | | | |
| D10 | | | Configures the cell-balancing switch diagnost these modes effectively override the BALSWE POLARITY configurations during the acquisiti register per the BALHIGHTHR and BALLOWT for details. | EN, MEASUREEN, ALTMUXSEL, and on mode and update the ALRTBALSW | | |
| D9 | | | BALSWDIAG[2:0] | DIAGNOSTIC TEST | | |
| | | | 000 | None | | |
| | 0 | BALSWDIAG[2:0] | 001 | Balancing switch short | | |
| | | | 010 | Balancing switch open | | |
| D 0 | | | 011 | None | | |
| D8 | | | 100 | None | | |
| | | | 101 | Cell sense open odds | | |
| | | | 110 | Cell sense open evens | | |
| | | | 111 | None | | |
| D7 | 0 | RDFILT | This bit chooses where the ADC scan data is read from. Writing this bit to '1' enables the read to occur from filtered CELLn registers. The default value is '0' wherein the read of the scanned data occurs from unfiltered ALU registers. | | | |

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| BIT | POR | NAME | DESCR | IPTION | |
|-----|-----|--------------|--|-----------------------------------|--|
| D6 | | | Configures for the number of oversamples in | the acquisition, per table below: | |
| | | | OVSAMPL[2:0] | OVERSAMPLES | |
| | | | 000 | 1 | |
| | | | 001 | 4 | |
| D5 | 0 | OVSAMPL[2:0] | 010 | 8 | |
| 05 | 0 | | 011 | 16 | |
| | | | 100 | 32 | |
| | | | 101 | 64 | |
| | | | 110 | 128 | |
| D4 | | | 111 | 128 | |
| D3 | 0 | AMENDFILT | This bit when set to '1' enables the automatic transfer of the new ADC conversion from the ALU to CELLn registers through the IIR filter at the end of the scan. The scan result is available in the ALU as well as the CELLn registers. The default value is '0', which keeps the scan conversion data in the ALU register as an unfiltered result. | | |
| D2 | 0 | SCANMODE | Enables top-down scan mode. Default is pyra | mid scan mode. | |
| D1 | 0 | FILTDONE | Indicates the user register has been updated with the new ADC conversion values based on filter coefficient bits when AMENDFILT = 1. Cleared only by writing it to logic-zero to detect update of the user registers for the next acquisition. Writing to logic-one has no effect. | | |
| D0 | 0 | SCAN | Enables the acquisition mode and (if in double-buffer mode) transfers previous acquisition data from ALU to data registers. Acts as a strobe bit and therefore does not need to be cleared. Always reads logic-zero. Ignored in acquisition mode. | | |

SCANCTRL Register (address 0x13) (continued)

ALRTOVEN Register (address 0x14)

| BIT | POR | NAME | DESCRIPTION |
|-----|-----|----------------|--|
| D15 | 0 | Reserved | |
| D14 | 0 | Reserved | Always reads logic-zero. |
| D13 | 0 | AINOVALRTEN1 | Enables the AIN1 overvoltage alert. |
| D12 | 0 | AINOVALRTEN0 | Enables the AIN0 overvoltage alert. |
| D11 | | | |
| D10 | | | |
| D9 | | | |
| D8 | | | |
| D7 | | | |
| D6 | 0 | OVALRTEN[12:1] | Enables the overvoltage alert for the respective cell. Clearing also clears the associated |
| D5 | 0 | OVALKIEN[12.1] | cell alert. |
| D4 | | | |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

ALRTUVEN Register (address 0x15)

| BIT | POR | NAME | DESCRIPTION |
|-----|-----|----------------|---|
| D15 | 0 | Decement | |
| D14 | 0 | Reserved | Always reads logic-zero. |
| D13 | 0 | AINUVALRTEN1 | Enables the AIN1 undervoltage alert. |
| D12 | 0 | AINUVALRTEN0 | Enables the AIN0 undervoltage alert. |
| D11 | | | |
| D10 | | | |
| D9 | | | |
| D8 | | | |
| D7 | | | |
| D6 | 0 | | Enables the undervoltage alert for the respective cell. Clearing also clears the associated |
| D5 | 0 | UVALRTEN[12:1] | cell alert. |
| D4 | | | |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

WATCHDOG Register (address 0x18)

| BIT | POR | NAME | | DESCRIPTION | |
|----------|-----|--------------|---|------------------------------------|--------------------------------|
| D15 | 0 | Reserved | Always reads logic-zero. | | |
| D14 | | | Sets the step size of the cell-b | alancing timer LSB per table be | low: |
| D13 | | | CBPDIV[2:0] | STEP SIZE | TIMEOUT RANGE |
| | | | 000 | Disabled | No timeout |
| | | | 001 | 1s | 1–15s |
| | 0 | CBPDIV[2:0] | 010 | 4s | 4–60s |
| D12 | 0 | | 011 | 16s | 16–240s |
| DIZ | | | 100 | 64s | 64–960s |
| | | | 101 | 128s | 128–1920s |
| | | | 110 | 256s | 256–3840s |
| | | | 111 | 256s | 256–3840s |
| D11 | | | Watchdog timer for the cell-balancing switches. The timer counts down at a rate set by | | |
| . | | | | ches '0', all cell-balancing switc | |
| D10 | 0 | CBTIMER[3:0] | separate from the BALCFGn enable bits. The timer should be periodically rewritten with a timeout value to keep the cell-balancing switches enabled. When the timer value is read, the value reported is latched during the stop bit time following the ACQCFG UART register address of the READALL command. If the GPIO3TMR configuration is enabled, the GPIO3 | | |
| D9 | Ū | | | | |
| D8 | | | pin is driven high, while CBTIM | /IER[3:0] is nonzero and is drive | en low when the timer value is |
| | | | zero. The cell-balancing limer | is reset to zero when EMGCYD | CHG = 1. |
| D7 | - | | | | |
| D6 | | | | | |
| D5 | | | | | |
| D4 | 0 | Reserved | Always reads logic-zero. | | |
| D3 | Ū | | | | |
| D2 | | | | | |
| D1 | | | | | |
| D0 | | | | | |

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

ACQCFG Register (address 0x19)

| BIT | POR | NAME | DESCI | RIPTION | | |
|-----|-----|---------------|--|------------------------------------|--|--|
| D15 | | | | | | |
| D14 | | | | | | |
| D13 | 0 | Reserved | | | | |
| D12 | 0 | Treserved | Always reads logic-zero. | | | |
| D11 | | | | | | |
| D10 | | | | | | |
| D9 | | | Configures the THRM mode based on the table below: | | | |
| | | | THRMMODE[1:0] | OPERATION | | |
| | 0 | THRMMODE[1:0] | 00 | Auto mode (on in acquisition mode) | | |
| D8 | U | | 01 | Auto mode (on in acquisition mode) | | |
| | | | 10 | Manual mode, THRM switch off | | |
| | | | 11 | Manual mode, THRM switch on | | |
| D7 | 0 | Reserved | Always reads logic-zero. | | | |
| D6 | | | | | | |
| D5 | | | | | | |
| D4 | | | | | | |
| D3 | 0 | AINTIME[5:0] | Configures the conversion time for each enabled AUXINn input from 6µs (default) up to 384µs (6µs/bit). This is to allow extra settling time if the application circuit requires it since the THRM voltage is not driven out until the start of the acquisition (in auto mode). | | | |
| D2 | U | | | | | |
| D1 | | | | | | |
| D0 | | | | | | |

BALSWEN Register (address 0x1A)

| BIT | POR | NAME | DESCRIPTION |
|-----|-----|---------------|--|
| D15 | | | |
| D14 | 0 | Decement | Alwaya zaoda lazia zaza |
| D13 | 0 | Reserved | Always reads logic-zero. |
| D12 | | | |
| D11 | | | |
| D10 | | | |
| D9 | | | |
| D8 | | | |
| D7 | | | |
| D6 | 0 | | PAL SWENIN 11 analysis the belonging switch (conducting) between SWn and SWn 1 |
| D5 | U | BALSWEN[11:0] | BALSWEN[n-1] enables the balancing switch (conducting) between SWn and SWn-1 |
| D4 | | | |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

DEVCFG2 Register (address 0x1B)

| BIT | POR | NAME | DESCRIPTION | |
|------------|-----|------------|---|--|
| D15 | 0 | LASTLOOP | Enables UART loopback mode, which internally connects upper-port transmitter to upper-port receiver. The loopback mode allows the host to locate a break in daisy-chain communication whether or not the last daisy-chain device uses an external wire loopback wire or the internal loopback. | |
| D14 | 0 | TXADPEN | Enables TX adaptive mode. Leave in default state for normal operation. | |
| D13 D12 | 0 | Reserved | Always reads logic-zero. | |
| D11 | 0 | TXLIDLEHIZ | Enables high-Z idle mode, which causes the TX drivers of the lower UART to idle in the high-Z state instead of idling in the logic-zero state (default mode). Leave in default state for normal operation. | |
| D10 | 0 | TXUIDLEHIZ | Enables high-Z idle mode, which causes the TX drivers of the upper UART to idle in the high-Z state instead of idling in the logic-zero state (default mode). Leave in default state for normal operation. | |
| D9 | 0 | RESERVED | Reserved for future use. Reads the written value. | |
| D8 | | | | |
| D7 | | | | |
| D6 | | | | |
| D5 | | | | |
| D4 | 0 | Reserved | Always reads logic-zero. | |
| D3 | | | | |
| D2 | | | | |
| D1 | | | | |
| D0 | | | | |

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

BALDIAGCFG1 Register (address 0x1C)

| BIT | POR | NAME | DESCRIPTION | |
|-----|-----|----------------|--|--|
| D15 | 0 | Reserved | Always reads logic zero | |
| D14 | 0 | Reserved | Always reads logic-zero. | |
| D13 | 0 | ALTMUXSEL_M | Mirror for ALTMUXSEL bit. | |
| D12 | 0 | POLARITY_M | Mirror for POLARITY bit. The ADC logic latches the value of this bit at the start of the measurement cycle. Changing the value of this bit takes effect at the next measurement-cycle start. | |
| D11 | | | | |
| D10 | | | | |
| D9 | | | | |
| D8 | | | | |
| D7 | | | | |
| D6 | 0 | CELLEN_M[12:1] | Mirror for CELLEN[12:1] in the MEASUREEN register. Writing to this field also updates | |
| D5 | 0 | | CELLEN[12:1]. Reading this field reflects CELLEN[12:1]. | |
| D4 | | | | |
| D3 | | | | |
| D2 | | | | |
| D1 | | | | |
| D0 | | | | |

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

| BIT | POR | NAME | DESCR | RIPTION | |
|-----|-----|---------------|--|--|--|
| D15 | | | Configuration for emergency cell-discharge n cycle for each discharge cycle (even or odd) | | |
| D14 | | | DCHGWIN[2:0] (LSb = 7.5s) | BEHAVIOR | |
| | 0 | DCHGWIN[2:0] | 0h | Switches on for 7.5s, off for 52.5s | |
| D13 | | | 1h | Switches on for 15s, off for 45s | |
| 013 | | | | | |
| | | | 7h | Switches on for 59.94s, off for 62.5ms | |
| D12 | 0 | Reserved | Always reads logic-zero. | | |
| D11 | | | Discharge counter which can be read to veri | fu aparation of the amarganay call discharge | |
| D10 | 0 | DCHGCNTR[3:0] | Discharge counter, which can be read to verify operation of the emergency cell-discharge mode (EMGCYDCHG = 1). During the cell-discharge mode, the discharge counter counts at 2Hz rolling over at Fh to 0h and continuing until the cell-discharge mode terminates. | | |
| D9 | 0 | | | | |
| D8 | | | Read-only. | | |
| D7 | | | Write to set the timeout value of the emerger | any coll discharge mode (EMCCVDCHC = 1) | |
| D6 | | | per the table below. Writing to 00h disables the | he timer and terminates the emergency cell- | |
| D5 | | | discharge mode. The timer starts when EMG | CYDCHG = 1 (and DCHGTIME[7:0] \neq 00h) | |
| D4 | | | and stops when it reaches the timeout. The t | inter is reset when EMGC FDCHG – 0. | |
| D3 | 0 | | DCHGTIME[7:0] (LSb = 2 HOURS) | TIMEOUT | |
| D2 | 0 | DCHGTIME[7:0] | 00h | Discharge mode disabled | |
| D1 | | | 01h | Discharge mode disabled after 4 hours | |
| | | | 02h | Discharge mode disabled after 6 hours | |
| D0 | | | | | |
| | | | FFh | Discharge mode disabled after 512 hours | |

BALSWDCHG Register (address 0x1D)

TOPCELL Register (address 0x1E)

| BIT | POR | NAME | DESCRIPTION |
|-----|-----|--------------|---|
| D15 | | | |
| D14 | | | |
| D13 | | | |
| D12 | | | |
| D11 | | | |
| D10 | 0 | | |
| D9 | 0 | Reserved | Always reads logic-zero. |
| D8 | | | |
| D7 | | | |
| D6 | | | |
| D5 | | | |
| D4 | | | |
| D3 | | | |
| D2 | Ch | TOPCELL[3:0] | Configures the top cell position if less than 12 channels are used. This is to properly mask the ALRTBALSW diagnostic alerts. TOPCELL[3:0] = 0h is not a valid configuration. |
| D1 | CII | | TOPCELL[3:0]= Dh, Eh, or Fh is identical to Ch (12d). |
| D0 | | | |

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

CELLn Register (addresses 0x20 to 0x2B)

| BIT | POR | NAME | DESCRIPTION |
|-----|-----|--------------|---|
| D15 | | | |
| D14 | | | |
| D13 | | | |
| D12 | | | |
| D11 | | | |
| D10 | | | |
| D9 | | | |
| D8 | 0 | CELLn[15:0] | CELLn[15:2] contains the 14-bit measurement result for CELLn. CELLn[1:0] always reads |
| D7 | 0 | CELLII[15.0] | logic-zero. Read-only. |
| D6 | | | |
| D5 | | | |
| D4 | | | |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

VBLOCK Register (address 0x2C)

| BIT | POR | NAME | DESCRIPTION |
|-----|-----|--------------|---|
| D15 | | | |
| D14 | | | |
| D13 | | | |
| D12 | | | |
| D11 | | | |
| D10 | | | |
| D9 | | | |
| D8 | 0 | VBLOCK[15:0] | VBLOCK[15:2] contains the 14-bit measurement result for V _{BLKP} . VBLOCK[1:0] always reads logic-zero. Read-only. |
| D7 | 0 | VBLOCK[15.0] | logic-zero. Read-only. |
| D6 | | | |
| D5 | | | |
| D4 | | | |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

AIN1 Register (address 0x2D)

| BIT | POR | NAME | DESCRIPTION |
|-----|-----|-------------|---|
| D15 | | | |
| D14 | | | |
| D13 | | | |
| D12 | | | |
| D11 | | | |
| D10 | | | |
| D9 | | | |
| D8 | 0 | AIN1[15:0] | AIN1[15:4] contains the 12-bit measurement result for AUXIN1. AIN1[3:0] always reads logic- |
| D7 | 0 | AIN [[15.0] | zero. Read-only. |
| D6 | | | |
| D5 | | | |
| D4 | | | |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

AIN2 Register (address 0x2E)

| BIT | POR | NAME | DESCRIPTION |
|-----|-----|------------|---|
| D15 | | | |
| D14 | | | |
| D13 | | | |
| D12 | | | |
| D11 | | | |
| D10 | | | |
| D9 | | | |
| D8 | 0 | AIN2[15:0] | AIN2[15:4] contains the 12-bit measurement result for AUXIN2. AIN2[3:0] always reads logic- |
| D7 | 0 | AIN2[15.0] | zero. Read-only. |
| D6 | | | |
| D5 | | | |
| D4 | | | |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

TOTAL Register (address 0x2F)

| BIT | POR | NAME | DESCRIPTION |
|-----|-----|-----------|---|
| D15 | | | |
| D14 | | | |
| D13 | | | |
| D12 | | | |
| D11 | | | |
| D10 | | | |
| D9 | | | |
| D8 | 0 | SUM[15:0] | 16-bit sum of all cell voltages CELLn[15:4] that are enabled by MEASUREEN. Read-only. |
| D7 | 0 | SUM[15.0] | To-bit suff of all cell voltages CELLIT[15.4] that are enabled by MEASUREEN. Read-only. |
| D6 | | | |
| D5 | | | |
| D4 | | | |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

OVTHCLR Register (address 0x40)

| BIT | POR | NAME | DESCRIPTION |
|-----|-------|---------------|--|
| D15 | | | |
| D14 | | | |
| D13 | | | |
| D12 | | | |
| D11 | | | |
| D10 | | | |
| D9 | | | |
| D8 | FFFCh | OVTHCLR[15:0] | 14-bit overvoltage-clear threshold. UVTHCLR[1:0] always reads logic-zero. |
| D7 | FFFGI | | 14-bit overvoltage-clear tilleshold. OV I HCLR[1.0] always leads logic-zero. |
| D6 | | | |
| D5 | | | |
| D4 | | | |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

OVTHSET Register (address 0x42)

| BIT | POR | NAME | DESCRIPTION |
|-----|-------|---------------|---|
| D15 | | | |
| D14 | | | |
| D13 | | | |
| D12 | | | |
| D11 | | | |
| D10 | | | |
| D9 | | | |
| D8 | FFFCh | OVTHSET[15:0] | 14-bit overvoltage-set threshold. OVTHSET[1:0] always reads logic-zero. |
| D7 | | OVTHSET[15.0] | 14-bit overvoltage-set threshold. OVTHSET[1.0] always reads logic-zero. |
| D6 | | | |
| D5 | | | |
| D4 | | | |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

UVTHCLR Register (address 0x44)

| BIT | POR | NAME | DESCRIPTION |
|-----|-----|---------------|--|
| D15 | | | |
| D14 | | | |
| D13 | | | |
| D12 | | | |
| D11 | | | |
| D10 | | | |
| D9 | | | |
| D8 | 0 | UVTHCLR[15:0] | 14-bit undervoltage-clear threshold. UVTHCLR[1:0] always reads logic-zero. |
| D7 | 0 | | 14-bit undervoltage-clear timeshold. OVTHOLN[1.0] always reads logic-zero. |
| D6 | | | |
| D5 | | | |
| D4 | | | |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

UVTHSET Register (address 0x46)

| BIT | POR | NAME | DESCRIPTION |
|-----|-----|---------------|--|
| D15 | | | |
| D14 | | | |
| D13 | | | |
| D12 | | | |
| D11 | | | |
| D10 | | | |
| D9 | | | |
| D8 | 0 | UVTHSET[15:0] | 14-bit undervoltage set threshold. UVTHSET[1:0] always reads logic-zero. |
| D7 | 0 | | 14 -bit undervoltage set timeshold. OV $173 \ge 1[1.0]$ always reads logic-zero. |
| D6 | | | |
| D5 | | | |
| D4 | | | |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

MSMTCH Register (address 0x48)

| BIT | POR | NAME | DESCRIPTION |
|-----|--------|--------------|---|
| D15 | | | |
| D14 | | | |
| D13 | | | |
| D12 | | | |
| D11 | | | |
| D10 | | | |
| D9 | | | |
| D8 | FFFCh | MSMTCH[15:0] | 14-bit voltage threshold for ALRTMSMTCH. MSMTCH[1:0] always reads logic-zero. |
| D7 | FFFCII | | |
| D6 | | | |
| D5 | | | |
| D4 | | | |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

AINOT Register (address 0x49)

| BIT | POR | NAME | DESCRIPTION |
|-----|-----|-------------|---|
| D15 | | | |
| D14 | | | |
| D13 | | | |
| D12 | | | |
| D11 | | | |
| D10 | | | |
| D9 | | | |
| D8 | 0 | | 12-bit undervoltage (over-temperature) threshold for AUXINn alerts. AINOT[3:0] always |
| D7 | 0 | AINOT[15:0] | reads logic-zero. |
| D6 | | | |
| D5 | | | |
| D4 | | | |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

AINUT Register (address 0x4A)

| BIT | POR | NAME | DESCRIPTION |
|-----|--------|-------------|--|
| D15 | | | |
| D14 | | | |
| D13 | | | |
| D12 | | | |
| D11 | | | |
| D10 | | | |
| D9 | | | |
| D8 | FFF0h | AINUT[15:0] | 12-bit overvoltage (undertemperature) threshold for AUXINn alerts. AINUT[3:0] always reads |
| D7 | 111011 | AINOT[13.0] | logic-zero |
| D6 | | | |
| D5 | | | |
| D4 | | | |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

BALSHRTTHR Register (address 0x4B)

| BIT | POR | NAME | DESCRIPTION |
|-----|-----|------------------|--|
| D15 | | | |
| D14 | | | |
| D13 | | | |
| D12 | | | |
| D11 | | | |
| D10 | | | |
| D9 | | | 14-bit voltage threshold for the balancing-switch short-circuit diagnostic test. The ADC |
| D8 | 0 | | results in this test mode are compared against the threshold. If any result is below the |
| D7 | 0 | BALSHRTTHR[15:0] | threshold, it is flagged as a balancing-switch alert. Results above the threshold are considered normal. The threshold should be set by the system controller prior to making |
| D6 | | | a diagnostic measurement. BALSHRTTHR[1:0] always reads logic-zero. |
| D5 | | | |
| D4 | | | |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

BALLOWTHR Register (address 0x4C)

| BIT | POR | NAME | DESCRIPTION |
|-----|-----|-----------------|---|
| D15 | | | |
| D14 | | | |
| D13 | | | |
| D12 | | | |
| D11 | | | |
| D10 | | | |
| D9 | | | 14-bit low-voltage threshold for the balancing-switch conducting and cell sense-wire |
| D8 | 0 | | diagnostic tests. The ADC results in this test mode are compared against the threshold. If any result is below the threshold, it is flagged as a balancing-switch alert. Results |
| D7 | 0 | BALLOWTHR[15:0] | above the threshold are considered normal. The threshold should be set by the system |
| D6 | | | controller prior to making a diagnostic measurement. BALLOWTHR[1:0] always reads logic-zero. |
| D5 | | | |
| D4 | | | |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

| BIT | POR | NAME | DESCRIPTION |
|-----|-----|------------------|--|
| D15 | | | |
| D14 | | | |
| D13 | | | |
| D12 | | | |
| D11 | | | |
| D10 | | | |
| D9 | | | 14-bit high-voltage threshold for the balancing-switch conducting and cell sense-wire |
| D8 | 0 | BALHIGHTHR[15:0] | diagnostic tests The ADC results in this test mode are compared against the threshold. If any result is above the threshold, it is flagged as a balancing-switch alert. Results |
| D7 | 0 | BALHIGHTHA[15.0] | below the threshold are considered normal. The threshold should be set by the system controller prior to making a diagnostic measurement. BALHIGHTHR[1:0] always reads |
| D6 | | | logic-zero. |
| D5 | | | |
| D4 | | | |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

BALHIGHTHR Register (address 0x4D)

DIAG Register (address 0x50)

| BIT | POR | NAME | DESCRIPTION |
|-----|-----|------------|--|
| D15 | | | |
| D14 | | | |
| D13 | | | |
| D12 | | | |
| D11 | | | |
| D10 | | | |
| D9 | | | |
| D8 | 0 | | DIAG[15:2] contains the 14-bit measurement result for the diagnostic selected by |
| D7 | 0 | DIAG[15:0] | DIAGCFG[2:0]. DIAG[1:0] always reads logic-zero. Read-only. |
| D6 | | | |
| D5 | | | |
| D4 | | | |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

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BIT POR NAME DESCRIPTION D15 Configures the current level for all enabled test sources per the table below (either 6.25µA or 3.125µA per bit. D14 **TEST SOURCE CURRENT** D13 CTSTDAC{3:0] Cx, AUXINn Cx, AUXINn 3.125µA 0h 6.25µA 0 CTSTDAC[3:0] 1h 12.5µA 6.25µA 2h 18.75µA 9.375µA D12 Dh 87.5µA 43.75µA Eh 46.875µA 93.75µA Fh 100µA 50µA Configures the cell input test-current sources to either source current from VAA (logic-one), D11 0 CTSTSRC or sink current to AGND (logic-zero). For C0, configures the cell input test current to source from VAA only. D10 0 Reserved Reserved for future use. D9 0 Enables the test current sources connected to the corresponding AUXINn input for AUXINTSTEN[2:1] diagnostic testing. The current level is configured by the CTSTDAC[3:0] and the current 0 D8 direction is configured by CTSTSRC. Selects the HVMUX output to which the HVMUX test current source is connected, if MUXDIAGPAIR is enabled, as shown below: MUXDIAGBUS D7 0 MUXDIAGBUS **HVMUX OUTPUT** 0 Output used for even cells, C0, and AGND 1 Output used for odd cells, REF, and ALTREF. Configures a single HVMUX test-current source to be connected to only one HVMUX D6 0 MUXDIAGPAIR output (as selected by MUXDIAGBUS). In the default configuration (MUXDIAGPAIR = 0), both HVMUX test-current sources are connected to both HVMUX outputs. 0 D5 Reserved Always reads logic-zero. Enables the HVMUX test-current source(s). The current level is configured by CSTDAC[3:0] and the connectivity is configured by MUXDIAGPAIR and MUXDIAGBUS. D4 0 MUXDIAGEN The ADC logic latches the value of this bit at the start of the measurement cycle. Changing the value of this bit takes effect at the next measurement-cycle start. Enables cell measurements on the SWn inputs (ALTMUX data path) instead of the Cn D3 0 ALTMUXSEL inputs (HVMUX data path). See the Diagnostics section. D2 Selects the diagnostic measurement for the acquisition per table below: DIAGNOSTIC MEASUREMENT DIAGSEL[2:0] D1 0b000 No measurement 0b001 V_{ALTREF} (with ADC reference = REF) 0b010 V_{AA} (with ADC reference = REF) DIAGSEL[2:0] 0 0b011 LSAMP offset D0 0b100 Zero-scale ADC output (000h) 0b101 Full-scale ADC output (FFFh) 0b110 Die temperature 0b111 No measurement

DIAGCFG Register (address 0x51)

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CTSTEN Register (address 0x52)

| BIT | POR | NAME | DESCRIPTION |
|-----|-----|--------------|---|
| D15 | | | |
| D14 | 0 | Reserved | Always reads logic-zero. |
| D13 | | | |
| D12 | | | |
| D11 | | | |
| D10 | | | |
| D9 | | | |
| D8 | | | |
| D7 | | | Enables the current sources connected to the corresponding cell input for diagnostic |
| D6 | 0 | CTSTEN[12:0] | testing. The current level is configured by the CTSTDAC[3:0] and the current direction is |
| D5 | | | configured by CTSTSRC in the DIAGCFG register. |
| D4 | | | |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

ADCTEST1A Register (address 0x57)

| BIT | POR | NAME | DESCRIPTION |
|-----|-----|-----------------|---|
| D15 | | | |
| D14 | 0 | Decerved | |
| D13 | 0 | Reserved | Always reads logic-zero. |
| D12 | | | |
| D11 | | | |
| D10 | | | |
| D9 | | | |
| D8 | | | |
| D7 | | | |
| D6 | | ADCTEST1A[11:0] | User-specified test data for the ALU diagnostic (ADCTEST = 1). This 12-bit data is fed into |
| D5 | | ADCTESTIA[11.0] | the ALU during the first conversion of odd-numbered samples (e.g., first sample). |
| D4 | | | |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

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ADCTEST1B Register (address 0x58)

| BIT | POR | NAME | DESCRIPTION |
|-----|-----|-----------------|---|
| D15 | | | |
| D14 | 0 | _ | Alwaya raada lagia zara |
| D13 | 0 | Reserved | Always reads logic-zero. |
| D12 | | | |
| D11 | | | |
| D10 | | | |
| D9 | | | |
| D8 | | | |
| D7 | | | |
| D6 | | ADCTEST1B[11:0] | User-specified test data for the ALU diagnostic (ADCTEST = 1). This 12-bit data is fed into |
| D5 | | ADCTESTIB[11.0] | the ALU during the second conversion of odd-numbered samples (e.g., first sample). |
| D4 | | | |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

ADCTEST2A Register (address 0x59)

| BIT | POR | NAME | DESCRIPTION | |
|-----|-----|-----------------|---|--|
| D15 | | | | |
| D14 | 0 | Reserved | Alwaya raada lagia zara | |
| D13 | 0 | Reserved | Always reads logic-zero. | |
| D12 | | | | |
| D11 | | | | |
| D10 | | | | |
| D9 | | | | |
| D8 | | | | |
| D7 | | | | |
| D6 | 0 | ADCTEST2A[11:0] | User-specified test data for the ALU diagnostic (ADCTEST = 1). This 12-bit data is fed into | |
| D5 | 0 | ADGTESTZA[11.0] | the ALU during the first conversion of even-numbered samples in oversampling mode. | |
| D4 | | | | |
| D3 | | | | |
| D2 | | | | |
| D1 | | | | |
| D0 | | | | |

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ADCTEST2B Register (address 0x5A)

| BIT | POR | NAME | DESCRIPTION |
|-----|-----|-----------------|---|
| D15 | | | |
| D14 | 0 | Reserved | Alwaya raada lagia zara |
| D13 | 0 | Reserved | Always reads logic-zero. |
| D12 | | | |
| D11 | | | |
| D10 | | | |
| D9 | | | |
| D8 | | | |
| D7 | | | |
| D6 | 0 | ADCTEST2B[11:0] | User-specified test data for the ALU diagnostic (ADCTEST = 1). This 12-bit data is fed into |
| D5 | 0 | | the ALU during the second conversion of even-numbered samples in oversampling mode. |
| D4 | | | |
| D3 | | | |
| D2 | | | |
| D1 | | | |
| D0 | | | |

Ordering Information

| PART | TEMP RANGE | PIN-PACKAGE |
|----------------|----------------|-------------|
| MAX17843ACB+* | -40° to +125°C | 64 LQFP |
| MAX17843ACB/V+ | -40° to +125°C | 64 LQFP |

N denotes an automotive qualified part.

+ Denotes a lead(Pb)-free/RoHS-compliant package. *Future product—contact factory for availability.

Package Information

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

| PACKAGE | PACKAGE | OUTLINE | LAND |
|---------|---------|----------------|----------------|
| TYPE | CODE | NO. | PATTERN NO. |
| 64 LQFP | C64+13 | <u>21-0083</u> | <u>90-0141</u> |

12-Channel, High-Voltage Smart Sensor Data-Acquisition Interface

Revision History

| REVISION NUMBER | REVISION DATE | DESCRIPTION | PAGES CHANGED |
|--------------------|------------------|--|--------------------------------|
| 0 | 6/17 | Initial release | — |
| 1 | 11/17 | Updated Benefits and Features, Absolute Maximum Ratings, Electrical Characteristics, TX Adaptive Mode for Single-Ended Mode, UART Communication Mode, SCANCTRL Register (address 0x13), and OVTHSET Register (address 0x42) sections/tables | 1, 14, 16, 53, 56, 111, 122 |
| 2 | 4/18 | Changed Total-Acquisition Error (V _{BLKP} Input) in <u>Electrical Characteristics</u> table from "-125 (min) to +125 (max)" to "-110 (min) to +110 (max)" and changed Bit-Wise and Mask in rows 8 and 16 from "0x001F to 0x003F" | 16, 87 |

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim Integrated's website at www.maximintegrated.com.

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